











### LMK04821, LMK04826, LMK04828

SNAS605AR -MARCH 2013-REVISED DECEMBER 2015

# LMK0482x Ultra Low-Noise JESD204B Compliant **Clock Jitter Cleaner with Dual Loop PLLs**

### **Features**

- JEDEC JESD204B Support
- Ultra-Low RMS Jitter
  - 88 fs RMS Jitter (12 kHz to 20 MHz)
  - 91 fs RMS Jitter (100 Hz to 20 MHz)
  - 162.5 dBc/Hz Noise Floor at 245.76 MHz
- Up to 14 Differential Device Clocks from PLL2
  - Up to 7 SYSREF Clocks
  - Maximum Clock Output Frequency 3.1 GHz
  - LVPECL, LVDS, HSDS, LCPECL Programmable Outputs from PLL2
- Up to 1 Buffered VCXO/Crystal Output from PLL1
  - LVPECL, LVDS, 2xLVCMOS Programmable
- Dual Loop PLLatinum™ PLL Architecture
- PLL1
  - Up to 3 Redundant Input Clocks
    - Automatic and Manual Switch-Over Modes
    - Hitless Switching and LOS
  - Integrated Low-Noise Crystal Oscillator Circuit
  - Holdover mode when Input Clocks are Lost

#### PLL2

- Normalized [1 Hz] PLL Noise Floor of -227 dBc/Hz
- Phase Detector Rate up to 155 MHz
- OSCin Frequency-Doubler
- Two Integrated Low-Noise VCOs
- 50% Duty Cycle Output Divides, 1 to 32 (even and odd)
- Precision Digital Delay, Dynamically Adjustable
- 25 ps Step Analog Delay
- Multi-mode: Dual PLL, single PLL, and Clock Distribution
- Industrial Temperature Range: -40 to 85°C
- Supports 105°C PCB Temperature (Measured at Thermal Pad)
- 3.15-V to 3.45-V Operation
- Package: 64-Pin QFN (9.0 mm x 9.0 mm x 0.8 mm)

# 2 Applications

- Wireless Infrastructure
- **Data Converter Clocking**
- Networking, SONET/SDH, DSLAM
- Medical / Video / Military / Aerospace
- **Test and Measurement**

# 3 Description

The LMK0482x family is the industry's highest performance clock conditioner with **JEDEC** JESD204B support.

The 14 clock outputs from PLL2 can be configured to drive seven JESD204B converters or other logic devices using device and SYSREF clocks. SYSREF can be provided using both DC and AC coupling. Not limited to JESD204B applications, each of the 14 outputs can be individually configured as high performance outputs for traditional clocking systems.

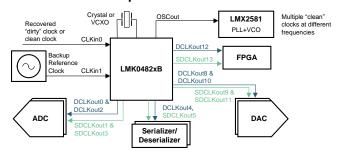
The high performance combined with features like the ability to trade off between power or performance, dual VCOs, dynamic digital delay, holdover, and glitchless analog delay make the LMK0482x family ideal for providing flexible high performance clocking trees.

### Device Information<sup>(1)</sup>

| PART<br>NUMBER | VCO0<br>FREQUENCY | VCO1 FREQUENCY   |  |
|----------------|-------------------|--|--|
| LMK04821       | 1930 to 2075 MHz  | 2920 to 3080 MHz<br>VCO1 Div = ÷2 to ÷8<br>(÷2 = 1460 to 1540 MHz) |  |
| LMK04826B      | 1840 to 1970 MHz  | 2440 to 2505 MHz   |  |
| LMK04828B      | 2370 to 2630 MHz  | 2920 to 3080 MHz   |  |

(1) For all available packages, see the orderable addendum at the end of the datasheet.

### Simplified Schematic





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# 4 Revision History

| C | nanges from Revision AQ (August 2014) to Revision AR                                   | Page |
|---|--|------|
| • | Added Support for 105°C thermal pad temperature  |      |
| • | Changed from I/O to I for pin 6 in Pin Functions table                                 |      |
| • | Deleted programmable status pin in Description column for pin 6 in Pin Functions table |      |
| • | Changed from No connection to Do not connect for pins 7, 8, 9 in Pin Functions table   |      |
| • | Changed to Reference Clck Input Port 1 for PLL 1 for Pins 34, 35 in Pin Functions      |      |
| • | Added Reference Clock Input Port 2 for PLL1 for pins 40, 41 in Pin Functions           | 8    |
| • | Added ESD Ratings  | 9    |
| • | Added PCB temperature in Recommended Operating Conditions                              | 9    |
| • | Added Digital Input Timing in Electrical Characteristics                               | 2    |
| • | Changed Detailed block diagrams for LMK04821 and LMK04826/8                            | 32   |
| • | Added 6 to DCLKout0 sequence and 7 to SDCLKout1 sequence in Figure 12                  | 34   |
| • | Added 6 to DCLKout0 sequence and 7 to SDCLKout1 sequence in Figure 13                  | 3    |
| • | Added For each SDCLKoutY being used in SYNC/SYSREF                                     | 30   |
| • | Deleted "SDCLKoutY_PD as required per output. " in Table 1                             | 30   |
| • | Added footnote starting SDCLKoutY_PD = 0 as in Table 1                                 | 36   |
| • | Added SDCLKout1_PD = 0, SDCLKout3_PD = 0 in Setup of SYSREF Example                    | 3    |
| • | Changed DLD_HOLD_CNT to HOLDOVER_DLD_CNT in Holdover Mode - Automatic Exit of Holdover | 4!   |
| • | Changed Recommended Programming Sequence   | 49   |
| • | Added 0x171/0x172 to Register Map  | 5    |
| • | Added LMK04821 register setting  | 5    |
| • | Revised Register 0x143 table   | 6    |
| • | Added fixed register setting for 0x171   | 68   |
|   |  |      |



# **Revision History (continued)**

| _ |  | _  |
|---|--|----|
| • | Changed RB_PLL2_LD description         | 92 |
| • | Changed RB_PLL1_LD description         | 92 |
| • | Added LMK04821 register setting        | 92 |
| • | Added LMK04821 register setting        | 91 |
| • | Added fixed register setting for 0x172 | 68 |

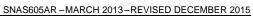
# Changes from Revision AP (June 2013) to Revision AQ

# Page

| • | Changed data sheet flow and layout to conform with new TI standards. Added, updated, or renamed the following sections: Device Information Table, Application and Implementation; Power Supply Recommendations; Layout; Device and Documentation Support; Mechanical, Packaging, and Ordering Information | 1  |
|---|---|----|
| • | Added values for LMK04821 under "Features" section.   |    |
| • | Changed LMK04820 family to LMK0482x family  |    |
| • | Added values for LMK04821 in Device Configuration Information   |    |
| • | Added holdover DAC to pin 36 description in Pin Functions   |    |
| • | Changed Thermal Information header from LMK0482xB to LMK0482x   |    |
| • | Changed CLKinX_BUF_TYPE to CLKinX_TYPE in Electrical Characteristics  |    |
| • | Added values for LMK04821 under Internal VCO Specifications in Electrical Characteristics   |    |
| • | Added values for LMK04821 under Noise Floor in Electrical Characteristics   |    |
| • | Added values for LMK04821 under CLKout Closed Loop Phase Noise Specifications a Commercial Quality VCXO in Electrical Characteristics   |    |
| • | Added 245.76 MHz as frequency for LMK04826B phase noise data L(f) <sub>CLKout</sub> for VCO0  | 16 |
| • | Added 245.76 MHz as frequency for LMK04826B phase noise data L(f) <sub>CLKout</sub> for VCO1  | 16 |
| • | Added 245.76 MHz as frequency for LMK04828B phase noise data L(f) <sub>CLKout</sub> for VCO0  | 16 |
| • | Added 245.76 MHz as frequency for LMK04828B phase noise data L(f) <sub>CLKout</sub> for VCO1  |    |
| • | Added values for LMK04821 under CLKout Closed Loop Jitter Specifications a Commercial Quality VCXO  | 17 |
| • | Added SDCLKoutY_HS = 0 for ts <sub>JESD204B</sub> in Electrical Characteristics   | 19 |
| • | Added Propagation Delay from CLKin0 to SDCLKoutY in Electrical Characteristics  | 19 |
| • | Added footnote that LMK04821 has no DCLKoutX or SDCLKoutY outputs on at power up, only OSCout   | 19 |
| • | Changed $V_{OH}$ TEST CONDITIONS to = 3 or 4 and $V_{OL}$ TEST CONDITIONS to 3, 4, or 6 under DIGITAL OUTPUTS (CLKin_SELX, Status_LDX, and RESET/GPO) subheading in Electrical Characteristics  | 21 |
| • | Changed Digital Inputs (SCK, SDIO, CS*) I <sub>IH</sub> V <sub>IH</sub> = VCC min line from 5 μA to –5 μA   | 22 |
| • | Added 4 wire mode read back has same timing as SDIO pin, R/W bit = 0 is for SPI write, R/W bit = 1 is for SPI read, W1 and W0 shall be written as 0.  | 23 |
| • | Added LMK04821 phase noise graphs under Clock Output AC Characteristics   | 24 |
| • | Added link to AN-912 Application Report   | 27 |
| • | Changed from Glitchless Half Shift to Glitchless Half Step  | 30 |
| • | Added LMK04821 detailed block diagram   | 32 |
| • | Changed block from SDCLKoutY_POL to DCLKoutX_POL in Figure 12   | 34 |
| • | Added SYSREF_CLKin0_MUX block to Figure 13 image.   | 35 |
| • | Changed Figure 13 to show that FB_MUX SYSREF input comes from SYSREF Divider, not SYSREF_MUX  | 35 |
| • | Changed term pulsor to pulser throughout  | 36 |
| • | Changed DCLKout0_1_DIV to DCLKout0_DIV; DCLKout2_3_DIV to DCLKout2_DIV; DCLKout4_5_DIV to DCLKout4_DIV  | 37 |
| • | Added DCLKout4_DIV = 20   | 37 |
| • | Added DCLKout0_DDLY_PD = 0, DCLKout2_DDLY_PD = 0, DCLKout4_DDLY_PD = 0  | 37 |
| • | Changed text to read, Set device clock and SYSREF divider digital delays: DCLKout0_DDLY_CNTH,   |    |



|   | DCLKout0_DDLY_CNTL, DCLKout2_DDLY_CNTH, DCLKout2_DDLY_CNTL, DCLKout4_DDLY_CNTH, DCLKout4_DDLY_CNTL, SYSREF_DDLY  | 37  |
|---|--|---|
| •                                       | Added = 1 in SYSREF Request  |   |
| •                                       | Changed step numbers in dynamic delay and references to steps to be correct, step 8 was duplicated   |   |
| •                                       | Added note LMK04821 includes VCO1 divider on VCO1 output.  |   |
| •                                       | Added note LMK04821 includes VCO1 divider on VCO1 output   |   |
| •                                       | Added R/W bit = 0 is for SPI write. R/W bit = 1 is for SPI read.   |   |
| •                                       | Added If using LMK04821, program register 0x174 in Recommended Programming Sequence  |   |
| •                                       | Added SYSREF_CLKin0_MUX and VCO1_DIV to register map   |   |
| •                                       | Added CLKin_OVERRIDE bit to register map   |   |
| •                                       | Changed from half shift to half step.  |   |
| •                                       | Changed definition of SDCLKoutY_DDLY value of 0 from Reserved to Bypass  |   |
| •                                       | Changed from Sets the polarity of SYSREF clocks to Sets the polarity of clock on SDCLKoutY when device clock output is selected with SDCLKoutY_MUX   |   |
| •                                       | Changed Sets the polarity of the device clocks to Sets the polarity of the device clocks from the DCLKoutX outputs   |   |
| •                                       | Added LMK04821 DCLKoutX_FMT power on reset values as powerdown   |   |
| •                                       | Changed from SYSREF to SYSREF Divider in Source column of Register 0x13F   |   |
| •                                       | Changed reserved to Off for CLKin1_OUT_MUX   |   |
| •                                       | Changed reserved to Off for CLKin0_OUT_MUX.  |   |
| •                                       | Added CLKin_OVERRIDE bit   | 76  |
| •                                       | Added LMK04821 register 0x174 for VCO1_DIV   | 91  |
| •                                       | Deleted LMK04828 from Core line  |   |
| •                                       | Added VCO1 Icc including VCO1 Divider for LMK04821   |   |
|   | S .  |   |
| _                                       | Changed VCO1 Icc and power dissipated for LMK04828B/26B from 6 mA to 13.5 mA and 19.8 mW to 44.55 mW   | 102   |
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| • | Changed datasheet title from LMK04828 to LMK0482xB  Changed LMK04828 family to LMK04820 family  Changed image from LMK04828B to LMK0482xB  Added LMK04826 to Device Configuration Information table  Changed - increased LMK04828B VCO0 max frequency from 2600 MHz to 2630 MHz.  Changed - expanded LMK04828B VCO1 frequency range from 2945 - 3005 MHz to 2920 MHz - 3080 MHz.  Changed Thermal Information header from LMK04828B to LMK0482xB  Added LMK04826 VCO Range Specification  Changed - increased LMK04828B VCO0 max frequency from 2600 MHz to 2630 MHz.  Changed - increased LMK04828B VCO0 max frequency from 2600 MHz to 2630 MHz.  Changed - expanded LMK04828B VCO1 frequency range from 2945 - 3005 MHz to 2920 MHz - 3080 MHz.  Added LMK04826 K <sub>VCO</sub> specification  Added LMK04826 K <sub>VCO</sub> specification vs LMK04826 specification for K <sub>VCO</sub> Added LMK04826 noise floor data  Changed - clarified phase noise data section header | Page 11 13 13 14 15 16 16 17 18 18 18 18 18 18 18 18 18 18 18 18 18 |
| • | Changed datasheet title from LMK04828 to LMK0482xB   | Page 11 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1                           |
| • | Changed datasheet title from LMK04828 to LMK0482xB   | Page 11 13 13 14 16 17 17 18 18 18 18 18 18 18 18 18 18 18 18 18    |
| • | Changed datasheet title from LMK04828 to LMK0482xB   | Page 11   |
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|   | Changed datasheet title from LMK04828 to LMK0482xB   | Page 11   |





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| • | Changed LMK04828 to LMK0482xB in VCXO/Crystal Buffered Output  | . 28 |
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| • | Changed LMK04828 to LMK0482xB in Status Pins   | . 31 |
| • | Changed image from LMK04828 to LMK0482xB   | . 46 |
| • | Changed - corrected value of PLL2_P selection to be 0 to correspond with register programming definition | . 46 |
| • | Changed image from LMK04828 to LMK0482xB   | . 47 |
| • | Changed image from LMK04828 to LMK0482xB   | . 48 |
| • | Added LMK04826 register setting  | . 55 |
| • | Added LMK04826 register setting  | . 91 |
| • | Added LMK04826 register setting  | . 92 |
|   |  |      |

Submit Documentation Feedback

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# 5 Device Comparison Table

# 5.1 Device Configuration Information

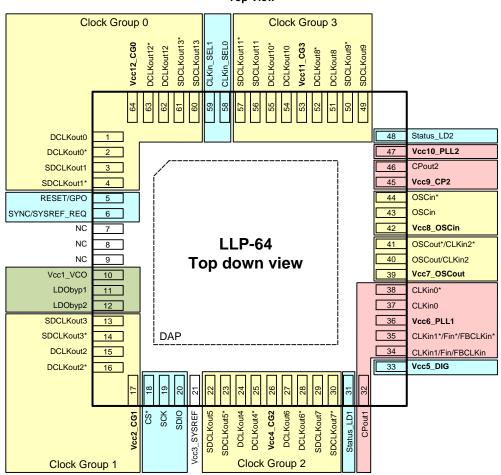
| PART NUMBER | REF-<br>ERENCE<br>INPUTS <sup>(1)</sup> | OSCout (BUFFERED<br>OSCin Clock) LVDS/<br>LVPECL/ LVCMOS (1) | PLL2<br>PROGRAMMABLE<br>LVDS/LVPECL/HSDS<br>OUTPUTS | VCO0 FREQUENCY   | VCO1 FREQUENCY                    |
|-------------|---|--|---|------------------|-----------------------------------|
|             |   | Up to 1  | 14  | 1930 to 2075 MHz | VCO1_DIV = ÷2<br>1460 to 1540 MHz |
|             | Up to 3                                 |  |   |                  | VCO1_DIV = ÷3<br>974 to 1026 MHz  |
|             |   |  |   |                  | VCO1_DIV = ÷4<br>730 to 770 MHz   |
| LMK04821    |   |  |   |                  | VCO1_DIV = ÷5<br>584 to 616 MHz   |
|             |   |  |   |                  | VCO1_DIV = ÷6<br>487 to 513 MHz   |
|             |   |  |   |                  | VCO1_DIV = ÷7<br>418 to 440 MHz   |
|             |   |  |   |                  | VCO1_DIV = ÷8<br>365 to 385 MHz   |
| LMK04826B   | Up to 3                                 | Up to 1  | 14  | 1840 to 1970 MHz | 2440 to 2505 MHz                  |
| LMK04828B   | Up to 3                                 | Up to 1  | 14  | 2370 to 2630 MHz | 2920 to 3080 MHz                  |

<sup>(1)</sup> OSCout may also be third clock input, CLKin2.



# 6 Pin Configuration and Functions

### NKD Package 64-Pin WQFN Top View



### **Pin Functions**

| PIN      |                          |          |              | DECODINE (4)  |  |
|----------|--------------------------|----------|--------------|---|--|
| NO. NAME |                          | l/O TYPE |              | DESCRIPTION <sup>(1)</sup>  |  |
| 1, 2     | DCLKout0,<br>DCLKout0*   | 0        | Programmable | Device clock output 0.  |  |
| 3, 4     | SDCLKout1,<br>SDCLKout1* | 0        | Programmable | SYSREF / Device clock output 1  |  |
| 5        | RESET/GPO                | - 1      | CMOS         | Device reset input or GPO   |  |
| 6        | SYNC/SYSREF_REQ          | I        | CMOS         | Synchronization input or SYSREF_REQ for requesting continuous SYSREF. |  |
| 7, 8, 9  | NC                       |          |              | Do not connect. These pins must be left floating.                     |  |
| 10       | Vcc1_VCO                 |          | PWR          | Power supply for VCO LDO.   |  |
| 11       | LDObyp1                  |          | ANLG         | LDO Bypass, bypassed to ground with 10-µF capacitor.                  |  |
| 12       | LDObyp2                  |          | ANLG         | LDO Bypass, bypassed to ground with a 0.1-µF capacitor.               |  |
| 13, 14   | SDCLKout3,<br>SDCLKout3* | 0        | Programmable | SYSREF / Device Clock output 3.                                       |  |
| 15, 16   | DCLKout2,<br>DCLKout2*   | 0        | Programmable | Device clock output 2.  |  |
| 17       | Vcc2_CG1                 |          | PWR          | Power supply for clock outputs 2 and 3.                               |  |
| 18       | CS*                      | I        | CMOS         | Chip Select   |  |
| 19       | SCK                      | I        | CMOS         | SPI Clock   |  |

(1) See Pin Connection Recommendations for recommended connections.



# Pin Functions (continued)

|        | PIN                        |     |              |  |  |
|--------|----------------------------|-----|--------------|--|--|
| NO.    | NAME                       | 1/0 | TYPE         | DESCRIPTION <sup>(1)</sup>                                       |  |
| 20     | SDIO                       | I/O | CMOS         | SPI Data   |  |
| 21     | Vcc3_SYSREF                | 1/0 | PWR          | Power supply for SYSREF divider and SYNC.                        |  |
| 22, 23 | SDCLKout5,<br>SDCKLout5*   | 0   | Programmable | SYSREF / Device clock output 5.                                  |  |
| 24, 25 | DCLKout4,<br>DCLKout4*     | 0   | Programmable | Device clock output 4.   |  |
| 26     | Vcc4_CG2                   |     | PWR          | Power supply for clock outputs 4, 5, 6 and 7.                    |  |
| 27, 28 | DCLKout6,<br>DCLKout6*     | 0   | Programmable | Device clock output 6.   |  |
| 29, 30 | SDCLKout7,<br>SDCLKout7*   | 0   | Programmable | SYSREF / Device clock output 7.                                  |  |
| 31     | Status_LD1                 | I/O | Programmable | Programmable status pin.   |  |
| 32     | CPout1                     | 0   | ANLG         | Charge pump 1 output.  |  |
| 33     | Vcc5_DIG                   |     | PWR          | Power supply for the digital circuitry.                          |  |
|        | CLKin1, CLKin1*            | 1   | ANLG         | Reference Clock Input Port 1 for PLL1.                           |  |
| 34, 35 | FBCLKin,<br>FBCLKin*       | 1   | ANLG         | Feedback input for external clock feedback input (0–delay mode). |  |
|        | Fin, Fin*                  | ı   | ANLG         | External VCO Input (External VCO mode).                          |  |
| 36     | Vcc6_PLL1                  |     | PWR          | Power supply for PLL1, charge pump 1, holdover DAC               |  |
| 37, 38 | CLKin0, CLKin0*            | 1   | ANLG         | Reference Clock Input Port 0 for PLL1.                           |  |
| 39     | Vcc7_OSCout                |     | PWR          | Power supply for OSCout port.                                    |  |
| 40.44  | OSCout, OSCout*            | 1/0 |              | Buffered output of OSCin port.                                   |  |
| 40, 41 | CLKin2, CLKin2*            | I/O | Programmable | Reference Clock Input Port 2 for PLL1.                           |  |
| 42     | Vcc8_OSCin                 |     | PWR          | Power supply for OSCin   |  |
| 43, 44 | OSCin, OSCin*              | - 1 | ANLG         | Feedback to PLL1, Reference input to PLL2. AC coupled.           |  |
| 45     | Vcc9_CP2                   |     | PWR          | Power supply for PLL2 Charge Pump.                               |  |
| 46     | CPout2                     | 0   | ANLG         | Charge pump 2 output.  |  |
| 47     | Vcc10_PLL2                 |     | PWR          | Power supply for PLL2.   |  |
| 48     | Status_LD2                 | I/O | Programmable | Programmable status pin.   |  |
| 49, 50 | SDCLKout9,<br>SDCLKout9*   | 0   | Programmable | SYSREF / Device clock 9  |  |
| 51, 52 | DCLKout8,<br>DCLKout8*     | 0   | Programmable | Device clock output 8.   |  |
| 53     | Vcc11_CG3                  |     | PWR          | Power supply for clock outputs 8, 9, 10, and 11.                 |  |
| 54, 55 | DCLKout10,<br>DCLKout10*   | 0   | Programmable | Device clock output 10.  |  |
| 56, 57 | SDCLKout11,<br>SDCLKout11* | 0   | Programmable | SYSREF / Device clock output 11.                                 |  |
| 58     | CLKin_SEL0                 | I/O | Programmable | Programmable status pin.   |  |
| 59     | CLKin_SEL1                 | I/O | Programmable | Programmable status pin.   |  |
| 60, 61 | SDCLKout13,<br>SDCLKout13* | 0   | Programmable | SYSREF / Device clock output 13.                                 |  |
| 62, 63 | DCLKout12,<br>DCLKout12*   | 0   | Programmable | Device clock output 12.  |  |
| 64     | Vcc12_CG0                  |     | PWR          | Power supply for clock outputs 0, 1, 12, and 13.                 |  |
| DAP    | DAP                        |     | GND          | DIE ATTACH PAD, connect to GND.                                  |  |



# 7 Specifications

# 7.1 Absolute Maximum Ratings

over operating free-air temperature range (unless otherwise noted) (1)

|                  |  | MIN  | MAX                     | UNIT |
|------------------|--|------|-------------------------|------|
| V <sub>CC</sub>  | Supply voltage (2)   | -0.3 | 3.6                     | V    |
| V <sub>IN</sub>  | Input voltage  | -0.3 | (V <sub>CC</sub> + 0.3) | V    |
| $T_L$            | Lead temperature (solder 4 seconds)  |      | 260                     | ٥    |
| $T_{J}$          | Junction temperature   |      | 150                     | ů    |
| I <sub>IN</sub>  | Differential input current (CLKinX/X*, OSCin/OSCin*, FBCLKin/FBCLKin*, Fin/Fin*) |      | ± 5                     | mA   |
| MSL              | Moisture sensitivity level   |      | 3                       |      |
| T <sub>stg</sub> | Storage temperature  | -65  | 150                     | °C   |

<sup>(1)</sup> Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. These are stress ratings only, which do not imply functional operation of the device at these or any other conditions beyond those indicated under Recommended Operating Conditions. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

### 7.2 ESD Ratings

|                    |                         |   | VALUE | UNIT |
|--------------------|-------------------------|---|-------|------|
|                    | Electrostatic discharge | Human-body model (HBM), per ANSI/ESDA/JEDEC JS-001 <sup>(1)</sup>   | ±2000 |      |
| V(ECD)             |                         | Machine Model (MM)  | ±150  | V    |
| V <sub>(ESD)</sub> |                         | Charged-device model (CDM), per JEDEC specification JESD22-C101 (2) | ±250  | ·    |

<sup>(1)</sup> JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process. Manufacturing with less than 500-V HBM is possible with the necessary precautions. Pins listed as ±2000 V may actually have higher performance.

### 7.3 Recommended Operating Conditions

over operating free-air temperature range (unless otherwise noted)

|           |   | MIN  | TYP | MAX  | UNIT |
|-----------|---|------|-----|------|------|
| $T_J$     | Junction Temperature                      |      |     | 125  | °C   |
| $T_A$     | Ambient Temperature                       | -40  | 25  | 85   | °C   |
| $T_{PCB}$ | PCB Temperature (measured at thermal pad) |      |     | 105  | °C   |
| $V_{CC}$  | Supply Voltage                            | 3.15 | 3.3 | 3.45 | V    |

### 7.4 Thermal Information

|                      |   | LMK0482x   |      |
|----------------------|---|------------|------|
|                      | THERMAL METRIC <sup>(1)</sup>                       | NKD (WQFN) | UNIT |
|                      |   | 64 PINS    |      |
| $R_{\theta JA}$      | Junction-to-ambient thermal resistance (2)          | 24.3       | °C/W |
| $R_{\theta JC(top)}$ | Junction-to-case (top) thermal resistance (3)       | 6.1        | °C/W |
| $R_{\theta JB}$      | Junction-to-board thermal resistance <sup>(4)</sup> | 3.5        | °C/W |

For more information about traditional and new thermal metrics, see the Semiconductor and IC Package Thermal Metrics application report (SPRA953).

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<sup>(2)</sup> Never to exceed 3.6 V.

<sup>(2)</sup> JEDEC document JEP157 states that 250-V CDM allows safe manufacturing with a standard ESD control process. Manufacturing with less than 250-V CDM is possible with the necessary precautions. Pins listed as ±250 V may actually have higher performance.

<sup>(2)</sup> The junction-to-ambient thermal resistance under natural convection is obtained in a simulation on a JEDEC-standard, High-K board, as specified in JESD51-7, in an environment described in JESD51-2a.

<sup>(3)</sup> The junction-to-case(top) thermal resistance is obtained by simulating a cold plate test on the package top. No specific JEDEC-standard test exists, but a close description can be found in the ANSI SEMI standard G30-88.

<sup>(4)</sup> The junction-to-board thermal resistance is obtained by simulating in an environment with a ring cold plate fixture to control the PCB temperature, as described in JESD51-8.



### Thermal Information (continued)

|                      |   | LMK0482x   |      |
|----------------------|---|------------|------|
|                      | THERMAL METRIC <sup>(1)</sup>                             | NKD (WQFN) | UNIT |
|                      |   | 64 PINS    |      |
| ΨЈТ                  | Junction-to-top characterization parameter <sup>(5)</sup> | 0.1        | °C/W |
| ΨЈВ                  | Junction-to-board characterization parameter (6)          | 3.5        | °C/W |
| $R_{\theta JC(bot)}$ | Junction-to-case (bottom) thermal resistance (7)          | 0.7        | °C/W |

- The junction-to-top characterization parameter, Ψ<sub>JT</sub>, estimates the junction temperature of a device in a real system and is extracted from the simulation data for obtaining R<sub>θ,JA</sub>, using a procedure described in JESD51-2a (sections 6 and 7).
- (6) The junction-to-board characterization parameter, Ψ<sub>JB</sub> estimates the junction temperature of a device in a real system and is extracted from the simulation data for obtaining R<sub>θJA</sub> , using a procedure described in JESD51-2a (sections 6 and 7).
- (7) The junction-to-case(bottom) thermal resistance is obtained by simulating a cold plate test on the exposed (power) pad. No specific JEDEC standard test exists, but a close description can be found in the ANSI SEMI standard G30-88.

### 7.5 Electrical Characteristics

 $(3.15 \text{ V} < \text{V}_{CC} < 3.45 \text{ V}, -40 ^{\circ}\text{C} < \text{T}_{A} < 85 ^{\circ}\text{C}$  and  $\text{T}_{PCB} \le 105 ^{\circ}\text{C}$ . Typical values at  $\text{V}_{CC} = 3.3 \text{ V}, \text{T}_{A} = 25 ^{\circ}\text{C}$ , at the Recommended Operating Conditions and are **not** assured.)

|                                     | PARAMETER  | TEST CONDITIONS  | MIN   | TYP | MAX      | UNIT |
|-------------------------------------|--|--|-------|-----|----------|------|
| <b>CURRENT CO</b>                   | NSUMPTION  |  |       |     |          |      |
| I <sub>CC_PD</sub>                  | Power Down Supply Current                                    |  |       | 1   | 3        | mA   |
| I <sub>CC_CLKS</sub>                | Supply Current <sup>(1)</sup>                                | 14 HSDS 8 mA clocks enabled PLL1 and PLL2 locked.                                  |       | 565 | 665      | mA   |
| CLKin0/0*, CL                       | Kin1/1*, and CLKin2/2* INPUT CLOCK S                         | PECIFICATIONS  | ·     |     |          |      |
| f <sub>CLKin</sub>                  | Clock Input Frequency  |  | 0.001 |     | 750      | MHz  |
| SLEW <sub>CLKin</sub>               | Clock Input Slew Rate (2)                                    | 20% to 80%   | 0.15  | 0.5 |          | V/ns |
| V <sub>ID</sub> CLKin               | Clock Input  |  | 0.125 |     | 1.55     | V    |
| V <sub>SS</sub> CLKin               | Differential Input Voltage <sup>(3)</sup> Figure 8           | AC coupled   | 0.25  |     | 3.1      | Vpp  |
| $V_{CLKin}$                         | Clock Input<br>Single-ended Input Voltage                    | AC coupled to CLKinX;<br>CLKinX* AC coupled to Ground<br>CLKinX_TYPE = 0 (Bipolar) | 0.25  |     | 2.4      | Vpp  |
|                                     |  | AC coupled to CLKinX;<br>CLKinX* AC coupled to Ground<br>CLKinX_TYPE = 1 (MOS)     | 0.35  |     | 2.4      | Vpp  |
|                                     | DC offset voltage between CLKinX/CLKinX* (CLKinX* - CLKinX)  | Each pin AC coupled, CLKin0/1/2<br>CLKinX_TYPE = 0 (Bipolar)                       |       | 0   |          | mV   |
| V <sub>CLKinX-offset</sub>          |  | Each pin AC coupled, CLKin0/1<br>CLKinX_TYPE = 1 (MOS)                             |       | 55  |          | mV   |
|                                     | DC offset voltage between CLKin2/CLKin2* (CLKin2* - CLKin2)  | Each pin AC coupled CLKinX_TYPE = 1 (MOS)  |       | 20  |          | mV   |
| V <sub>CLKin-</sub> V <sub>IH</sub> | High input voltage   | DC coupled to CLKinX;  | 2.0   |     | $V_{CC}$ | V    |
| V <sub>CLKin-</sub> V <sub>IL</sub> | Low input voltage  | CLKinX* AC coupled to Ground CLKinX_TYPE = 1 (MOS)                                 | 0.0   |     | 0.4      | ٧    |
| FBCLKin/FBC                         | LKin* and Fin/Fin* INPUT SPECIFICATION                       | ONS  |       |     |          |      |
| f <sub>FBCLKin</sub>                | Clock Input Frequency for<br>0-delay with external feedback. | AC coupled CLKinX_TYPE = 0 (Bipolar)   | 0.001 |     | 750      | MHz  |
| f <sub>Fin</sub>                    | Clock Input Frequency for external VCO or distribution mode. | AC coupled <sup>(4)</sup><br>CLKinX_TYPE = 0 (Bipolar)                             | 0.001 |     | 3100     | MHz  |

- (1) See the applications section of *Power Supply Recommendations* for Icc for specific part configuration and how to calculate Icc for a specific design.
- (2) In order to meet the jitter performance listed in the subsequent sections of this data sheet, the minimum recommended slew rate for all input clocks is 0.5 V/ns. This is especially true for single-ended clocks. Phase noise performance will begin to degrade as the clock input slew rate is reduced. However, the device will function at slew rates down to the minimum listed. When compared to single-ended clocks, differential clocks (LVDS, LVPECL) will be less susceptible to degradation in phase noise performance at lower slew rates due to their common mode noise rejection. However, it is also recommended to use the highest possible slew rate for differential clocks to achieve optimal phase noise performance at the device outputs.
- 3) See Differential Voltage Measurement Terminology for definition of V<sub>ID</sub> and V<sub>OD</sub> voltages.
- (4) Assured by characterization. ATE tested at 2949.12 MHz.



(3.15 V <  $V_{CC}$  < 3.45 V, -40 °C <  $T_A$  < 85 °C and  $T_{PCB}$  ≤ 105 °C. Typical values at  $V_{CC}$  = 3.3 V,  $T_A$  = 25 °C, at the Recommended Operating Conditions and are **not** assured.)

|                                       | PARAMETER  | TEST CONDITIONS   | MIN  | TYP         | MAX  | UNIT    |
|---------------------------------------|--|---|------|-------------|------|---------|
| V <sub>FBCLKin/Fin</sub>              | Single Ended<br>Clock Input Voltage                                | AC coupled CLKinX_TYPE = 0 (Bipolar)  | 0.25 |             | 2.0  | Vpp     |
| SLEW <sub>FBCLKin/Fin</sub>           | Slew Rate on CLKin (2)   | AC coupled; 20% to 80%; (CLKinX_TYPE = 0)                                       | 0.15 | 0.5         |      | V/ns    |
| PLL1 SPECIFICA                        | ATIONS   |   |      |             |      |         |
| f <sub>PD1</sub>                      | PLL1 Phase Detector Frequency                                      |   |      |             | 40   | MHz     |
|                                       |  | $V_{CPout1} = V_{CC}/2$ , PLL1_CP_GAIN = 0                                      |      | 50          |      |         |
|                                       |  | V <sub>CPout1</sub> = V <sub>CC</sub> /2, PLL1_CP_GAIN = 1                      |      | 150         |      |         |
| I <sub>CPout1</sub> SOURCE            | PLL1 Charge  | $V_{CPout1} = V_{CC}/2$ , PLL1_CP_GAIN = 2                                      |      | 250         |      |         |
| ICPout1300RGE                         | Pump Source Current (5)  |   |      |             |      | μA      |
|                                       |  | $V_{CPout1} = V_{CC}/2$ , PLL1_CP_GAIN = 14                                     |      | 1450        |      |         |
|                                       |  | V <sub>CPout1</sub> = V <sub>CC</sub> /2, PLL1_CP_GAIN = 15                     |      | 1550        |      |         |
|                                       |  | V <sub>CPout1</sub> =V <sub>CC</sub> /2, PLL1_CP_GAIN = 0                       |      | <b>-</b> 50 |      |         |
|                                       |  | V <sub>CPout1</sub> =V <sub>CC</sub> /2, PLL1_CP_GAIN = 1                       |      | -150        |      |         |
| I CINIZ                               | PLL1 Charge  | V <sub>CPout1</sub> =V <sub>CC</sub> /2, PLL1_CP_GAIN = 2                       |      | -250        |      |         |
| I <sub>CPout1</sub> SINK              | Pump Sink Current (5)  |   |      |             |      | μA      |
|                                       |  | V <sub>CPout1</sub> =V <sub>CC</sub> /2, PLL1_CP_GAIN = 14                      |      | -1450       |      |         |
|                                       |  | V <sub>CPout1</sub> =V <sub>CC</sub> /2, PLL1_CP_GAIN = 15                      |      | -1550       |      |         |
| I <sub>CPout1</sub> %MIS              | Charge Pump<br>Sink / Source Mismatch                              | V <sub>CPout1</sub> = V <sub>CC</sub> /2, T = 25 °C                             |      | 1%          | 10%  |         |
| I <sub>CPout1</sub> V <sub>TUNE</sub> | Magnitude of Charge Pump Current Variation vs. Charge Pump Voltage | 0.5 V < V <sub>CPout1</sub> < V <sub>CC</sub> - 0.5 V<br>T <sub>A</sub> = 25 °C |      | 4%          |      |         |
| I <sub>CPout1</sub> %TEMP             | Charge Pump Current vs. Temperature Variation                      |   |      | 4%          |      |         |
| I <sub>CPout1</sub> TRI               | Charge Pump TRI-STATE Leakage<br>Current                           | 0.5 V < V <sub>CPout</sub> < V <sub>CC</sub> - 0.5 V                            |      |             | 5    | nA      |
|                                       | PLL 1/f Noise at 10 kHz offset.                                    | PLL1_CP_GAIN = 350 μA   |      | -117        |      |         |
| PN10kHz                               | Normalized to 1 GHz Output<br>Frequency                            | PLL1_CP_GAIN = 1550 μA  |      | -118        |      | dBc/Hz  |
| PN1Hz                                 | Normalized Phase Noise Contribution                                | PLL1_CP_GAIN = 350 μA   |      | -221.5      |      | dBc/Hz  |
| FINITIZ                               | Normalized Friase Noise Contribution                               | PLL1_CP_GAIN = 1550 μA  |      | -223        |      | UDC/11Z |
| PLL2 REFEREN                          | CE INPUT (OSCin) SPECIFICATIONS                                    |   |      |             |      |         |
| f <sub>OSCin</sub>                    | PLL2 Reference Input <sup>(6)</sup>                                |   |      |             | 500  | MHz     |
| SLEW <sub>OSCin</sub>                 | PLL2 Reference Clock minimum slew rate on OSCin <sup>(2)</sup>     | 20% to 80%  | 0.15 | 0.5         |      | V/ns    |
| V <sub>OSCin</sub>                    | Input Voltage for OSCin or OSCin*                                  | AC coupled; Single-ended<br>(Unused pin AC coupled to GND)                      | 0.2  |             | 2.4  | Vpp     |
| V <sub>ID</sub> OSCin                 | Differential voltage swing   | A   | 0.2  |             | 1.55 | V       |
| V <sub>SS</sub> OSCin                 | Figure 8   | AC coupled  | 0.4  |             | 3.1  | Vpp     |
|                                       | DC offset voltage between  | Each pin AC coupled   |      | 20          |      | mV      |
| V <sub>OSCin-offset</sub>             | OSCin/OSCin* (OSCinX* - OSCinX)                                    |   |      |             |      |         |

<sup>(5)</sup> This parameter is programmable

<sup>(6)</sup> F<sub>OSCin</sub> maximum frequency assured by characterization. Production tested at 122.88 MHz.

<sup>7)</sup> Assured by characterization. ATE tested at 122.88 MHz.

<sup>(8)</sup> The EN\_PLL2\_REF\_2X bit enables/disables a frequency doubler mode for the PLL2 OSCin path.



 $(3.15 \text{ V} < \text{V}_{CC} < 3.45 \text{ V}, -40 ^{\circ}\text{C} < \text{T}_{A} < 85 ^{\circ}\text{C}$  and  $\text{T}_{PCB} \le 105 ^{\circ}\text{C}$ . Typical values at  $\text{V}_{CC} = 3.3 \text{ V}, \text{T}_{A} = 25 ^{\circ}\text{C}$ , at the Recommended Operating Conditions and are **not** assured.)

|                           | PARAMETER  | TEST CONDITIONS  | MIN TY | P MAX      | UNIT    |
|---------------------------|--|--|--------|------------|---------|
| CRYSTAL OSC               | ILLATOR MODE SPECIFICATIONS  |  |        |            |         |
| F <sub>XTAL</sub>         | Crystal Frequency Range  | Fundamental mode crystal ESR = 200 $\Omega$ (10 to 30 MHz) ESR = 125 $\Omega$ (30 to 40 MHz)                                     | 10     | 40         | MHz     |
| C <sub>IN</sub>           | Input Capacitance of OSCin port                                    | -40 to 85 °C   |        | 1          | pF      |
| PLL2 PHASE D              | ETECTOR and CHARGE PUMP SPECII                                     | FICATIONS  |        |            |         |
| f <sub>PD2</sub>          | Phase Detector Frequency (7)                                       |  |        | 155        | MHz     |
|                           |  | $V_{CPout2}=V_{CC}/2$ , PLL2_CP_GAIN = 0   | 10     | 00         |         |
| I COURCE                  | PLL2 Charge Pump Source Current                                    | V <sub>CPout2</sub> =V <sub>CC</sub> /2, PLL2_CP_GAIN = 1  | 40     | 00         |         |
| I <sub>CPout</sub> SOURCE | (5)  | V <sub>CPout2</sub> =V <sub>CC</sub> /2, PLL2_CP_GAIN = 2  | 160    | 00         | μΑ      |
|                           |  | $V_{CPout2}=V_{CC}/2$ , PLL2_CP_GAIN = 3   | 320    | 00         |         |
|                           | PLL2 Charge Pump Sink Current <sup>(5)</sup>                       | $V_{CPout2}=V_{CC}/2$ , PLL2_CP_GAIN = 0   | -10    | 00         |         |
| I CINIZ                   |  | V <sub>CPout2</sub> =V <sub>CC</sub> /2, PLL2_CP_GAIN = 1  | -40    | 00         |         |
| I <sub>CPout</sub> SINK   |  | $V_{CPout2}=V_{CC}/2$ , PLL2_CP_GAIN = 2   | -160   | 00         | μA      |
|                           |  | $V_{CPout2}=V_{CC}/2$ , PLL2_CP_GAIN = 3   | -320   | 00         |         |
| I <sub>CPout2</sub> %MIS  | Charge Pump Sink/Source Mismatch                                   | $V_{CPout2}=V_{CC}/2$ , $T_A = 25$ °C  | 19     | % 10%      |         |
| $I_{CPout2}V_{TUNE}$      | Magnitude of Charge Pump Current vs. Charge Pump Voltage Variation | $0.5 \text{ V} < \text{V}_{\text{CPout2}} < \text{V}_{\text{CC}} - 0.5 \text{ V}$<br>$\text{T}_{\text{A}} = 25 ^{\circ}\text{C}$ | 49     | %          |         |
| I <sub>CPout2</sub> %TEMP | Charge Pump Current vs. Temperature Variation                      |  | 49     | %          |         |
| I <sub>CPout2</sub> TRI   | Charge Pump Leakage  | 0.5 V < V <sub>CPout2</sub> < V <sub>CC</sub> - 0.5 V  |        | 10         | nA      |
|                           | PLL 1/f Noise at 10 kHz offset (9).                                | PLL2_CP_GAIN = 400 μA  | -11    | 8          |         |
| PN10kHz                   | Normalized to<br>1 GHz Output Frequency                            | PLL2_CP_GAIN = 3200 μA   | -12    | <u>?</u> 1 | dBc/Hz  |
| PN1Hz                     | Normalized Phase Noise Contribution                                | PLL2_CP_GAIN = 400 μA  | -222   | .5         | dBc/Hz  |
| I INTITLE                 | (10)   | PLL2_CP_GAIN = 3200 μA   | -22    | 27         | UDC/11Z |

<sup>(9)</sup> A specification in modeling PLL in-band phase noise is the 1/f flicker noise, L<sub>PLL\_flicker</sub>(f), which is dominant close to the carrier. Flicker noise has a 10 dB/decade slope. PN10kHz is normalized to a 10 kHz offset and a 1 GHz carrier frequency. PN10kHz = L<sub>PLL\_flicker</sub>(10 kHz) - 20log(Fout / 1 GHz), where L<sub>PLL\_flicker</sub>(f) is the single side band phase noise of only the flicker noise's contribution to total noise, L(f). To measure L<sub>PLL\_flicker</sub>(f) it is important to be on the 10 dB/decade slope close to the carrier. A high compare frequency and a clean crystal are important to isolating this noise source from the total phase noise, L(f). L<sub>PLL\_flicker</sub>(f) can be masked by the reference oscillator performance if a low power or noisy source is used. The total PLL in-band phase noise performance is the sum of L<sub>PLL\_flicker</sub>(f) and L<sub>PLL\_flicker</sub>(f).

and L<sub>PLL\_flat</sub>(f).

(10) A specification modeling PLL in-band phase noise. The normalized phase noise contribution of the PLL, L<sub>PLL\_flat</sub>(f), is defined as: PN1HZ=L<sub>PLL\_flat</sub>(f) - 20log(N) - 10log(f<sub>PDX</sub>). L<sub>PLL\_flat</sub>(f) is the single side band phase noise measured at an offset frequency, f, in a 1 Hz bandwidth and f<sub>PDX</sub> is the phase detector frequency of the synthesizer. L<sub>PLL\_flat</sub>(f) contributes to the total noise, L(f).



(3.15 V <  $V_{CC}$  < 3.45 V, -40 °C <  $T_A$  < 85 °C and  $T_{PCB}$  ≤ 105 °C. Typical values at  $V_{CC}$  = 3.3 V,  $T_A$  = 25 °C, at the Recommended Operating Conditions and are not assured.)

|                  | PARAMETER  | TEST CONDITIONS  | MIN TYP  | MAX  | UNIT       |
|------------------|--|--|----------|------|------------|
| INTERNAL         | VCO SPECIFICATIONS   |  |          |      |            |
|                  | LMICOADOA VOO Turing Dange                                 | VCO0   | 1930     | 2075 | N41.1-     |
|                  | LMK04821 VCO Tuning Range                                  | VCO1 (11)  | 2920     | 3080 | MHz        |
|                  | LMIZO4826 VCO Tuning Dongs                                 | VCO0   | 1840     | 1970 | MHz        |
| $f_{VCO}$        | LMK04826 VCO Tuning Range                                  | VCO1   | 2440     | 2505 | IVIHZ      |
|                  | LMI/04929 VCO Tuning Dongs                                 | VCO0   | 2370     | 2630 | MHz        |
|                  | LMK04828 VCO Tuning Range                                  | VCO1   | 2920     | 3080 | IVITZ      |
|                  | LMK04004 Fine Tuning Consists it                           | LMK04821 VCO0  | 12 to 20 |      | NAL 1- 0.7 |
|                  | LMK04821 Fine Tuning Sensitivity                           | LMK04821 VCO1  | 15 to 24 |      | MHz/V      |
| V                | LMIZO4826 Fine Tuning Consistivity                         | LMK04826 VCO0  | 11 to 19 |      | NAL I A. / |
| K <sub>VCO</sub> | LMK04826 Fine Tuning Sensitivity                           | LMK04826 VCO1  | 8 to 11  |      | MHz/V      |
|                  | LMK04000 Fine Tuning Consists it.                          | LMK04828 VCO0 at 2457.6 MHz  | 17 to 27 |      | NAL 1- 0.7 |
|                  | LMK04828 Fine Tuning Sensitivity                           | LMK04828 VCO1 at 2949.12 MHz   | 17 to 23 |      | MHz/V      |
| ΔT <sub>CL</sub> | Allowable Temperature Drift for<br>Continuous Lock<br>(12) | After programming for lock, no changes to output configuration are permitted to assure continuous lock |          | 125  | °C         |

<sup>(11)</sup> The VCO1 divider, VCO1\_DIV in register 0x174, can be programmed to ÷2 to ÷8 resulting in a lower effective VCO frequency range as shown in Device Configuration Information.

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<sup>(12)</sup> Maximum Allowable Temperature Drift for Continuous Lock is how far the temperature can drift in either direction from the value it was at the time that the 0x168 register was last programmed with PLL2\_FCAL\_DIS = 0, and still have the part stay in lock. The action of programming the 0x168 register, even to the same value, activates a frequency calibration routine. This implies the part will work over the entire frequency range, but if the temperature drifts more than the maximum allowable drift for continuous lock, then it will be necessary to reload the appropriate register to ensure it stays in lock. Regardless of what temperature the part was initially programmed at, the temperature can never drift outside the frequency range of -40 °C to 85 °C without violating specifications.



 $(3.15 \text{ V} < \text{V}_{CC} < 3.45 \text{ V}, -40 ^{\circ}\text{C} < \text{T}_{A} < 85 ^{\circ}\text{C}$  and  $\text{T}_{PCB} \le 105 ^{\circ}\text{C}$ . Typical values at  $\text{V}_{CC} = 3.3 \text{ V}, \text{T}_{A} = 25 ^{\circ}\text{C}$ , at the Recommended Operating Conditions and are **not** assured.)

|                        | PARAMETER  | TEST       | CONDITIONS               | MIN TYP | MAX | UNIT   |
|------------------------|--|------------|--------------------------|---------|-----|--------|
| NOISE FLOO             | R  |            |                          |         |     |        |
|                        |  |            | LVDS                     | -158.2  |     |        |
|                        |  |            | HSDS 6 mA                | -160    |     |        |
|                        |  |            | HSDS 8 mA                | -161    |     |        |
| L(f) <sub>CLKout</sub> | LMK04821, VCO0, Noise Floor<br>20 MHz Offset <sup>(13)</sup> | 245.76 MHz | HSDS 10 mA               | -161.4  |     | dBc/Hz |
|                        | 20 1411 12 011001  |            | LVPECL16 /w 240 $\Omega$ | -161.6  |     |        |
|                        |  |            | LVPECL20 /w 240 $\Omega$ | -162    |     |        |
|                        |  |            | LVPECL                   | 161.7   |     |        |
|                        |  |            | LVDS                     | -157.1  |     |        |
|                        |  |            | HSDS 6 mA                | -158.3  |     |        |
|                        |  |            | HSDS 8 mA                | -159    |     |        |
| L(f) <sub>CLKout</sub> | LMK04821, VCO1, Noise Floor<br>20 MHz Offset <sup>(13)</sup> | 245.76 MHz | HSDS 10 mA               | -159.2  |     | dBc/Hz |
|                        |  |            | LVPECL16 /w 240 $\Omega$ | -158.8  |     |        |
|                        |  |            | LVPECL20 /w 240 $\Omega$ | -158.9  |     |        |
|                        |  |            | LVPECL                   | -158.8  |     |        |
|                        |  |            | LVDS                     | -158.1  |     |        |
|                        |  |            | HSDS 6 mA                | -159.7  |     |        |
|                        |  |            | HSDS 8 mA                | -160.8  |     |        |
| L(f) <sub>CLKout</sub> | LMK04826, VCO0, Noise Floor<br>20 MHz Offset (14)            | 245.76 MHz | HSDS 10 mA               | -161.3  |     | dBc/Hz |
|                        | 20 1/11 12 011000  |            | LVPECL16 /w 240 $\Omega$ | -161.8  |     |        |
|                        |  |            | LVPECL20 /w 240 $\Omega$ | -162.0  |     |        |
|                        |  |            | LCPECL                   | -161.7  |     |        |
|                        |  |            | LVDS                     | -157.5  |     |        |
|                        |  |            | HSDS 6 mA                | -158.9  |     |        |
|                        |  |            | HSDS 8 mA                | -159.8  |     |        |
| L(f) <sub>CLKout</sub> | LMK04826, VCO1, Noise Floor<br>20 MHz Offset (14)            | 245.76 MHz | HSDS 10 mA               | -160.3  |     | dBc/Hz |
|                        | 25 12 611660   |            | LVPECL16 /w 240 Ω        | -160.8  |     |        |
|                        |  |            | LVPECL20 /w 240 Ω        | -160.7  |     |        |
|                        |  |            | LCPECL                   | -160.7  |     |        |

<sup>(13)</sup> Data collected using a Prodyn BIB-100G balun. Loop filter is C1 = 47 pF, C2 = 3.9 nF, R2 = 620  $\Omega$ , C3 = 10 pF, R3 = 200  $\Omega$ , C4 = 10 pF, R4 = 200  $\Omega$ , PLL1\_CP = 450  $\mu$ A, PLL2\_CP = 3.2 mA.. VCO0 PLL2 loop filter bandwidth = 288 kHz, phase margin = 72 degrees. VCO1 Loop filter loop bandwidth = 221 kHz, phase margin = 70 degrees. CLKoutX\_Y\_IDL = 1, CLKoutX\_Y\_ODL = 0.

<sup>(14)</sup> Data collected using a Prodyn BIB-100G balun. Loop filter for PLL2 is C1 = 47 pF, C2 = 3.9 nF, R2 = 620 Ω, C3 = 10 pF, R3 = 200 Ω, C4 = 10 pF, R4 = 200 Ω, PLL1\_CP = 450 μA, PLL2\_CP = 3.2 mA.. VCO0 loop filter bandwidth = 303 kHz, phase margin = 73 degrees. VCO1 Loop filter loop bandwidth = 151 kHz, phase margin = 64 degrees. CLKoutX\_Y\_IDL = 1, CLKoutX\_Y\_ODL = 0.



 $(3.15 \text{ V} < \text{V}_{CC} < 3.45 \text{ V}, -40 ^{\circ}\text{C} < \text{T}_{A} < 85 ^{\circ}\text{C}$  and  $\text{T}_{PCB} \le 105 ^{\circ}\text{C}$ . Typical values at  $\text{V}_{CC} = 3.3 \text{ V}, \text{T}_{A} = 25 ^{\circ}\text{C}$ , at the Recommended Operating Conditions and are **not** assured.)

|                        | PARAMETER   | TEST C            | ONDITIONS                       | MIN TYP | MAX | UNIT   |
|------------------------|---|-------------------|---------------------------------|---------|-----|--------|
| NOISE FLOO             | R (continued)                                     |                   |                                 |         |     |        |
| NOIGE I LOGI           |   |                   | LVDS                            | -156.3  |     |        |
|                        |   |                   | HSDS 6 mA                       | -158.4  |     |        |
|                        |   |                   | HSDS 8 mA                       | -159.3  |     |        |
| L(f) <sub>CLKout</sub> | LMK04828, VCO0, Noise Floor<br>20 MHz Offset (15) | 245.76 MHz        | HSDS 10 mA                      | -158.9  |     | dBc/Hz |
|                        | 20 1711 12 011000                                 |                   | LVPECL16 /w 240 Ω               | -161.6  |     |        |
| İ                      |   |                   | LVPECL20 /w 240 Ω               | -162.5  |     |        |
| İ                      |   |                   | LCPECL                          | -162.1  |     |        |
| i                      |   |                   | LVDS                            | -155.7  |     |        |
|                        |   |                   | HSDS 6 mA                       | -157.5  |     |        |
|                        |   |                   | HSDS 8 mA                       | -158.1  |     |        |
| L(f) <sub>CLKout</sub> | LMK04828, VCO1, Noise Floor<br>20 MHz Offset (15) | 245.76 MHz        | HSDS 10 mA                      | -157.7  |     | dBc/Hz |
|                        | 20 WH 2 011000                                    |                   | LVPECL16 /w 240 Ω               | -160.3  |     |        |
|                        |   |                   | LVPECL20 /w 240 Ω               | -161.1  |     |        |
|                        |   |                   | LCPECL                          | -160.8  |     |        |
| CLKout CLO             | SED LOOP PHASE NOISE SPECIFICA                    | TIONS a COMMERCIA | AL QUALITY VCXO <sup>(16)</sup> |         |     |        |
|                        |   | Offset = 1 kHz    |                                 | -126.9  |     |        |
|                        |   | Offset = 10 kHz   |                                 | -133.5  |     |        |
|                        | LMK04821  | Offset = 100 kHz  |                                 | -135.4  |     |        |
| L(f) <sub>CLKout</sub> | VCO0<br>SSB Phase Noise <sup>(13)</sup>           | Offset = 1 MHz    |                                 | -149.8  |     | dBc/Hz |
|                        | 245.76 MHz  |                   | LVDS                            | -158.1  |     |        |
|                        |   | Offset = 10 MHz   | HSDS 8 mA                       | -161.1  |     |        |
|                        |   |                   | LVPECL16 /w 240 Ω               | -161.7  |     |        |
|                        |   | Offset = 1 kHz    |                                 | -126.8  |     |        |
|                        |   | Offset = 10 kHz   |                                 | -133.4  |     |        |
|                        | LMK04821  | Offset = 100 kHz  |                                 | -135.4  |     |        |
| L(f) <sub>CLKout</sub> | VCO1<br>SSB Phase Noise <sup>(13)</sup>           | Offset = 1 MHz    |                                 | -151.8  |     | dBc/Hz |
|                        | 245.76 MHz  |                   | LVDS                            | -157.2  |     |        |
|                        |   | Offset = 10 MHz   | HSDS 8 mA                       | -159.1  |     |        |
|                        | LVPECL16 /w 240                                   | LVPECL16 /w 240 Ω | -158.9                          |         |     |        |

<sup>(15)</sup> Data collected using ADT2-1T+ balun. Loop filter is C1 = 47 pF, C2 = 3.9 nF, R2 =  $620 \Omega$ , C3 = 10 pF, R3 =  $200 \Omega$ , C4 = 10 pF, R4 =  $200 \Omega$ , PLL1\_CP =  $450 \mu$ A, PLL2\_CP =  $3.2 \mu$ A. VCO0 loop filter bandwidth =  $344 \mu$ AHz, phase margin =  $73 \mu$ A degrees. VCO1 Loop filter loop bandwidth =  $233 \mu$ AHz, phase margin =  $70 \mu$ A degrees. CLKoutX\_Y\_IDL =  $1 \mu$ A, CLKoutX\_Y\_ODL =  $1 \mu$ A.

(16) VCXO used is a 122.88 MHz Crystek CVHD-950-122.880.



 $(3.15~V < V_{CC} < 3.45~V, -40~^{\circ}C < T_{A} < 85~^{\circ}C$  and  $T_{PCB} \le 105~^{\circ}C$ . Typical values at  $V_{CC} = 3.3~V, T_{A} = 25~^{\circ}C$ , at the Recommended Operating Conditions and are **not** assured.)

|                        | PARAMETER   | TEST C                    | CONDITIONS                     | MIN TYP   | MAX    | UNIT   |  |
|------------------------|---|---------------------------|--------------------------------|-----------|--------|--------|--|
| CLKout CLO             | SED LOOP PHASE NOISE SPECIFI                          | CATIONS a COMMERCIA       | AL QUALITY VCXO (co            | ntinued)  |        |        |  |
|                        |   | Offset = 10 kHz           | Offset = 10 kHz                |           |        |        |  |
|                        |   | Offset = 100 kHz          |                                | -135.4    |        |        |  |
|                        | LMK04826B   |                           | LVDS                           | -148.2    |        |        |  |
| L(f) <sub>CLKout</sub> | VCOO  | Offset = 1 MHz            | HSDS 8 mA<br>LVPECL16 /w 240 Ω | -148.6    |        | dBc/Hz |  |
|                        | 245.76 MHz  |                           | LVDS                           | -157.8    |        |        |  |
|                        |   | Offset = 10 MHz           | HSDS 8 mA                      | -160.4    |        |        |  |
|                        |   |                           | LVPECL16 /w 240 $\Omega$       | -161.5    |        |        |  |
|                        |   | Offset = 10 kHz           |                                | -134.3    |        |        |  |
|                        |   | Offset = 100 kHz          |                                | -133.7    |        |        |  |
|                        | LMK04826B   |                           | LVDS                           | -152.5    |        |        |  |
| L(f) <sub>CLKout</sub> | VCO1<br>SSB Phase Noise <sup>(14)</sup><br>245.76 MHz | Noise (14) Offset = 1 MHz | HSDS 8 mA<br>LVPECL16 /w 240 Ω | -153.6    |        | dBc/Hz |  |
|                        |   |                           |                                | LVDS      | -157.3 |        |  |
|                        |   |                           | Offset = 10 MHz                | HSDS 8 mA | -159.6 |        |  |
|                        |   |                           | LVPECL16 /w 240 Ω              | -160.5    |        |        |  |
|                        |   | Offset = 1 kHz            |                                | -124.3    |        |        |  |
|                        |   | Offset = 10 kHz           |                                | -134.7    |        |        |  |
|                        | LMK04828  | Offset = 100 kHz          |                                | -136.5    |        |        |  |
| $L(f)_{CLKout}$        | VCO0<br>SSB Phase Noise <sup>(15)</sup>               | Offset = 1 MHz            |                                | -148.4    |        | dBc/Hz |  |
|                        | 245.76 MHz  |                           | LVDS                           | -156.4    |        |        |  |
|                        |   | Offset = 10 MHz           | HSDS 8 mA                      | -159.1    |        |        |  |
|                        |   |                           | LVPECL16 /w 240 Ω              | -160.8    |        |        |  |
|                        |   | Offset = 1 kHz            |                                | -124.2    |        |        |  |
|                        |   | Offset = 10 kHz           |                                | -134.4    |        |        |  |
|                        | LMK04828  | Offset = 100 kHz          |                                | -135.2    |        |        |  |
| $L(f)_{CLKout}$        | VCO1<br>SSB Phase Noise <sup>(15)</sup>               | Offset = 1 MHz            |                                | -151.5    |        | dBc/Hz |  |
|                        | 245.76 MHz  | LVDS                      | -159.9                         |           |        |        |  |
|                        |   | Offset = 10 MHz           | HSDS 8 mA                      | -155.8    |        |        |  |
|                        |   | LVPECL16 /w 240 Ω         | -158.1                         |           |        |        |  |



 $(3.15~V < V_{CC} < 3.45~V, -40~^{\circ}C < T_{A} < 85~^{\circ}C$  and  $T_{PCB} \le 105~^{\circ}C$ . Typical values at  $V_{CC} = 3.3~V, T_{A} = 25~^{\circ}C$ , at the Recommended Operating Conditions and are **not** assured.)

|                     | PARAMETER   | TEST CONDITIONS                                     | MIN TYP MAX        | UNIT   |
|---------------------|---|---|--------------------|--------|
| CLKout CLC          | OSED LOOP JITTER SPECIFICATION                      | S a COMMERCIAL QUALITY VCXO (16)                    |                    |        |
|                     |   | LVDS, BW = 12 kHz to 20 MHz                         | 99                 |        |
|                     | LMK04821, VCO0<br>f <sub>CLKout</sub> = 245.76 MHz  | HSDS 8 mA, BW = 12 kHz to 20 MHz                    | 94                 |        |
|                     |   | LVPECL16 /w 240 $\Omega$ ,<br>BW = 12 kHz to 20 MHz | 96                 | fs rms |
|                     | Integrated RMS Jitter (13)                          | LVPECL20 /w 240 $\Omega$ ,<br>BW = 12 kHz to 20 MHz | 94                 |        |
|                     |   | LCPECL /w 240 $\Omega$ ,<br>BW = 12 kHz to 20 MHz   | 93                 |        |
| $J_{CLKout}$        |   | LVDS, BW = 12 kHz to 20 MHz                         | 96                 |        |
|                     |   | HSDS 8 mA, BW = 12 kHz to 20 MHz                    | 90                 |        |
|                     | LMK04821, VCO1<br>f <sub>CLKout</sub> = 245.76 MHz  | LVPECL16 /w 240 $\Omega$ , BW = 12 kHz to 20 MHz    | 92                 | fs rms |
|                     | Integrated RMS Jitter (13)                          | LVPECL20 /w 240 $\Omega$ ,<br>BW = 12 kHz to 20 MHz | 91                 |        |
|                     |   | LCPECL /w 240 $\Omega$ , BW = 12 kHz to 20 MHz      | 91                 |        |
| CLKout CLC          | OSED LOOP JITTER SPECIFICATION                      | S a COMMERCIAL QUALITY VCXO (continued              | d) <sup>(16)</sup> |        |
|                     | LMK04826B, VCO0<br>f <sub>CLKout</sub> = 245.76 MHz | LVDS, BW = 100 Hz to 20 MHz                         | 106                |        |
|                     |   | LVDS, BW = 12 kHz to 20 MHz                         | 104                |        |
|                     |   | HSDS 8 mA, BW = 100 Hz to 20 MHz                    | 99                 |        |
|                     |   | HSDS 8 mA, BW = 12 kHz to 20 MHz                    | 97                 |        |
|                     |   | LVPECL16 /w 240 $\Omega$ , BW = 100 Hz to 20 MHz    | 99                 | fs rms |
|                     | Integrated RMS Jitter (14)                          | LVPECL16 /w 240 $\Omega$ , BW = 12 kHz to 20 MHz    | 96                 |        |
|                     |   | LCPECL /w 240 $\Omega$ ,<br>BW = 100 Hz to 20 MHz   | 100                |        |
|                     |   | LCPECL /w 240 $\Omega$ ,<br>BW = 12 kHz to 20 MHz   | 97                 |        |
| J <sub>CLKout</sub> |   | LVDS, BW = 100 Hz to 20 MHz                         | 99                 |        |
|                     |   | LVDS, BW = 12 kHz to 20 MHz                         | 97                 |        |
|                     |   | HSDS 8 mA, BW = 100 Hz to 20 MHz                    | 92                 |        |
|                     |   | HSDS 8 mA, BW = 12 kHz to 20 MHz                    | 90                 |        |
|                     | LMK04826, VCO1<br>f <sub>CLKout</sub> = 245.76 MHz  | LVPECL16 /w 240 $\Omega$ , BW = 100 Hz to 20 MHz    | 91                 | fs rms |
|                     | Integrated RMS Jitter (14)                          | LVPECL20 /w 240 $\Omega$ , BW = 12 kHz to 20 MHz    | 89                 |        |
|                     |   | LCPECL /w 240 $\Omega$ , BW = 100 Hz to 20 MHz      | 92                 |        |
|                     |   | LCPECL /w 240 Ω,<br>BW = 12 kHz to 20 MHz           | 89                 |        |

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 $(3.15~V < V_{CC} < 3.45~V, -40~^{\circ}C < T_{A} < 85~^{\circ}C$  and  $T_{PCB} \le 105~^{\circ}C$ . Typical values at  $V_{CC} = 3.3~V, T_{A} = 25~^{\circ}C$ , at the Recommended Operating Conditions and are **not** assured.)

|                     | PARAMETER   | TEST CONDITIONS                                      | MIN TYP            | MAX | UNIT   |
|---------------------|---|--|--------------------|-----|--------|
| CLKout CLOS         | SED LOOP JITTER SPECIFICATION:  | S a COMMERCIAL QUALITY VCXO (continued               | d) <sup>(16)</sup> |     |        |
|                     |   | LVDS, BW = 100 Hz to 20 MHz                          | 112                |     |        |
|                     |   | LVDS, BW = 12 kHz to 20 MHz                          | 109                |     |        |
|                     |   | HSDS 8 mA, BW = $100 \text{ Hz}$ to $20 \text{ MHz}$ | 102                |     |        |
|                     |   | HSDS 8 mA, BW = 12 kHz to 20 MHz                     | 99                 |     |        |
|                     | LMK04828, VCO0<br>f <sub>CLKout</sub> = 245.76 MHz  | LVPECL16 /w 240 $\Omega$ , BW = 100 Hz to 20 MHz     | 98                 |     | fs rms |
|                     | Integrated RMS Jitter (15)  | LVPECL20 /w 240 $\Omega$ , BW = 12 kHz to 20 MHz     | 95                 |     |        |
|                     |   | LCPECL /w 240 $\Omega$ ,<br>BW = 100 Hz to 20 MHz    | 96                 |     |        |
|                     |   | LCPECL /w 240 $\Omega$ , BW = 12 kHz to 20 MHz       | 93                 |     | İ      |
| J <sub>CLKout</sub> |   | LVDS, BW = 100 Hz to 20 MHz                          | 108                |     |        |
|                     |   | LVDS, BW = 12 kHz to 20 MHz                          | 105                |     |        |
|                     |   | HSDS 8 mA, BW = 100 Hz to 20 MHz                     | 98                 |     |        |
|                     |   | HSDS 8 mA, BW = 12 kHz to 20 MHz                     | 94                 |     |        |
|                     | LMK04828, VCO1<br>f <sub>CLKout</sub> = 245.76 MHz<br>Integrated RMS Jitter <sup>(15)</sup> | LVPECL16 /w 240 $\Omega$ ,<br>BW = 100 Hz to 20 MHz  | 93                 |     | fs rms |
|                     |   | LVPECL20 /w 240 $\Omega$ ,<br>BW = 12 kHz to 20 MHz  | 90                 |     |        |
|                     |   | LCPECL /w 240 $\Omega$ , BW = 100 Hz to 20 MHz       | 91                 |     |        |
|                     |   | LCPECL /w 240 Ω,<br>BW = 12 kHz to 20 MHz            | 88                 |     |        |

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 $(3.15 \text{ V} < \text{V}_{CC} < 3.45 \text{ V}, -40 ^{\circ}\text{C} < \text{T}_{A} < 85 ^{\circ}\text{C}$  and  $\text{T}_{PCB} \le 105 ^{\circ}\text{C}$ . Typical values at  $\text{V}_{CC} = 3.3 \text{ V}, \text{T}_{A} = 25 ^{\circ}\text{C}$ , at the Recommended Operating Conditions and are **not** assured.)

|  | PARAMETER   | TEST CONDITIONS   | MIN   | TYP  | MAX   | UNIT    |
|--|---|---|-------|------|-------|---------|
| DEFAULT POV  | VER on RESET CLOCK OUTPUT FREQ  | UENCY   |       |      | 1     |         |
| ,  | Default output clock frequency at   | LMK04826  |       | 235  |       | N 41 1- |
| †CLKout-startup  | device power on (17)(18)  | LMK04828  | 315   |      |       | MHz     |
| f <sub>OSCout</sub>  | OSCout Frequency  | (7)   |       |      | 500   | MHz     |
| CLOCK SKEW   | and DELAY   |   |       |      |       |         |
|  | DCLKoutX to SDCLKoutY $F_{CLK} = 245.76$ MHz, $R_L = 100$ $\Omega$ AC coupled $^{(19)}$   | Same pair, Same format <sup>(20)</sup><br>SDCLKoutY_MUX = 0 (Device Clock)  |       |      | 25    |         |
| T <sub>SKEW</sub>  | Maximum DCLKoutX or SDCLKoutY to DCLKoutX or SDCLKoutY $F_{CLK} = 245.76 \text{ MHz}, \ R_L = 100 \ \Omega$ AC coupled                          | Any pair, Same format <sup>(20)</sup><br>SDCLKoutY_MUX = 0 (Device Clock)   | 50    |      |       | ps      |
| ts <sub>JESD204B</sub>   | SYSREF to Device Clock setup time base reference. See SYSREF to Device Clock Alignment to adjust SYSREF to Device Clock setup time as required. | SDCLKoutY_MUX = 1 (SYSREF) SYSREF_DIV = 30 SYSREF_DDLY = 8 (global) SDCLKoutY_DDLY = 1 (2 cycles, local) DCLKoutX_MUX = 1 (Div+DCC+HS) DCLKoutX_DIV = 30 DCLKoutX_DDLY_CNTH = 7 DCLKoutX_DDLY_CNTL = 6 DCLKoutX_HS = 0 SDCLKoutY_HS = 0 |       | -80  |       | ps      |
| t <sub>PD</sub> CLKin0_ Propagation Delay from CLKin0 t<br>SDCLKout1 SDCLKout1 |   | CLKin0_OUT_MUX = 0 (SYSREF Mux) SYSREF_CLKin0_MUX = 1 (CLKin0) SDCLKout1_PD = 0 SDCLKout1_DDLY = 0 (Bypass) SDCLKout1_MUX = 1 (SR) EN_SYNC = 1 LVPECL16 /w 240 Ω  | 0.65  |      |       | ns      |
| f <sub>ADLY</sub> max  | Maximum analog delay frequency DCLKoutX_MUX = 4   |   |       | 1536 |       | MHz     |
| LVDS CLOCK   | OUTPUTS (DCLKoutX, SDCLKoutY, an  | d OSCout)   |       |      | ·     |         |
| $V_{OD}$   | Differential Output Voltage   |   |       | 395  |       | mV      |
| $\Delta V_{OD}$  | Change in Magnitude of V <sub>OD</sub> for complementary output states  Output Offset Voltage   | T = 25 °C, DC measurement AC coupled to receiver input $R_{L} = 100 \Omega$ differential termination  | -60   |      | 60    | mV      |
| V <sub>OS</sub>  |   |   | 1.125 | 1.25 | 1.375 | V       |
| $\Delta V_{OS}$  | Change in V <sub>OS</sub> for complementary output states   |   |       |      | 35    | mV      |
| $T_R / T_F$  | Output Rise Time  | 20% to 80%, $R_L = 100 \Omega$ , 245.76 MHz   | 180   |      |       | ne      |
| 'R' 'F   | Output Fall Time  | 80% to 20%, $R_L = 100 \Omega$  |       |      |       | ps      |
| I <sub>SA</sub><br>I <sub>SB</sub>   | Output short circuit current - single ended   | Single-ended output shorted to GND T = 25 °C -24  |       | 24   | mA    |         |
| I <sub>SAB</sub>   | Output short circuit current - differential   | Complimentary outputs tied together   | -12   |      | 12    | mA      |

<sup>(17)</sup> OSCout will oscillate at start-up at the frequency of the VCXO attached to OSCin port.

(20) LVPECL uses 120  $\Omega$  emitter resistor, LVDS and HSDS uses 560  $\Omega$  shunt.

<sup>(18)</sup> LMK04821 has no DCLKoutX or SDCLKoutY outputs which oscillate at power on. Only OSCout oscillates at power on.

<sup>(19)</sup> Equal loading and identical clock output configuration on each clock output is required for specification to be valid. Specification not valid for delay mode.



 $(3.15~V < V_{CC} < 3.45~V, -40~^{\circ}C < T_{A} < 85~^{\circ}C$  and  $T_{PCB} \le 105~^{\circ}C$ . Typical values at  $V_{CC} = 3.3~V, T_{A} = 25~^{\circ}C$ , at the Recommended Operating Conditions and are **not** assured.)

|                 | PARAMETER   | TEST CONDITIONS   | MIN TYP                   | MAX | UNIT |
|-----------------|---|---|---------------------------|-----|------|
| 6 mA HSDS       | CLOCK OUTPUTS (DCLKoutX and SDC                           | LKoutY)   |                           |     |      |
| V <sub>OH</sub> |   | T = 25 °C, DC measurement   | V <sub>CC</sub> -<br>1.05 |     |      |
| V <sub>OL</sub> |   | Termination = $50 \Omega$ to $V_{CC}$ - 1.42 V  | V <sub>CC</sub> -<br>1.64 |     |      |
| V <sub>OD</sub> | Differential Output Voltage                               |   | 590                       |     | mV   |
| $\Delta V_{OD}$ | Change in V <sub>OD</sub> for complementary output states |   | -80                       | 80  | mVpp |
| 8 mA HSDS       | CLOCK OUTPUTS (DCLKoutX and SDC                           | LKoutY)   |                           |     |      |
| T /T            | Output Rise Time  | 245.76 MHz, 20% to 80%, $R_L$ = 100 Ω   | 470                       |     |      |
| $T_R/T_F$       | Output Fall Time  | 245.76 MHz, 80% to 20%, $R_L$ = 100 Ω   | 170                       |     | ps   |
| V <sub>OH</sub> |   | T = 25 °C, DC measurement   | V <sub>CC</sub> -<br>1.26 |     |      |
| V <sub>OL</sub> |   | Termination = $50 \Omega$ to $V_{CC}$ - 1.64 V  | V <sub>CC</sub><br>-2.06  |     |      |
| $V_{OD}$        | Differential Output Voltage                               |   | 800                       |     | mV   |
| $\Delta V_{OD}$ | Change in V <sub>OD</sub> for complementary output states |   | -115                      | 115 | mVpp |
| 10 mA HSD       | S CLOCK OUTPUTS (DCLKoutX and SDC                         | CLKoutY)  |                           |     | -    |
| V <sub>OH</sub> | ·   |   | V <sub>CC</sub> -<br>0.99 |     |      |
| V <sub>OL</sub> |   | T = 25 °C, DC measurement<br>Termination = 50 $\Omega$ to<br>V <sub>CC</sub> - 1.43 V | V <sub>CC</sub> -<br>1.97 |     |      |
| V <sub>OD</sub> |   |   | 980                       |     | mVpp |
| $\Delta V_{OD}$ | Change in V <sub>OD</sub> for complementary output states |   | -115                      | 115 | mVpp |
| LVPECL CL       | OCK OUTPUTS (DCLKoutX and SDCLKo                          | outY)   |                           |     |      |
|                 | 20% to 80% Output Rise                                    | $R_L = 100 \Omega$ , emitter resistors = 240 $\Omega$ to                              |                           |     | 1    |
| $T_R / T_F$     | 80% to 20% Output Fall Time                               | GND DCLKoutX_TYPE = 4 or 5 (1600 or 2000 mVpp)  | 150                       |     | ps   |
| 1600 mVpp       | LVPECL CLOCK OUTPUTS (DCLKoutX a                          |   |                           |     |      |
| V <sub>OH</sub> | Output High Voltage                                       | ,   | V <sub>CC</sub> - 1.04    |     | V    |
| V <sub>OL</sub> | Output Low Voltage  | DC Measurement Termination = $50 \Omega$ to   | V <sub>CC</sub> -<br>1.80 |     | V    |
| V <sub>OD</sub> | Output Voltage<br>Figure 9                                | V <sub>CC</sub> - 2.0 V   | 760                       |     | mV   |
| 2000 mVpp       | LVPECL CLOCK OUTPUTS (DCLKoutX a                          | and SDCLKoutY)  |                           |     | -    |
| V <sub>OH</sub> | Output High Voltage                                       | -   | V <sub>CC</sub> -<br>1.09 |     | V    |
| V <sub>OL</sub> | Output Low Voltage  | DC Measurement Termination = $50 \Omega$ to $V_{CC}$ - 2.3 V                          | V <sub>CC</sub> -<br>2.05 |     | V    |
| V <sub>OD</sub> | Output Voltage<br>Figure 9                                |   | 960                       |     | mV   |
| LCPECL CL       | OCK OUTPUTS (DCLKoutX and SDCLKo                          | outY)   |                           |     |      |
| V <sub>OH</sub> | Output High Voltage                                       |   | 1.57                      |     | V    |
| V <sub>OL</sub> | Output Low Voltage  | DC Measurement  | 0.62                      |     | V    |
| V <sub>OD</sub> | Output Voltage<br>Figure 9                                | Termination = 50 $\Omega$ to 0.5 V  | 950                       |     | mV   |



(3.15 V <  $V_{CC}$  < 3.45 V, -40 °C <  $T_A$  < 85 °C and  $T_{PCB}$  ≤ 105 °C. Typical values at  $V_{CC}$  = 3.3 V,  $T_A$  = 25 °C, at the Recommended Operating Conditions and are **not** assured.)

|                     | PARAMETER   | TEST CONDITIONS  | MIN                   | TYP | MAX        | UNIT   |
|---------------------|---|--|-----------------------|-----|------------|--------|
| LVCMOS CLO          | OCK OUTPUTS (OSCout)  |  | <b>'</b>              |     | '          |        |
| _                   | Maximum Frequency   | E nC Lood  | 250                   |     |            | NAL I- |
| †CLKout             | (21)  | 5 pF Load  | 250                   |     |            | MHz    |
| V <sub>OH</sub>     | Output High Voltage   | 1 mA Load  | V <sub>CC</sub> - 0.1 |     |            | V      |
| V <sub>OL</sub>     | Output Low Voltage  | 1 mA Load  |                       |     | 0.1        | V      |
| I <sub>OH</sub>     | Output High Current (Source)  | $V_{CC} = 3.3 \text{ V}, V_{O} = 1.65 \text{ V}$   |                       | 28  |            | mA     |
| l <sub>OL</sub>     | Output Low Current (Sink)   | $V_{CC} = 3.3 \text{ V}, V_{O} = 1.65 \text{ V}$   |                       | 28  |            | mA     |
| DUTY <sub>CLK</sub> | Output Duty Cycle (22)  | $V_{CC}/2$ to $V_{CC}/2$ ,<br>$F_{CLK} = 100$ MHz, $T = 25$ °C   |                       | 50% |            |        |
| $T_R$               | Output Rise Time  | 20% to 80%, $R_L = 50 \Omega$ , $C_L = 5 pF$   |                       | 400 |            | ps     |
| T <sub>F</sub>      | Output Fall Time  | 80% to 20%, $R_L = 50 \Omega$ , $C_L = 5 pF$   |                       | 400 |            | ps     |
| DIGITAL OUT         | TPUTS (CLKin_SELX, Status_LDX, ar   | nd RESET/GPO)  |                       |     |            |        |
| V <sub>OH</sub>     | High-Level Output Voltage   | I <sub>OH</sub> = -500 μA<br>CLKin_SELX_TYPE = 3 or 4<br>Status_LDX_TYPE = 3 or 4<br>RESET_TYPE = 3 or 4     | V <sub>CC</sub> - 0.4 |     |            | V      |
| $V_{OL}$            | Low-Level Output Voltage  | $I_{OL}$ = 500 µA<br>CLKin_SELX_TYPE = 3, 4, or 6<br>Status_LDX_TYPE = 3, 4, or 6<br>RESET_TYPE = 3, 4, or 6 |                       |     | 0.4        | V      |
| DIGITAL OUT         | TPUT (SDIO)   |  |                       |     |            |        |
| V <sub>OH</sub>     | High-Level Output Voltage I <sub>OH</sub> = -500 μA; During SPI re SDIO_RDBK_TYPE = 0 |  | V <sub>CC</sub> - 0.4 |     |            | V      |
| V <sub>OL</sub>     | Low-Level Output Voltage  | I <sub>OL</sub> = 500 μA ; During SPI read.<br>SDIO_RDBK_TYPE = 0 or 1                                       |                       |     | 0.4        | V      |
| DIGITAL INP         | UTS (CLKinX_SEL, RESET/GPO, SYN   | IC, SCK, SDIO, or CS*)   |                       |     |            |        |
| $V_{IH}$            | High-Level Input Voltage  |  | 1.2                   |     | $V_{CC}$   | V      |
| $V_{IL}$            | Low-Level Input Voltage   |  |                       |     | 0.4        | V      |
| DIGITAL INP         | UTS (CLKinX_SEL)  |  |                       |     |            |        |
|                     | High-Level Input Current $V_{IH} = V_{CC}$  | CLKin_SELX_TYPE = 0,<br>(High Impedance)   | -5                    |     | 5          |        |
| I <sub>IH</sub>     |   | CLKin_SELX_TYPE = 1 (Pull-up)  | -5                    |     | 5          | μA     |
|                     |   | CLKin_SELX_TYPE = 2 (Pull-down)  | 10                    |     | 80         |        |
|                     | Low-Level Input Current V <sub>IL</sub> = 0 V   | CLKin_SELX_TYPE = 0,<br>(High Impedance)   | -5                    |     | 5          |        |
| I <sub>IL</sub>     |   | CLKin_SELX_TYPE = 1 (Pull-up)  | -40                   |     | <b>-</b> 5 | μΑ     |
|                     |   | CLKin_SELX_TYPE = 2 (Pull-down)  | -5                    |     | 5          |        |
| DIGITAL INP         | UT (RESET/GPO)  |  |                       |     |            |        |
| Іін                 | High-Level Input Current V <sub>IH</sub> = V <sub>CC</sub>                            |  |                       | 80  | μΑ         |        |
|                     | Low-Level Input Current   | RESET_TYPE = 0 (High Impedance)  | -5                    |     | 5          |        |
| I <sub>IL</sub>     |   | RESET_TYPE = 1 (Pull-up)   | -40                   |     | <b>-</b> 5 | μΑ     |
|                     | - IL  | RESET_TYPE = 2 (Pull-down)   | -5                    |     | 5          |        |
| DIGITAL INP         | UTS (SYNC)  |  |                       |     |            |        |
| l <sub>IH</sub>     | High-Level Input Current $V_{IH} = V_{CC}$  |  |                       |     | 25         | μA     |
| I <sub>IL</sub>     | Low-Level Input Current   | V <sub>IL</sub> = 0 V  | -5                    | -   | 5          |        |

<sup>(21)</sup> Assured by characterization. ATE tested to 10 MHz.

<sup>(22)</sup> Assumes OSCin has 50% input duty cycle.



(3.15 V <  $V_{CC}$  < 3.45 V,  $-40~^{\circ}C$  <  $T_{A}$  < 85  $^{\circ}C$  and  $T_{PCB}$  ≤ 105  $^{\circ}C$ . Typical values at  $V_{CC}$  = 3.3 V,  $T_{A}$  = 25  $^{\circ}C$ , at the Recommended Operating Conditions and are **not** assured.)

|                      | PARAMETER                | TEST CONDITIONS                      | MIN | TYP | MAX | UNIT |  |
|----------------------|--------------------------|--------------------------------------|-----|-----|-----|------|--|
| I <sub>IH</sub>      | High-Level Input Current | $V_{IH} = V_{CC}$                    | -5  |     | 5   | μΑ   |  |
| I <sub>IL</sub>      | Low-Level Input Current  | $V_{IL} = 0$                         | -5  |     | 5   | μΑ   |  |
| DIGITAL INPUT TIMING |                          |                                      |     |     |     |      |  |
| t <sub>HIGH</sub>    |                          | RESET pin held high for device reset | 25  |     |     | ns   |  |



### 7.6 SPI Interface Timing

|                   |   | TEST CONDITIONS | MIN               | TYP | MAX | UNIT |
|-------------------|---|-----------------|-------------------|-----|-----|------|
| tds               | Setup time for SDI edge to SCLK rising edge         | See Figure 1    | 10                |     |     | ns   |
| td <sub>H</sub>   | Hold time for SDI edge from SCLK rising edge        | See Figure 1    | 10                |     |     | ns   |
| t <sub>SCLK</sub> | Period of SCLK                                      | See Figure 1    | 50 <sup>(1)</sup> |     |     | ns   |
| t <sub>HIGH</sub> | High width of SCLK                                  | See Figure 1    | 25                |     |     | ns   |
| t <sub>LOW</sub>  | Low width of SCLK                                   | See Figure 1    | 25                |     |     | ns   |
| tcs               | Setup time for CS* falling edge to SCLK rising edge | See Figure 1    | 10                |     |     | ns   |
| tc <sub>H</sub>   | Hold time for CS* rising edge from SCLK rising edge | See Figure 1    | 30                |     |     | ns   |
| td <sub>v</sub>   | SCLK falling edge to valid read back data           | See Figure 1    |                   |     | 20  | ns   |

### (1) 20 MHz

Register programming information on the SDIO pin is clocked into a shift register on each rising edge of the SCK signal. On the rising edge of the CS\* signal, the register is sent from the shift register to the register addressed. A slew rate of at least 30 V/µs is recommended for these signals. After programming is complete the CS\* signal should be returned to a high state. If the SCK or SDIO lines are toggled while the VCO is in lock, as is sometimes the case when these lines are shared with other parts, the phase noise may be degraded during this programming.

4 wire mode read back has same timing as SDIO pin.

R/W bit = 0 is for SPI write. R/W bit = 1 is for SPI read.

W1 and W0 will be written as 0.

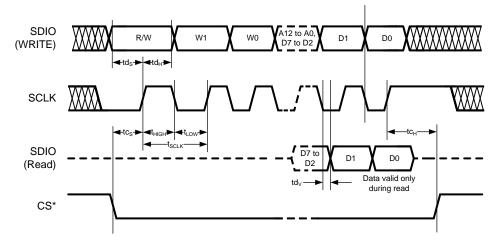


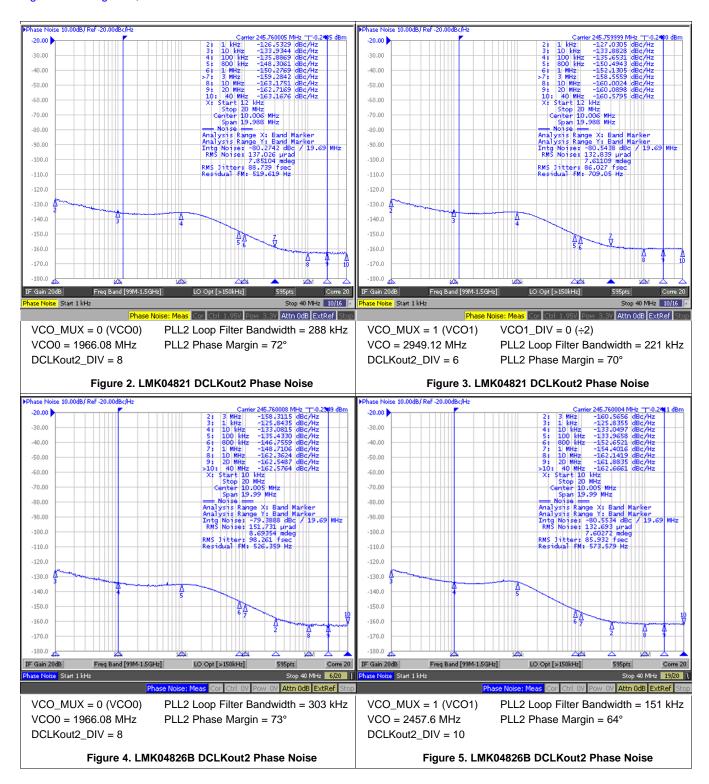
Figure 1. SPI Timing Diagram



### 7.7 Typical Characteristics – Clock Output AC Characteristics

**NOTE**: These plots show performance at frequencies beyond the point at which the part is ensured to operate in order to give an idea of the capabilities of the part. They do not imply any sort of ensured specification.

For Figure 2 through Figure 7, CLKout2\_3\_IDL=1; CLKout2\_3\_ODL=0; LVPECL20 with 240-Ω emitter resistors; DCLKout2 Frequency = 245.76 MHz; DCLKout2\_MUX = 0 (Divider). For Figure 2 through Figure 5, Balun Prodyn BIB-100G. For Figure 6 and Figure 7, Balun ADT2-1T+.

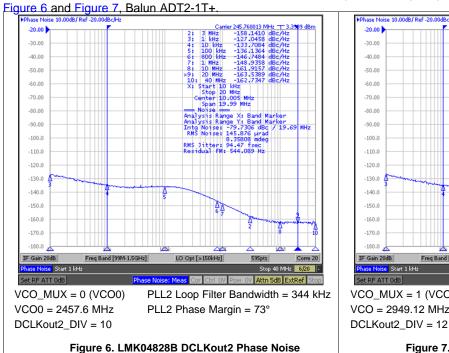


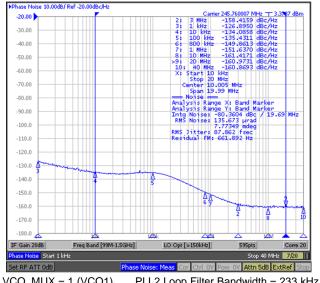


# Typical Characteristics – Clock Output AC Characteristics (continued)

NOTE: These plots show performance at frequencies beyond the point at which the part is ensured to operate in order to give an idea of the capabilities of the part. They do not imply any sort of ensured specification.

For Figure 2 through Figure 7, CLKout2\_3\_IDL=1; CLKout2\_3\_ODL=0; LVPECL20 with 240-Ω emitter resistors; DCLKout2 Frequency = 245.76 MHz; DCLKout2\_MUX = 0 (Divider). For Figure 2 through Figure 5, Balun Prodyn BIB-100G. For





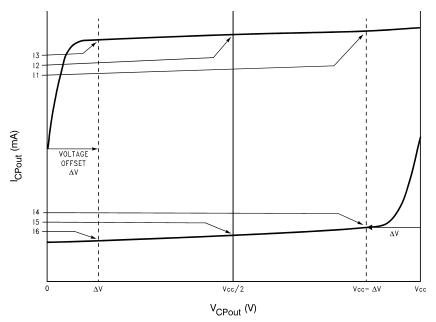
 $VCO_MUX = 1 (VCO1)$ VCO = 2949.12 MHz

PLL2 Loop Filter Bandwidth = 233 kHz PLL2 Phase Margin = 70°

# TEXAS INSTRUMENTS

### 8 Parameter Measurement Information

# 8.1 Charge Pump Current Specification Definitions



I1 = Charge Pump Sink Current at  $V_{CPout} = V_{CC} - \Delta V$ 

I2 = Charge Pump Sink Current at  $V_{CPout} = V_{CC}/2$ 

I3 = Charge Pump Sink Current at  $V_{CPout} = \Delta V$ 

I4 = Charge Pump Source Current at  $V_{CPout} = V_{CC} - \Delta V$ 

I5 = Charge Pump Source Current at  $V_{CPout} = V_{CC}/2$ 

I6 = Charge Pump Source Current at  $V_{CPout} = \Delta V$ 

 $\Delta V$  = Voltage offset from the positive and negative supply rails. Defined to be 0.5 V for this device.

### 8.1.1 Charge Pump Output Current Magnitude Variation Vs. Charge Pump Output Voltage

$$I_{CPout} \ Vs \ V_{CPout} = \frac{|11| - |13|}{|11| + |13|} \times 100\%$$
$$= \frac{|14| - |16|}{|14| + |16|} \times 100\%$$

### 8.1.2 Charge Pump Sink Current Vs. Charge Pump Output Source Current Mismatch

$$I_{CPout}$$
 Sink Vs  $I_{CPout}$  Source = 
$$\frac{||2| - ||5|}{||2| + ||5|} \times 100\%$$

### 8.1.3 Charge Pump Output Current Magnitude Variation Vs. Ambient Temperature

$$I_{CPout} \text{ Vs } T_{A} = \frac{|I_{2}||_{T_{A}} - |I_{2}||_{T_{A} = 25^{\circ}C}}{|I_{2}||_{T_{A} = 25^{\circ}C}} \times 100\%$$

$$= \frac{|I_{5}||_{T_{A}} - |I_{5}||_{T_{A} = 25^{\circ}C}}{|I_{5}||_{T_{A} = 25^{\circ}C}} \times 100\%$$



### 8.2 Differential Voltage Measurement Terminology

The differential voltage of a differential signal can be described by two different definitions causing confusion when reading data sheets or communicating with other engineers. This section will address the measurement and description of a differential signal so that the reader will be able to understand and distinguish between the two different definitions when used.

The first definition used to describe a differential signal is the absolute value of the voltage potential between the inverting and non-inverting signal. The symbol for this first measurement is typically  $V_{ID}$  or  $V_{OD}$  depending on if an input or output voltage is being described.

The second definition used to describe a differential signal is to measure the potential of the non-inverting signal with respect to the inverting signal. The symbol for this second measurement is  $V_{SS}$  and is a calculated parameter. Nowhere in the IC does this signal exist with respect to ground, it only exists in reference to its differential pair.  $V_{SS}$  can be measured directly by oscilloscopes with floating references, otherwise this value can be calculated as twice the value of  $V_{OD}$  as described in the first description.

Figure 8 illustrates the two different definitions side-by-side for inputs and Figure 9 illustrates the two different definitions side-by-side for outputs. The  $V_{ID}$  and  $V_{OD}$  definitions show  $V_A$  and  $V_B$  DC levels that the non-inverting and inverting signals toggle between with respect to ground.  $V_{SS}$  input and output definitions show that if the inverting signal is considered the voltage potential reference, the non-inverting signal voltage potential is now increasing and decreasing above and below the non-inverting reference. Thus the peak-to-peak voltage of the differential signal can be measured.

V<sub>ID</sub> and V<sub>OD</sub> are often defined as volts (V) and V<sub>SS</sub> is often defined as volts peak-to-peak (V<sub>PP</sub>).

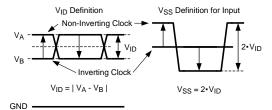


Figure 8. Two Different Definitions for Differential Input Signals

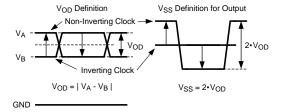


Figure 9. Two Different Definitions for Differential Output Signals

Refer to application note AN-912 Common Data Transmission Parameters and their Definitions (SNLA036) for more information.



# 9 Detailed Description

### 9.1 Overview

The family of LMK0482x devices are verify flexible to meet many application requirements. The typical use case for LMK0482x is as a cascaded dual loop iitter cleaner for JESD204B systems. However traditional (non-JESD204B) systems are possible with use of the large SYSREF divider to produce a low frequency. Note that while the Device Clock outputs (DCLKoutX) do not provide LVCMOS outputs, the OSCout may be used to provide LVCMOS outputs at DCLKout6 or DCLKout8 frequency using the feedback mux.

In addition to dual loop operation, by powering down various blocks the LMK0482x may be configured for single loop or clock distribution modes also.

### 9.1.1 Jitter Cleaning

The dual loop PLL architecture of the LMK0482x family provides the lowest jitter performance over a wide range of output frequencies and phase noise integration bandwidths. The first stage PLL (PLL1) is driven by an external reference clock and uses an external VCXO or tunable crystal to provide a frequency accurate, low phase noise reference clock for the second stage frequency multiplication PLL (PLL2).

PLL1 typically uses a narrow loop bandwidth (typically 10 Hz to 200 Hz) to retain the frequency accuracy of the reference clock input signal while at the same time suppressing the higher offset frequency phase noise that the reference clock may have accumulated along its path or from other circuits. This "cleaned" reference clock provides the reference input to PLL2.

The low phase noise reference provided to PLL2 allows PLL2 to operate with a wide loop bandwidth (typically 50 kHz to 200 kHz). The loop bandwidth for PLL2 is chosen to take advantage of the superior high offset frequency phase noise profile of the internal VCO and the good low offset frequency phase noise of the reference VCXO or tunable crystal.

Ultra low jitter is achieved by allowing the external VCXO or Crystal's phase noise to dominate the final output phase noise at low offset frequencies and the internal VCO's phase noise to dominate the final output phase noise at high offset frequencies. This results in best overall phase noise and jitter performance.

### 9.1.2 JEDEC JESD204B Support

The LMK0482x family provides support for JEDEC JESD204B. The LMK0482x will clock up to 7 JESD204B targets using 7 device clocks (DCLKoutX) and 7 SYSREF clocks (SDCLKoutY). Each device clock is grouped with a SYSREF clock.

It is also possible to re-program SYSREF clocks to behave as extra device clocks for applications which have non-JESD204B clock requirements.

### 9.1.3 Three PLL1 Redundant Reference Inputs (CLKin0/CLKin0\*, CLKin1/CLKin1\*, and CLKin2/CLKin2\*)

The LMK0482x family has up to three reference clock inputs for PLL1. They are CLKin0, CLKin1, and CLKin2. The active clock is chosen based on CLKin\_SEL\_MODE. Automatic or manual switching can occur between the inputs.

CLKin0, CLKin1, and CLKin2 each have their own PLL1 R dividers.

CLKin1 is shared for use as an external 0-delay feedback (FBCLKin), or for use with an external VCO (Fin).

CLKin2 is shared for use as OSCout. To use powerdown OSCout, see VCO\_MUX, OSCout\_MUX, OSCout FMT.

Fast manual switching between reference clocks is possible with a external pins CLKin SEL0 and CLKin SEL1.

### 9.1.4 VCXO/Crystal Buffered Output

The LMK0482x family provides OSCout, which by default is a buffered copy of the PLL1 feedback/PLL2 reference input. This reference input is typically a low noise VCXO or Crystal. When using a VCXO, this output can be used to clock external devices such as microcontrollers, FPGAs, CPLDs, and so forth, before the LMK0482x is programmed.

The OSCout buffer output type is programmable to LVDS, LVPECL, or LVCMOS.



### Overview (continued)

The VCXO/Crystal buffered output can be synchronized to the VCO clock distribution outputs by using Cascaded 0-Delay Mode. The buffered output of VCXO/Crystal has deterministic phase relationship with CLKin.

### 9.1.5 Frequency Holdover

The LMK0482x family supports holdover operation to keep the clock outputs on frequency with minimum drift when the reference is lost until a valid reference clock signal is re-established.

### 9.1.6 PLL2 Integrated Loop Filter Poles

The LMK0482x family features programmable 3rd and 4th order loop filter poles for PLL2. These internal resistors and capacitor values may be selected from a fixed range of values to achieve either a 3rd or 4th order loop filter response. The integrated programmable resistors and capacitors compliment external components mounted near the chip.

These integrated components can be effectively disabled by programming the integrated resistors and capacitors to their minimum values.

### 9.1.7 Internal VCOs

The LMK0482x family has two internal VCOs, selected by VCO\_MUX. The output of the selected VCO is routed to the Clock Distribution Path. This same selection is also fed back to the PLL2 phase detector through a prescaler and N-divider.

### 9.1.8 VCO1 Divider (LMK04821 only)

The LMK04821 includes a VCO divider on the output of VCO1. The VCO1 divider can be programmed from 2 to 8.

When using a VCO1 frequency of 2949.12 MHz and a divide of 8, frequencies as low as 11.52 MHz can be achieved. Using the VCO1\_DIV will limit maximum output frequency from any output to VCO1 frequency divided by VCO1\_DIV value.

When using VCO1, the output frequency from the VCO1\_DIV will define digital delay resolution.

The VCO1\_DIV divider also impacts the total N divide value for PLL2 when VCO1 is selected, this should be accounted for when selecting PLL2\_N value.

### 9.1.9 External VCO Mode

The Fin/Fin\* input allows an external VCO to be used with PLL2 of the LMK0482x family.

Using an external VCO reduces the number of available clock inputs by one.

### 9.1.10 Clock Distribution

The LMK0482x family features a total of 14 PLL2 clock outputs driven from the internal or external VCO.

All PLL2 clock outputs have programmable output types. They can be programmed to LVPECL, LVDS, or HSDS, or LCPECL.

If OSCout is included in the total number of clock outputs the LMK0482x family is able to distribute, then up to 15 differential clocks. OSCout may be a buffered version of OSCin, DCLKout6, DCLKout8, or SYSREF.

The following sections discuss specific features of the clock distribution channels that allow the user to control various aspects of the output clocks.

# 9.1.10.1 Device Clock Divider

Each device clock, DCLKoutX, has a single clock output divider. The divider supports a divide range of 1 to 32 (even and odd) with 50% output duty cycle using duty cycle correction mode. The output of this divider may also be directed to SDCLKoutY, where Y = X + 1.

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### **Overview (continued)**

### 9.1.10.2 Sysref Clock Divider

The SYSREF clocks, SDCLKoutY, all share a common divider. The divider supports a divide range of 8 to 8191 (even and odd).

### 9.1.10.3 Device Clock Delay

The device clocks include both a analog and digital delay for phase adjustment of the clock outputs.

The analog delay allows a nominal 25 ps step size and range from 0 to 575 ps of total delay. Enabling the analog delay adds a nominal 500 ps of delay in addition to the programmed value.

The digital delay allows a group of outputs to be delayed from 4 to 32 VCO cycles. The delay step can be as small as half the period of the clock distribution path. For example, 2 GHz VCO frequency results in 250 ps coarse tuning steps. The coarse (digital) delay value takes effect on the clock outputs after a SYNC event.

There are 2 different ways to use the digital delay.

- 1. Fixed Digital Delay Allows all the outputs to have a known phase relationship upon a SYNC event. Typically performed at startup.
- 2. Dynamic Digital Delay Allows the phase relationships of clocks to change while clocks continue to operate.

### 9.1.10.4 SYSREF Delay

The global SYSREF divider includes a digital delay block which allows a global phase shift with respect to the other clocks.

Each local SYSREF clock output includes both an analog and additional local digital delay for unique phase adjustment of each SYSREF clock.

The local analog delay allows for 150 ps steps.

The local digital delay and SYSREF\_HS bit allows the each individual SYSREF output to be delayed from, 1.5 to 11 VCO cycles. The delay step can be as small as half the period of the clock distribution path by using the DCLKoutX HS bit. For example, 2 GHz VCO frequency results in 250 ps coarse tuning steps.

### 9.1.10.5 Glitchless Half Step and Glitchless Analog Delay

The device clocks include a features to ensure glitchless operation of the half step and analog delay operations when enabled.

### 9.1.10.6 Programmable Output Formats

For increased flexibility all LMK0482x family device and SYSREF clock outputs, DCLKoutX and SDCLKoutY, can be programmed to an LVDS, HSDS, LVPECL, or LCPECL output type. The OSCout can be programmed to an LVDS, LVPECL, or LVCMOS output type.

Any LVPECL output type can be programmed to 1600, or 2000 mVpp amplitude levels. The 2000 mVpp LVPECL output type is a Texas Instruments proprietary configuration that produces a 2000 mVpp differential swing for compatibility with many data converters and is also known as 2VPECL.

LCPECL allows for DC coupling SYSREF to low voltage converters.

### 9.1.10.7 Clock Output Synchronization

Using the SYNC input causes all active clock outputs to share a rising edge as programmed by fixed digital delay.

The SYNC event must occur for digital delay values to take effect.



### Overview (continued)

### 9.1.11 0-Delay

The LMK0482x family supports two types of 0-delay.

- 1. Cascaded 0-delay
- 2. Nested 0-delay

Cascaded 0-delay mode establishes a fixed deterministic phase relationship of the phase of the PLL2 input clock (OSCin) to the phase of a clock selected by the feedback mux. The 0-delay feedback may performed with an internal feedback from CLKout6, CLKout8, SYSREF, or with an external feedback loop into the FBCLKin port as selected by the FB\_MUX. Because OSCin has a fixed deterministic phase relationship to the feedback clock, OSCout will also have a fixed deterministic phase relationship to the feedback clock. In this mode PLL1 input clock (CLKinX) also has a fixed deterministic phase relationship to PLL2 input clock (OSCin), this results in a fixed deterministic phase relationship between all clocks from CLKinX to the clock outputs.

Nested 0-delay mode establishes a fixed deterministic phase relationship of the phase of the PLL1 input clock (CLKinX) to the phase of a clock selected by the feedback mux. The 0-delay feedback may performed with an internal feedback from CLKout6, CLKout8, SYSREF, or with an external feedback loop into the FBCLKin port as selected by the FB\_MUX.

Without using 0-delay mode there will be n possible fixed phase relationships from clock input to clock output depending on the clock output divide value.

Using an external 0-delay feedback reduces the number of available clock inputs by one.

### 9.1.12 Status Pins

The LMK0482x provides status pins which can be monitored for feedback or in some cases used for input depending upon device programming. For example:

- The CLKin\_SEL0 pin may indicate the LOS (loss-of-signal) for CLKin0.
- The CLKin SEL1 pin may be an input for selecting the active clock input.
- The Status\_LD1 pin may indicate if the device is locked.
- The Status\_LD2 pin may indicate if PLL2 is locked.

The status pins can be programmed to a variety of other outputs including PLL divider outputs, combined PLL lock detect signals, PLL1 Vtune railing, readback, and so forth. Refer to the programming section of this data sheet for more information.

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### 9.2 Functional Block Diagram

Figure 10 and Figure 11 illustrate the complete LMK0482x family block diagram.

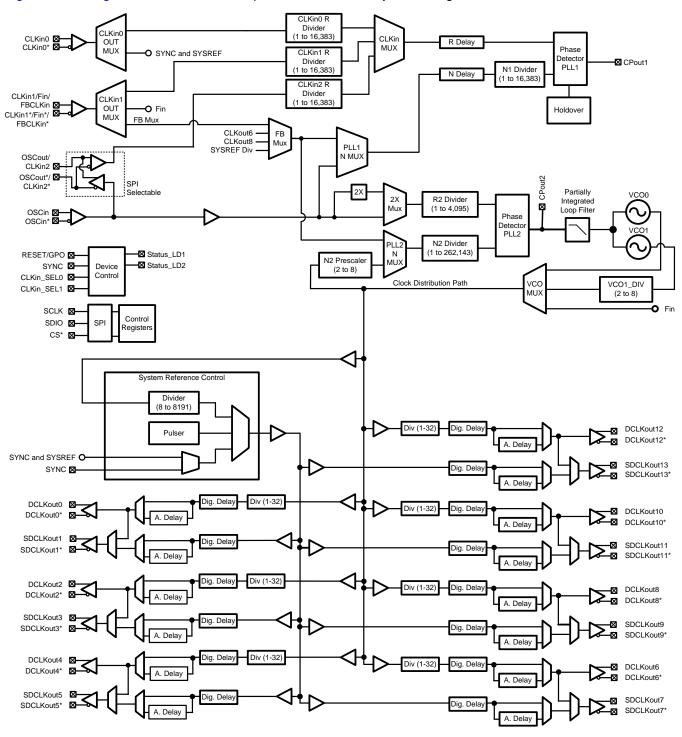


Figure 10. Detailed LMK04821 Block Diagram



## **Functional Block Diagram (continued)**

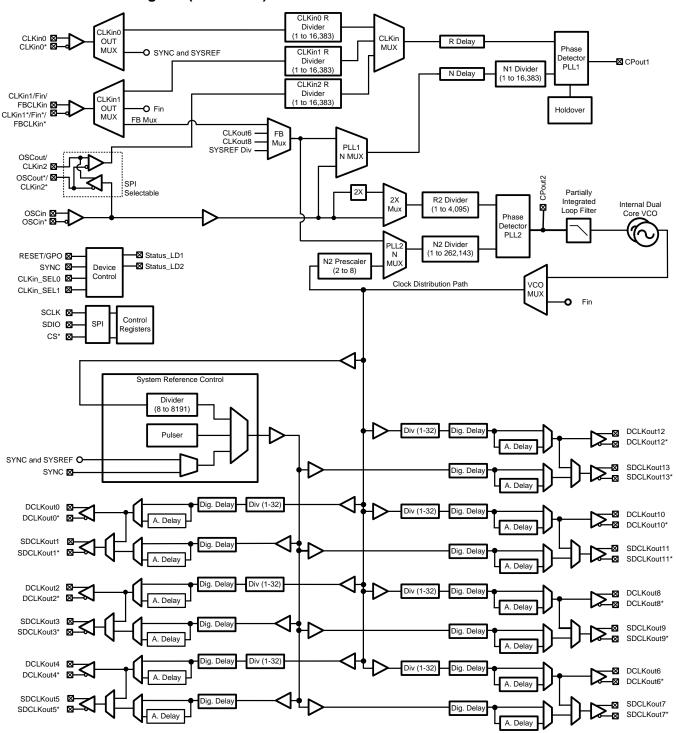


Figure 11. Detailed LMK04826 and LMK04828 Block Diagram



### Functional Block Diagram (continued)

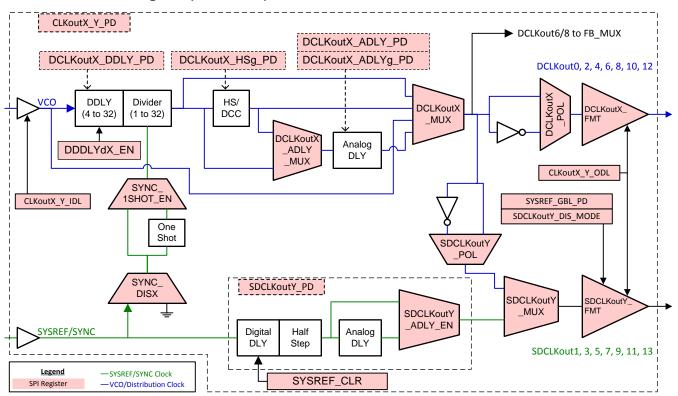


Figure 12. Device and SYSREF Clock Output Block



## **Functional Block Diagram (continued)**

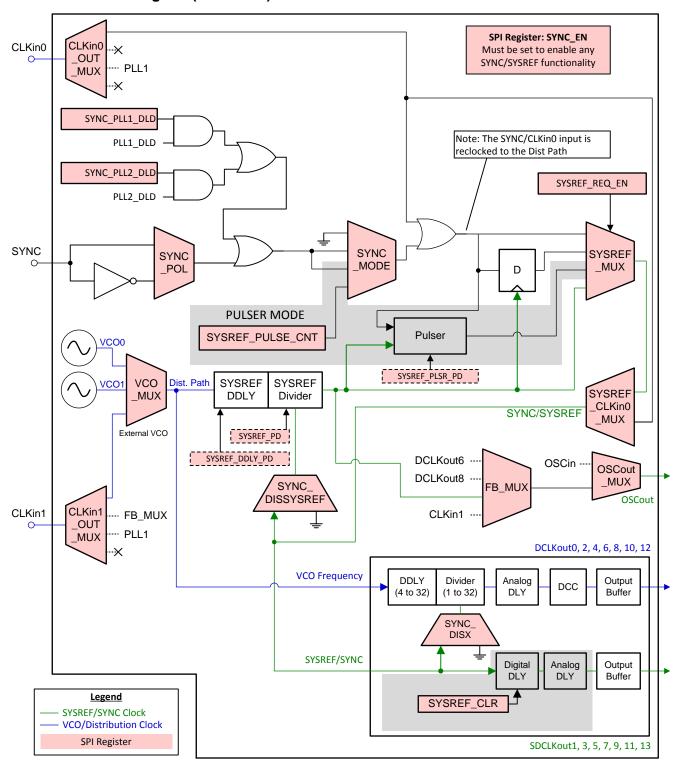


Figure 13. SYNC/SYSREF Clocking Paths



## 9.3 Feature Description

### 9.3.1 SYNC/SYSREF

The SYNC and SYSREF signals share the same clocking path. To properly use SYNC and/or SYSREF for JESD204B it is important to understand the SYNC/SYSREF system. Figure 12 illustrates the detailed diagram of a clock output block with SYNC circuitry included. Figure 13 illustrates the interconnects and highlights some important registers used in controlling the device for SYNC/SYSREF purposes.

To reset or synchronize a divider, the following conditions must be met:

- 1. SYNC\_EN must be set. This ensures proper operation of the SYNC circuitry.
- SYSREF\_MUX and SYNC\_MODE must be set to a proper combination to provide a valid SYNC/SYSREF signal.
  - If SYSREF block is being used, the SYSREF\_PD bit must be clear.
  - If the SYSREF Pulser is being used, the SYSREF\_PLSR\_PD bit must be clear.
  - For each SDCLKoutY being used for SYSREF, respective SDCLKoutY\_PD bits must be cleared.
- SYSREF\_DDLY\_PD and DCLKoutX\_DDLY\_PD bits must be clear to power up the digital delay circuitry during SYNC as use requires.
- 4. The SYNC\_DISX bit must be clear to allow SYNC/SYSREF signal to divider circuit. The SYSREF\_MUX register selects the SYNC source which resets the SYSREF/CLKoutX dividers provided the corresponding SYNC\_DISX bit is clear.
- 5. Other bits which impact the operation of SYNC such as SYNC\_1SHOT\_EN may be set as desired.

Table 1 illustrates the some possible combinations of SYSREF\_MUX and SYNC\_MODE.

**Table 1. Some Possible SYNC Configurations** 

| NAME SYNC_MODE                      |        | SYSREF_MUX | OTHER  | DESCRIPTION  |  |  |  |
|-------------------------------------|--------|------------|--|--|--|--|--|
| SYNC Disabled                       | 0      | 0          | CLKin0_OUT_MUX ≠ 0   | No SYNC will occur.  |  |  |  |
| Pin or SPI SYNC                     | 1      | 0          | CLKin0_OUT_MUX ≠ 0   | Basic SYNC functionality, SYNC pin polarity is selected by SYNC_POL. To achieve SYNC through SPI, toggle the SYNC_POL bit.                                   |  |  |  |
| Differential input SYNC             | 0 or 1 | 0 or 1     | CLKin0_OUT_MUX = 0   | Differential CLKin0 now operates as SYNC input.  |  |  |  |
| JESD204B Pulser on pin transition.  | 2      | 2          | SYSREF_PULSE_CNT sets pulse count  | Produce SYSREF_PULSE_CNT programmed number of pulses on pin transition. SYNC_POL can be used to cause SYNC via SPI.  |  |  |  |
| JESD204B Pulser on SPI programming. | 3      | 2          | SYSREF_PULSE_CNT sets pulse count  | Programming SYSREF_PULSE_CNT register starts sending the number of pulses.   |  |  |  |
| Re-clocked SYNC                     | 1      | 1          | SYSREF operational,<br>SYSREF Divider as<br>required for training frame<br>size. | Allows precise SYNC for n-bit frame training patterns for non-JESD converters such as LM97600.   |  |  |  |
| External SYSREF request             | 0      | 2          | SYSREF_REQ_EN = 1 Pulser powered up  | When SYNC pin is asserted, continuous SYSERF pulses occur. Turning on and off of the pulses is synchronized to prevent runt pulses from occurring on SYSREF. |  |  |  |
| Continuous<br>SYSREF                | Х      | 3          | SYSREF_PD = 0<br>SYSREF_DDLY_PD = 0<br>SYSREF_PLSR_PD = 1                        | Continuous SYSREF signal.  |  |  |  |

SDCLKoutY\_PD = 0 as required per SYSREF output. This applies to any SYNC or SYSREF output on SDCLKoutY when SDCLKoutY\_MUX = 1 (SYSREF output)



### Feature Description (continued)

Table 1. Some Possible SYNC Configurations (continued)

| NAME                       | SYNC_MODE | SYSREF_MUX | OTHER   | DESCRIPTION  |
|----------------------------|-----------|------------|---|--|
| Direct SYSREF distribution | 0         | 0          | CLKin0_OUT_MUX = 0<br>SDCLKoutY_DDLY = 0<br>(Local sysref DDLY<br>bypassed)<br>SYSREF_DDLY_PD = 1<br>SYSREF_PLSR_PD = 1<br>SYSREF_PD = 1. | A direct fan-out of SYSREF with no re-clocking to clock distribution path. |

#### 9.3.2 JEDEC JESD204B

#### 9.3.2.1 How To Enable SYSREF

Table 2 summarizes the bits needed to make SYSREF functionality operational.

#### **Table 2. SYSREF Bits**

| REGIS<br>TER | FIELD              | VALUE | DESCRIPTION   |  |
|--------------|--------------------|-------|---|--|
| 0x140        | SYSREF_PD          | 0     | Must be clear, power-up SYSREF circuitry.   |  |
| 0x140        | SYSREF_DDLY_<br>PD | 0     | Must be clear to power-up digital delay circuitry during initial SYNC to ensure deterministic timing.   |  |
| 0x143        | SYNC_EN            | 1     | Must be set, enable SYNC.   |  |
| 0x143        | SYSREF_CLR         | 1 → 0 | Do not hold local SYSREF DDLY block in reset except at start.  Anytime SYSREF_PD = 1 because of user programming or device RESET, it is necessary to set SYSREF_CLR for 15 VCO clock cycles to clear the local SYSREF digital delay. Once cleared, SYSREF_CLR must be cleared to allow SYSREF to operate. |  |

Enabling JESD204B operation involves synchronizing all the clock dividers with the SYSREF divder, then configuring the actual SYSREF functionality.

#### 9.3.2.1.1 Setup of SYSREF Example

The following procedure is a programming example for a system which is to operate with a 3000 MHz VCO frequency. Use DCLKout0 and DCLKout2 to drive converters at 1500 MHz. Use DCLKout4 to drive an FPGA at 150 MHz. Synchronize the converters and FPGA using a two SYSREF pulses at 10 MHz.

#### 1. Program registers 0x000 to 0x1fff as desired. Key to prepare for SYSREF operations:

- (a) Prepare for manual SYNC: SYNC\_POL = 0, SYNC\_MODE = 1, SYSREF\_MUX = 0
- (b) Setup output dividers as per example: DCLKout0\_DIV and DCLKout2\_DIV = 2 for frequency of 1500 MHz. DCLKout4\_DIV = 20 for frequency of 150 MHz.
- (c) Setup output dividers as per example: SYSREF DIV = 300 for 10 MHz SYSREF
- (d) Setup SYSREF: SYSREF\_PD = 0, SYSREF\_DDLY\_PD = 0, DCLKout0\_DDLY\_PD = 0, DCLKout2\_DDLY\_PD = 0, DCLKout4\_DDLY\_PD = 0, SYNC\_EN = 1, SYSREF\_PLSR\_PD = 0, SYSREF\_PULSE\_CNT = 1 (2 pulses). SDCLKout1\_PD = 0, SDCLKout3\_PD = 0
- (e) Clear Local SYSREF DDLY: SYSREF CLR = 1.

#### 2. Establish deterministic phase relationships between SYSREF and Device Clock for JESD204B:

- (a) Set device clock and SYSREF divider digital delays: DCLKout0\_DDLY\_CNTH, DCLKout0\_DDLY\_CNTL, DCLKout2\_DDLY\_CNTH, DCLKout2\_DDLY\_CNTL, DCLKout4\_DDLY\_CNTH, DCLKout4\_DDLY\_CNTL, SYSREF DDLY.
- (b) Set device clock digital delay half steps: DCLKout0 HS, DCLKout2 HS, DCLKout4 HS.
- (c) Set SYSREF clock digital delay as required to achieve known phase relationships: SDCLKout1\_DDLY, SDCLKout3\_DDLY, SDCLKout5\_DDLY.
- (d) To allow SYNC to effect dividers: SYNC\_DIS0 = 0, SYNC\_DIS2 = 0, SYNC\_DIS4 = 0, SYNC\_DISSYSREF = 0
- (e) Perform SYNC by toggling SYNC POL = 1 then SYNC POL = 0.



- Now that dividers are synchronized, disable SYNC from resetting these dividers. It is not desired for SYSREF to reset it's own divider or the dividers of the output clocks.
  - (a) Prevent SYNC (SYSREF) from affecting dividers: SYNC\_DIS0 = 1, SYNC\_DIS2 = 1, SYNC\_DIS4 = 1, SYNC\_DISSYSREF = 1.
- 4. Release reset of local SYSREF digital delay.
  - (a) SYSREF\_CLR = 0. Note this bit needs to be set for only 15 VCO clocks after SYSREF\_PD = 0.
- 5. Set SYSREF operation.
  - (a) Allow pin SYNC event to start pulser: SYNC MODE = 2.
  - (b) Select pulser as SYSREF signal: SYSREF MUX = 2.
- 6. Complete! Now asserting the SYNC pin, or toggling SYNC\_POL will result in a series of 2 SYSREF pulses.

#### 9.3.2.1.2 SYSREF\_CLR

The local digital delay of the SDCLKout is implemented as a shift buffer. To ensure no un-wanted pulses occur at this SYSREF output at startup, when using SYSREF, requires clearing the buffers by setting SYSREF\_CLR = 1 for 15 VCO clock cycles. After a reset, this bit is set, so it must be cleared before SYSREF output is used.

#### 9.3.2.2 SYSREF Modes

#### 9.3.2.2.1 SYSREF Pulser

This mode allows for the output of 1, 2, 4, or 8 SYSREF pulses for every SYNC pin event or SPI programming. This implements the gapped periodic functionality of the JEDEC JESD204B specification.

When in SYSREF Pulser mode, programming the field SYSREF\_PULSE\_CNT in register 0x13E will result in the pulser sending the programmed number of pulses.

#### 9.3.2.2.2 Continuous SYSREF

This mode allows for continuous output of the SYSREF clock.

Continuous operation of SYSREF is not recommended due to crosstalk from the SYSREF clock to device clock. JESD204B is designed to operate with a single burst of pulses to initialize the system at startup, after which it is theoretically not required to send another SYSREF since the system will continue to operate with deterministic phases.

If continuous operation of SYSREF is required, consider using a SYSREF output from a non-adjacent output or SYSREF from the OSCout pin to minimize crosstalk.

#### 9.3.2.2.3 SYSREF Request

This mode allows an external source to synchronously turn on or off a continuous stream of SYSREF pulses using the SYNC/SYSREF\_REQ pin.

Setup the mode by programming SYSREF\_REQ\_EN = 1 and SYSREF\_MUX = 2 (Pulser). The pulser does not need to be powered for this mode of operation.

When the SYSREF\_REQ pin is asserted, the SYSREF\_MUX will synchronously be set to continuous mode providing continuous pulses at the SYSREF frequency until the SYSREF\_REQ pin is un-asserted and the final SYSREF pulse will complete sending synchronously.



#### 9.3.3 Digital Delay

Digital (coarse) delay allows a group of outputs to be delayed by 4 to 32 VCO cycles. The delay step can be as small as half the period of the VCO cycle by using the DCLKoutX\_HS bit. There are two different ways to use the digital delay:

- 1. Fixed digital delay
- 2. Dynamic digital delay

In both delay modes, the regular clock divider is substituted with an alternative divide value. The substitute divide value consists of two values, DCLKoutX\_DDLY\_CNTH and DCLKoutX\_DDLY\_CNTL. The minimum \_CNTH/\_CNTL value is 2 and the maximum \_CNTH/\_CNTL value is 16. This will result in a minimum alternative divide value of 4 and a maximum of 32.

#### 9.3.3.1 Fixed Digital Delay

Fixed digital delay value takes effect on the clock outputs after a SYNC event. As such, the outputs will be LOW for a while during the SYNC event. Applications that cannot accept clock breakup when adjusting digital delay should use dynamic digital delay.

#### 9.3.3.1.1 Fixed Digital Delay Example

Assuming the device already has the following initial configurations, and the application should delay DCLKout2 by one VCO cycle compared to DCLKout0.

- VCO frequency = 2949.12 MHz
- DCLKout0 = 368.64 MHz (DCLKout0 DIV = 8)
- DCLKout2 = 368.64 MHz (DCLKout2 DIV = 8)

The following steps should be followed

- 1. Set DCLKout0 DDLY CNTH = 4 and DCLKout2 DDLY CNTH = 4. First part of delay for each clock.
- 2. Set DCLKout0\_DDLY\_CNTL = 4 and DCLKout2\_DDLY\_CNTL = 5. Second part of delay for each clock.
- 3. Set DCLKout0 DDLY PD = 0 and DCLKout2 DDLY PD = 0. Power up the digital delay circuit.
- 4. Set SYNC\_DIS0 = 0 and SYNC\_DIS2 = 0. Allow the output to be synchronized.
- 5. Perform SYNC by asserting, then unasserting SYNC. Either by using SYNC\_POL bit or the SYNC pin.
- 6. Now that the SYNC is complete, to save power it is allowable to power down DCLKout0\_DDLY\_PD = 1 and/or DCLKout2\_DDLY\_PD = 1.
- 7. Set SYNC\_DIS0 = 1 and SYNC\_DIS2 = 1. To prevent the output from being synchronized, very important for steady state operation when using JESD204B.

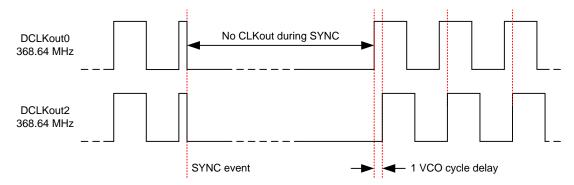


Figure 14. Fixed Digital Delay Example



#### 9.3.3.2 Dynamic Digital Delay

Dynamic digital delay allows the phase of clocks to be changed with respect to each other with little impact to the clock signal. This is accomplished by substituting the regular clock divider with an alternate divide value for one cycle. This substitution will occur a number of times equal to the value programmed into the DDLYd\_STEP\_CNT field for all outputs with DDLYdX EN = 1.

- By programming a larger alternate divider (delay) value, the phase of the adjusted outputs will be delayed with respect to the other clocks.
- By programming a smaller alternate divider (delay) value, the phase of the adjusted output will advanced with respect to the other clocks.

Table 3 shows the recommended DCLKoutX\_DDLY\_CNTH and DCLKoutX\_DDLY\_CNTL alternate divide setting for delay by one VCO cycle. The clock will output high during the DCLKoutX\_DDLY\_CNTH time to permit a continuous output clock. The clock output will be low during the DCLKoutX\_DDLY\_CNTL time.

Table 3. Recommended DCLKoutX\_DDLY\_CNTH/\_CNTL Values for Delay by One VCO Cycle

| CLOCK DIVIDER | _CNTH | _CNTL | CLOCK DIVIDER | _CNTH             | _CNTL             |
|---------------|-------|-------|---------------|-------------------|-------------------|
| 2             | 2     | 3     | 17            | 9                 | 9                 |
| 3             | 3     | 4     | 18            | 9                 | 10                |
| 4             | 2     | 3     | 19            | 10                | 10                |
| 5             | 3     | 3     | 20            | 10                | 11                |
| 6             | 3     | 4     | 21            | 11                | 11                |
| 7             | 4     | 4     | 22            | 11                | 12                |
| 8             | 4     | 5     | 23            | 12                | 12                |
| 9             | 5     | 5     | 24            | 12                | 13                |
| 10            | 5     | 6     | 25            | 13                | 13                |
| 11            | 6     | 6     | 26            | 13                | 14                |
| 12            | 6     | 7     | 27            | 14                | 14                |
| 13            | 7     | 7     | 28            | 14                | 15                |
| 14            | 7     | 8     | 29            | 15                | 15                |
| 15            | 8     | 8     | 30            | 15                | 16 <sup>(1)</sup> |
| 16            | 8     | 9     | 31            | 16 <sup>(1)</sup> | 16 <sup>(1)</sup> |

<sup>(1)</sup> To achieve \_CNTH/\_CNTL value of 16, 0 must be programmed into the \_CNTH/\_CNTL field.

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## 9.3.3.3 Single and Multiple Dynamic Digital Delay Example

In this example two separate adjustments will be made to the device clocks. In the first adjustment a single delay of 1 VCO cycle will occur between DCLKout2 and DCLKout0. In the second adjustment two delays of 1 VCO cycle will occur between DCLKout2 and DCLKout0. At this point in the example, DCLKout2 will be delayed 3 VCO cycles behind DCLKout0.

Assuming the device already has the following initial configurations:

- VCO frequency: 2949.12 MHz
- DCLKout0 = 368.64 MHz, DCLKout0 DIV = 8
- DCLKout2 = 368.64 MHz, DCLKout2 DIV = 8

The following steps illustrate the example above:

- 1. Set DCLKout2\_DDLY\_CNTH = 4. First part of delay for DCLKout2.
- 2. Set DCLKout2\_DDLY\_CNTL = 5. Second part of delay for DCLKout2.
- 3. Set DCLKout2\_DDLY\_PD = 0. Enable the digital delay for DCLKout2.
- 4. Set DDLYd2\_EN = 1. Enable dynamic digital delay for DCLKout2.
- 5. Set SYNC\_DIS0 = 1 and SYNC\_DIS2 = 0. Sync should be disabled to DCLKout0, but not DCLKout2.
- 6. Set SYNC\_MODE = 3. Enable SYNC event from SPI write to DDLYd\_STEP\_CNT's register.
- 7. Set SYNC\_MODE = 2, SYSREF\_MUX = 2. Setup proper SYNC settings.
- 8. Set DDLYd\_STEP\_CNT = 1. This begins the first adjustment.

Before step 8 DCLKout2 clock edge is aligned with DCLKout0.

After step 8, DCLKout2 counts four VCO cycles high and then five VCO cycles low as programmed by DCLKout2\_DDLY\_CNTH and DCLKout2\_DDLY\_CNTL fields, effectively delaying DCLKout2 by one VCO cycle with respect to DCLKout0. **This is the first adjustment.** 

9. Set DDLYd STEP CNT = 2. This begins the **second adjustment**.

Before step 9, DCLKout2 clock edge was delayed 1 VCO cycle from DCLKout0.

After step 9, DCLKout2 counts four VCO cycles high and then five VCO cycles low as programmed by DCLKout2\_DDLY\_CNTH and DCLKout2\_DDLY\_CNTL fields twice, delaying DCLKout2 by two VCO cycles with respect to DCLKout0. **This is the second adjustment.** 

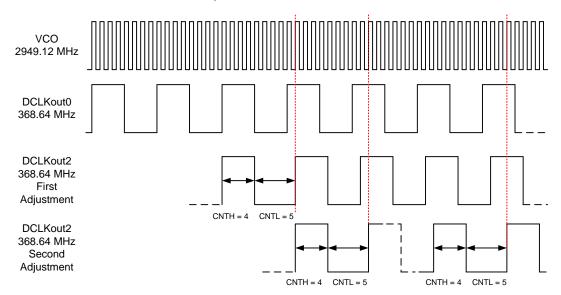


Figure 15. Single and Multiple Adjustment Dynamic Digital Delay Example



#### 9.3.4 SYSREF to Device Clock Alignment

To ensure proper JESD204B operation, the timing relationship between the SYSREF and the Device clock must be adjusted for optimum setup and hold time. The ts<sub>JESD204B</sub> defines the time between SYSREF and Device Clock for a specific condition of SYSREF divider and Device Clock digital delay. From this point, the SYSREF\_DDLY. SDCLKoutY\_DDLY, DCLKoutX\_DDLY\_CNTH, DCLKoutDDLY\_CNTL, and DCLKoutX\_MUX, SDCKLoutX\_ADLY, and so forth. can be adjusted to provide the required setup and hold time between SYSREF and Device Clock.

It is possible to digitally adjust the SYSREF up to 20 VCO cycles before the SYSREF. So for example with a 2949.12 MHz VCO frequency,  $ts_{JESD204B} + 20 \times (1/VCO \text{ Frequency}) = -80 \text{ ps} + 20 \times (1/2949.12 \text{ MHz}) = 6.7 \text{ ns}$ .

#### 9.3.5 Input Clock Switching

Manual, pin select, and automatic are three different kinds clock input switching modes can be set with the CLKin\_SEL\_MODE register.

Below is information about how the active input clock is selected and what causes a switching event in the various clock input selection modes.

#### 9.3.5.1 Input Clock Switching - Manual Mode

When CLKin\_SEL\_MODE is 0, 1, or 2 then CLKin0, CLKin1, or CLKin2 respectively is always selected as the active input clock. Manual mode will also override the EN\_CLKinX bits such that the CLKinX buffer will operate even if CLKinX is disabled with EN CLKinX = 0.

If holdover is entered in this mode, then the device will re-lock to the selected CLKin upon holdover exit.

#### 9.3.5.2 Input Clock Switching - Pin Select Mode

When CLKin\_SEL\_MODE is 3, the pins CLKin\_SEL0 and CLKin\_SEL1 select which clock input is active.

### **Configuring Pin Select Mode**

The CLKin\_SEL0\_TYPE must be programmed to an input value for the CLKin\_SEL0 pin to function as an input for pin select mode.

The CLKin\_SEL1\_TYPE must be programmed to an input value for the CLKin\_SEL1 pin to function as an input for pin select mode.

If the CLKin SELX TYPE is set as output, the pin input value is considered "Low."

The polarity of CLKin\_SEL0 and CLKin\_SEL1 input pins can be inverted with the CLKin\_SEL\_INV bit.

Table 4 defines which input clock is active depending on CLKin\_SEL0 and CLKin\_SEL1 state.

Table 4. Active Clock Input - Pin Select Mode, CLKin\_SEL\_INV = 0

| PIN CLKin_SEL1 | PIN CLKin_SEL0 | ACTIVE CLOCK |
|----------------|----------------|--------------|
| Low            | Low            | CLKin0       |
| Low            | High           | CLKin1       |
| High           | Low            | CLKin2       |
| High           | High           | Holdover     |

The pin select mode will override the EN\_CLKinX bits such that the CLKinX buffer will operate even if CLKinX is disabled with EN\_CLKinX = 0. To switch as fast as possible, keep the clock input buffers enabled (EN\_CLKinX = 1) that could be switched to.



#### 9.3.5.3 Input Clock Switching - Automatic Mode

When CLKin\_SEL\_MODE is 4, the active clock is selected in round-robin order of enabled clock inputs starting upon an input clock switch event. The switching order of the clocks is CLKin0  $\rightarrow$  CLKin1  $\rightarrow$  CLKin2  $\rightarrow$  CLKin0, and so forth.

For a clock input to be eligible to be switched through, it must be enabled using EN CLKinX.

#### **Starting Active Clock**

Upon programming this mode, the currently active clock remains active if PLL1 lock detect is high. To ensure a particular clock input is the active clock when starting this mode, program CLKin\_SEL\_MODE to the manual mode which selects the desired clock input (CLKin0, 1, or 2). Wait for PLL1 to lock PLL1\_DLD = 1, then select this mode with CLKin\_SEL\_MODE = 4.

#### 9.3.6 Digital Lock Detect

Both PLL1 and PLL2 support digital lock detect. Digital lock detect compares the phase between the reference path (R) and the feedback path (N) of the PLL. When the time error, which is phase error, between the two signals is less than a specified window size (ɛ) a lock detect count increments. When the lock detect count reaches a user specified value, PLL1\_DLD\_CNT or PLL2\_DLD\_CNT, lock detect is asserted true. Once digital lock detect is true, a single phase comparison outside the specified window will cause digital lock detect to be asserted false. This is illustrated in *Figure 16*.

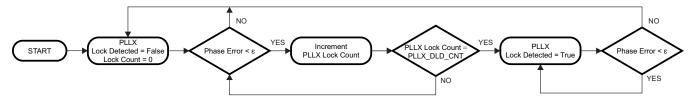


Figure 16. Digital Lock Detect Flowchart

This incremental lock detect count feature functions as a digital filter to ensure that lock detect isn't asserted for only a brief time when the phases of R and N are within the specified tolerance for only a brief time during initial phase lock.

See *Digital Lock Detect Frequency Accuracy* for more detailed information on programming the registers to achieve a specified frequency accuracy in ppm with lock detect.

The digital lock detect signal can be monitored on the Status\_LD1 or Status\_LD2 pin. The pin may be programmed to output the status of lock detect for PLL1, PLL2, or both PLL1 and PLL2.

#### 9.3.6.1 Calculating Digital Lock Detect Frequency Accuracy

See *Digital Lock Detect Frequency Accuracy* for more detailed information on programming the registers to achieve a specified frequency accuracy in ppm with lock detect.

The digital lock detect feature can also be used with holdover to automatically exit holdover mode. See *Exiting Holdover* for more info.



#### 9.3.7 Holdover

Holdover mode causes PLL2 to stay locked on frequency with minimal frequency drift when an input clock reference to PLL1 becomes invalid. While in holdover mode, the PLL1 charge pump is TRI-STATED and a fixed tuning voltage is set on CPout1 to operate PLL1 in open loop.

#### 9.3.7.1 Enable Holdover

Program HOLDOVER\_EN = 1 to enable holdover mode.

Holdover mode can be configured to set the CPout1 voltage upon holdover entry to a fixed user defined voltage or a tracked voltage.

#### 9.3.7.1.1 Fixed (Manual) CPout1 Holdover Mode

By programming MAN DAC EN = 1, then the MAN DAC value will be set on the CPout1 pin during holdover.

The user can optionally enable CPout1 voltage tracking (TRACK\_EN = 1), read back the tracked DAC value, then re-program MAN\_DAC value to a user desired value based on information from previous DAC read backs. This allows the most user control over the holdover CPout1 voltage, but also requires more user intervention.

#### 9.3.7.1.2 Tracked CPout1 Holdover Mode

By programming MAN\_DAC\_EN = 0 and TRACK\_EN = 1, the tracked voltage of CPout1 will be set on the CPout1 pin during holdover. When the DAC has acquired the current CPout1 voltage, the *DAC\_Locked* signal is set which may be observed on Status\_LD1 or Status\_LD2 pins by programming PLL1\_LD\_MUX or PLL2\_LD\_MUX respectively.

Updates to the DAC value for the Tracked CPout1 sub-mode occurs at the rate of the PLL1 phase detector frequency divided by (DAC\_CLK\_MULT \* DAC\_CLK\_CNTR).

The DAC update rate should be programmed for ≤ 100 kHz to ensure DAC holdover accuracy.

The ability to program slow DAC update rates, for example one DAC update per 4.08 seconds when using 1024 kHz PLL1 phase detector frequency with DAC\_CLK\_MULT = 16,384 and DAC\_CLK\_CNTR = 255, allows the device to *look-back* and set CPout1 at at previous "good" CPout1 tuning voltage values before the event which caused holdover to occurre.

The current voltage of DAC value can be read back using RB DAC VALUE, see RB DAC VALUE.

#### 9.3.7.2 During Holdover

PLL1 is run in open loop mode.

- PLL1 charge pump is set to TRI-STATE.
- PLL1 DLD will be un-asserted.
- · The HOLDOVER status is asserted
- During holdover If PLL2 was locked prior to entry of holdover mode, PLL2 DLD will continue to be asserted.
- CPout1 voltage will be set to:
  - a voltage set in the MAN\_DAC register (MAN\_DAC\_EN = 1).
  - a voltage determined to be the last valid CPout1 voltage (MAN\_DAC\_EN = 0).
- PLL1 will attempt to lock with the active clock input.

The HOLDOVER status signal can be monitored on the Status\_LD1 or Status\_LD2 pin by programming the PLL1\_DLD\_MUX or PLL2\_DLD\_MUX register to "Holdover Status."



#### 9.3.7.3 Exiting Holdover

Holdover mode can be exited in one of two ways.

- Manually, by programming the device from the host.
- Automatically, By a clock operating within a specified ppm of the current PLL1 frequency on the active clock input.

#### 9.3.7.4 Holdover Frequency Accuracy and DAC Performance

When in holdover mode, PLL1 will run in open loop and the DAC will set the CPout1 voltage. If Fixed CPout1 mode is used, then the output of the DAC will be a voltage dependant upon the MAN\_DAC register. If Tracked CPout1 mode is used, then the output of the DAC will be the voltage at the CPout1 pin before holdover mode was entered. When using Tracked mode and MAN\_DAC\_EN = 1, during holdover the DAC value is loaded with the programmed value in MAN\_DAC, not the tracked value.

When in Tracked CPout1 mode, the DAC has a worst case tracking error of ±2 LSBs once PLL1 tuning voltage is acquired. The step size is approximately 3.2 mV, therefore the VCXO frequency error during holdover mode caused by the DAC tracking accuracy is ±6.4 mV × Kv, where Kv is the tuning sensitivity of the VCXO in use. Therefore, the accuracy of the system when in holdover mode in ppm is:

Holdover accuracy (ppm) = 
$$\frac{\pm 6.4 \text{ mV} \times \text{Kv} \times 1e6}{\text{VCXO Frequency}}$$
 (1)

Example: consider a system with a 19.2 MHz clock input, a 153.6 MHz VCXO with a Kv of 17 kHz/V. The accuracy of the system in holdover in ppm is:

$$\pm 0.71 \text{ ppm} = \pm 6.4 \text{ mV} \times 17 \text{ kHz/V} \times 166 / 153.6 \text{ MHz}$$
 (2)

It is important to account for this frequency error when determining the allowable frequency error window to cause holdover mode to exit.

#### 9.3.7.5 Holdover Mode - Automatic Exit of Holdover

The LMK048xx device can be programmed to automatically exit holdover mode when the accuracy of the frequency on the active clock input achieves a specified accuracy. The programmable variables include PLL1\_WND\_SIZE and HOLDOVER\_DLD\_CNT.

See *Digital Lock Detect Frequency Accuracy* to calculate the register values to cause holdover to automatically exit upon reference signal recovery to within a user specified ppm error of the holdover frequency.

It is possible for the time to exit holdover to vary because the condition for automatic holdover exit is for the reference and feedback signals to have a time/phase error less than a programmable value. Because it is possible for two clock signals to be very close in frequency but not close in phase, it may take a long time for the phases of the clocks to align themselves within the allowable time/phase error before holdover exits.



#### 9.4 Device Functional Modes

The following section describes the settings to enable various modes of operation for the LMK0482x family. See Figure 12 and Figure 13 for visual diagrams of each mode.

The LMK0482x Family is a flexible device that can be configured for many different use cases. The following simplified block diagrams help show the user the different use cases of the device.

#### 9.4.1 **DUAL PLL**

Figure 17 illustrates the typical use case of the LMK0482x family in dual loop mode. In dual loop mode the reference to PLL1 from CLKin0, CLKin1, or CLKin2. An external VCXO or tunable crystal will be used to provide feedback for the first PLL and a reference to the second PLL. This first PLL cleans the jitter with the VCXO or low cost tunable crystal by using a narrow loop bandwidth. The VCXO or tunable crystal output may be buffered through the OSCout port. The VCXO or tunable crystal is used as the reference to PLL2 and may be doubled using the frequency doubler. The internal VCO drives up to seven divide/delay blocks which drive up to 14 clock outputs.

Hitless switching and holdover functionality are optionally available when the input reference clock is lost. Holdover works by fixing the tuning voltage of PLL1 to the VCXO or tunable crystal.

It is also possible to use an external VCO in place of PLL2's internal VCO. In this case one less CLKin is available as a reference.

LMK04821 includes VCO1 divider on VCO1 output.

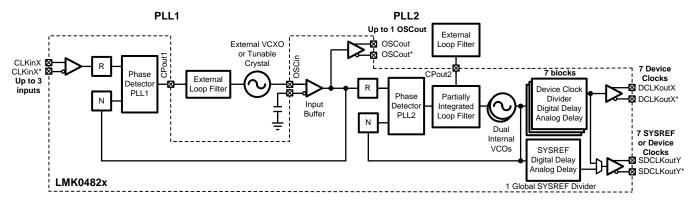


Figure 17. Simplified Functional Block Diagram for Dual Loop Mode

Table 5. Dual Loop Mode Register Configuration

| FIELD          | REGISTER<br>ADDRESS | FUNCTION  | VALUE  | SELECTED VALUE                        |
|----------------|---------------------|---|--------|---------------------------------------|
| PLL1_NCLK_MUX  | 0x13F               | Selects the input to the PLL1 N divider         | 0      | OSCin                                 |
| PLL2_NCLK_MUX  | 0x13F               | Selects the input to the PLL2 N divider         | 0      | PLL2_P                                |
| FB_MUX_EN      | 0x13F               | Enables the Feedback Mux                        | 0      | Disabled                              |
| FB_MUX         | 0x13F               | Selects the output of the Feedback Mux          | X      | Don't care because FB_MUX is disabled |
| OSCin_PD       | 0x140               | Powers down the OSCin port                      | 0      | Powered up                            |
| CLKin0_OUT_MUX | 0x147               | Selects where the output of CLKin0 is directed. | 2      | PLL1                                  |
| CLKin1_OUT_MUX | 0x147               | Selects where the output of CLKin1 is directed. |        | PLL1                                  |
| VCO_MUX        | 0x138               | Selects the VCO 0, 1 or an external VCO         | 0 or 1 | VCO 0 or VCO 1                        |



#### 9.4.2 0-DELAY Dual PLL

Figure 18 illustrates the use case of cascaded 0-delay dual loop mode. This configuration differs from dual loop mode Figure 17 in that the feedback for PLL2 is driven by a clock output instead of the VCO output. Figure 19 illustrates the use case of nested 0-delay dual loop mode. This configuration is similar to the dual PLL in *DUAL PLL* except that the feedback to the first PLL is driven by a clock output. This causes the clock outputs to have deterministic phase relationship with the clock input. Since all the clock outputs can be synchronized together, all the clock outputs can share the same deterministic phase relationship with the clock input signal. The feedback to PLL1 can be connected internally as shown using CLKout6, CLKout8, SYSREF, or externally using FBCLKin (CLKin1).

It is also possible to use an external VCO in place of PLL2's internal VCO; but one less CLKin is available as a reference and external 0-delay feedback is not available.

LMK04821 includes VCO1 divider on VCO1 output.

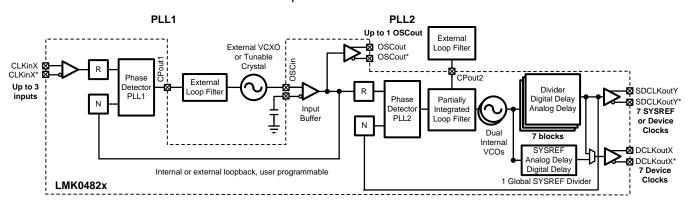


Figure 18. Simplified Functional Block Diagram for Cascaded 0-delay Dual Loop Mode

Table 6. Cascaded 0-delay Dual Loop Mode Register Configuration

| FIELD          | REGISTER<br>ADDRESS | FUNCTION  | VALUE      | SELECTED VALUE                               |
|----------------|---------------------|---|------------|--|
| PLL1_NCLK_MUX  | 0x13F               | Selects the input to the PLL1 N divider.        | 0          | OSCin  |
| PLL2_NCLK_MUX  | 0x13F               | Selects the input to the PLL2 N divider         | 1          | Feedback Mux                                 |
| FB_MUX_EN      | 0x13F               | Enables the Feedback Mux.                       | 1          | Feedback Mux Enabled                         |
| FB_MUX         | 0x13F               | Selects the output of the Feedback Mux.         | 0, 1, or 2 | Select between DCLKout6,<br>DCLKout8, SYSREF |
| OSCin_PD       | 0x140               | Powers down the OSCin port.                     | 0          | Powered up                                   |
| CLKin0_OUT_MUX | 0x147               | Selects where the output of CLKin0 is directed. | 0          | PLL1   |
| CLKin1_OUT_MUX | 0x147               | Selects where the output of CLKin1 is directed. | 0 or 2     | Fin or PLL1                                  |
| VCO_MUX        | 0x138               | Selects the VCO 0, 1 or an external VCO         | 0 or 1     | VCO 0 or VCO 1                               |



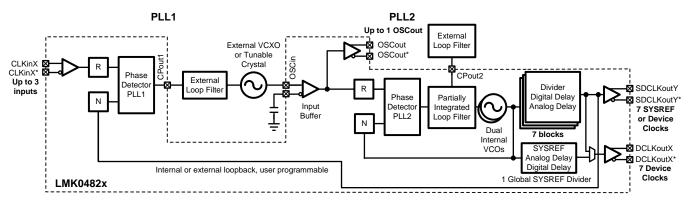


Figure 19. Simplified Functional Block Diagram for Nested 0-delay Dual Loop Mode

LMK04821 includes VCO1 divider on VCO1 output.

Table 7 illustrates nested 0-delay mode. This is the same as cascaded except the clock out feedback is to PLL1. The CLKin and CLKout have the same deterministic phase relationship but the VCXO's phase will not be deterministic to the CLKin or CLKouts.

Table 7. Nested 0-delay Dual Loop Mode Register Configuration

| FIELD          | REGISTER<br>ADDRESS | FUNCTION  | VALUE      | SELECTED VALUE                               |
|----------------|---------------------|---|------------|--|
| PLL1_NCLK_MUX  | 0x13F               | Selects the input to the PLL1 N divider.        | 1          | Feedback Mux                                 |
| PLL2_NCLK_MUX  | 0x13F               | Selects the input to the PLL2 N divider         | 0          | PLL2 P                                       |
| FB_MUX_EN      | 0x13F               | Enables the Feedback Mux.                       | 1          | Enabled                                      |
| FB_MUX         | 0x13F               | Selects the output of the Feedback Mux.         | 0, 1, or 2 | Select between DCLKout6,<br>DCLKout8, SYSREF |
| OSCin_PD       | 0x140               | Powers down the OSCin port.                     | 0          | Powered up                                   |
| CLKin0_OUT_MUX | 0x147               | Selects where the output of CLKin0 is directed. | 2          | PLL1   |
| CLKin1_OUT_MUX | 0x147               | Selects where the output of CLKin1 is directed. | 0 or 2     | Fin or PLL1                                  |
| VCO_MUX        | 0x138               | Selects the VCO 0, 1 or an external VCO         | 0 or 1     | VCO 0 or VCO 1                               |



#### 9.5 Programming

LMK0482x family devices are programmed using 24-bit registers. Each register consists of a 1-bit command field (R/W), a 2-bit multi-byte field (W1, W0), a 13-bit address field (A12 to A0) and a 8-bit data field (D7 to D0). The contents of each register is clocked in MSB first (R/W), and the LSB (D0) last. During programming, the CS\* signal is held low. The serial data is clocked in on the rising edge of the SCK signal. After the LSB is clocked in, the CS\* signal goes high to latch the contents into the shift register. It is recommended to program registers in numeric order -- for example, 0x000 to 0x1FFF -- to achieve proper device operation. Each register consists of one or more fields which control the device functionality. See electrical characteristics and Figure 1 for timing details.

R/W bit = 0 is for SPI write. R/W bit = 1 is for SPI read.

W1 and W0 shall be written as 0.

#### 9.5.1 Recommended Programming Sequence

Registers are programmed in numeric order with 0x000 being the first and 0x1FFF being the last register programmed. The recommended programming sequence from POR involves:

- 1. Program register 0x000 with RESET = 1.
- 2. Program registers in numeric order from 0x000 to 0x165. Ensure the following register is programmed as follows:
  - -0x145 = 127 (0x7F)
- 3. Program register 0x171 to 0xAA and 0x172 to 0x02.
- 4. If using LMK04821, program register 0x174.
- 5. Program registers 0x17C and 0x17D as required by OPT\_REG\_1 and OPT\_REG\_2.
- 6. Program registers 0x166 to 0x1FFF.

When using LMK04821: Program register 0x174, bits 4:0 (VCO1 DIV) with proper value before programming PLL2 N register in 0x166, 0x167, and 0x168 for proper total PLL2 N value.

Program register 0x171, 0x172, 0x17C (OPT\_REG\_1) and 0x17D (OPT\_REG\_2) before programming PLL2 in registers: 0x166, 0x167, and 0x168 to optimize PLL2 N and VCO1 phase noise performance over temperature.

#### 9.5.1.1 SPI LOCK

When writing to SPI LOCK, registers 0x1FFD, 0x1FFE, and 0x1FFF should all always be written sequentially.

#### 9.5.1.2 SYSREF CLR

When using SYSREF output, SYSREF local digital delay block should be cleared using SYSREF\_CLR bit. See SYSREF CLR for more info.

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## 9.6 Register Maps

## 9.6.1 Register Map for Device Programming

Table 8 provides the register map for device programming. Any register can be read from the same data address it is written to.

Table 8. LMK0482x Register Map

| ADDRESS |                       |                      |                        | DA                     | ιΤΑ              |                       |             |                 |
|---------|-----------------------|----------------------|------------------------|------------------------|------------------|-----------------------|-------------|-----------------|
| [11:0]  | 7                     | 6                    | 5                      | 4                      | 3                | 2                     | 1           | 0               |
| [11.0]  |                       | U                    | J                      | SPI_3WIRE              | 3                | 2                     | •           | U               |
| 0x000   | RESET                 | 0                    | 0                      | _DIS                   | 0                | 0                     | 0           | 0               |
| 0x002   | 0                     | 0                    | 0                      | 0                      | 0                | 0                     | 0           | POWER<br>DOWN   |
| 0x003   |                       |                      |                        | ID_DEVI                | CE_TYPE          |                       | 1           | -               |
| 0x004   |                       |                      |                        | ID_PRO                 | DD[15:8]         |                       |             |                 |
| 0x005   |                       |                      |                        | ID_PR                  | OD[7:0]          |                       |             |                 |
| 0x006   |                       |                      |                        | ID_MA                  | SKREV            |                       |             |                 |
| 0x00C   |                       |                      |                        | ID_VNE                 | DR[15:8]         |                       |             |                 |
| 0x00D   |                       |                      |                        | ID_VN                  | DR[7:0]          |                       |             |                 |
| 0x100   | 0                     | CLKout0_1<br>_ODL    | CLKout0_1<br>_IDL      |                        |                  | DCLKout0_DIV          |             |                 |
| 0x101   |                       | DCLKout0_            | DDLY_CNTH              | 1                      |                  | DCLKout0_I            | ODLY_CNTL   |                 |
| 0x103   |                       |                      | DCLKout0_ADLY          |                        |                  | DCLKout0_<br>ADLY_MUX | DCLKo       | ut0_MUX         |
| 0x104   | 0                     | DCLKout0<br>_HS      | SDCLKout1<br>_MUX      |                        | SDCLKo           | ut1_DDLY              |             | SDCLKout<br>_HS |
| 0x105   | 0                     | 0                    | 0                      | SDCLKout1_<br>ADLY_EN  |                  | SDCLKo                | ut1_ADLY    |                 |
| 0x106   | DCLKout0<br>_ DDLY_PD | DCLKout0<br>_ HSg_PD | DCLKout0<br>_ ADLYg_PD | DCLKout0<br>_ADLY _PD  | CLKout0_1<br>_PD | SDCLKout1             | _DIS_MODE   | SDCLKout<br>_PD |
| 0x107   | SDCLKout1<br>_POL     |                      | CLKout1_FMT            |                        | DCLKout0<br>_POL |                       | CLKout0_FMT |                 |
| 0x108   | 0                     | CLKout2_3<br>_ODL    | CLKout2_3<br>_IDL      |                        |                  | DCLKout2_DIV          |             |                 |
| 0x109   |                       | DCLKout2_            | DDLY_CNTH              | 1                      |                  | DCLKout2_I            | ODLY_CNTL   |                 |
| 0x10B   |                       |                      | DCLKout2_ADLY          |                        |                  | DCLKout2_<br>ADLY_MUX | DCLKo       | ut2_MUX         |
| 0x10C   | 0                     | DCLKout2<br>_HS      | SDCLKout3<br>_MUX      |                        | SDCLKo           | ut3_DDLY              |             | SDCLKou<br>_HS  |
| 0x10D   | 0                     | 0                    | 0                      | SDCLKout3<br>_ ADLY_EN |                  | SDCLKo                | ut3_ADLY    |                 |
| 0x10E   | DCLKout2<br>_ DDLY_PD | DCLKout2<br>_ HSg_PD | DCLKout2<br>_ ADLYg_PD | DCLKout2<br>_ADLY _PD  | CLKout2_3<br>_PD | SDCLKout3             | _DIS_MODE   | SDCLKout<br>_PD |
| 0x10F   | SDCLKout3<br>_POL     |                      | CLKout3_FMT            |                        | DCLKout2<br>_POL |                       | CLKout2_FMT |                 |
| 0x110   | 0                     | CLKout4_5<br>_ODL    | CLKout4_5<br>_IDL      |                        |                  | DCLKout4_DIV          |             |                 |
| 0x111   |                       | DCLKout4_            | DDLY_CNTH              |                        |                  | DCLKout4_I            | DDLY_CNTL   |                 |
| 0x113   |                       | DCLKout4_ADLY        |                        |                        |                  | DCLKout4_<br>ADLY_MUX | DCLKo       | ut4_MUX         |
| 0x114   | 0                     | DCLKout4<br>_HS      | SDCLKout5<br>_MUX      |                        | SDCLKo           | ut5_DDLY              |             | SDCLKou<br>_HS  |
| 0x115   | 0                     | 0                    | 0                      | SDCLKout5<br>_ ADLY_EN |                  | SDCLKo                | ut5_ADLY    |                 |
| 0x116   | DCLKout4<br>_ DDLY_PD | DCLKout4<br>_ HSg_PD | DCLKout4<br>_ ADLYg_PD | DCLKout4<br>_ADLY _PD  | CLKout4_5<br>_PD | SDCLKout5             | _DIS_MODE   | SDCLKout<br>_PD |
| 0x117   | SDCLKout5<br>_POL     |                      | CLKout5_FMT            |                        | DCLKout4<br>_POL |                       | CLKout4_FMT |                 |
| 0x118   | 0                     | CLKout6_7<br>_ODL    | CLKout6_8<br>_IDL      |                        |                  | DCLKout6_DIV          |             |                 |

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## **Register Maps (continued)**

## Table 8. LMK0482x Register Map (continued)

| ADDRESS |                        |                       |                          | DA                        | ιΤΑ                                 |                        |                                       |                   |
|---------|------------------------|-----------------------|--------------------------|---------------------------|-------------------------------------|------------------------|---------------------------------------|-------------------|
| [11:0]  | 7                      | 6                     | 5                        | 4                         | 3                                   | 2                      | 1                                     | 0                 |
| 0x119   |                        | DCLKout6_[            | DDLY_CNTH                |                           |                                     | DCLKout6_[             | DDLY_CNTL                             |                   |
| 0x11B   |                        |                       | DCLKout6_ADLY            |                           |                                     | DCLKout6_<br>ADLY_MUX  | DCLKo                                 | ut6_MUX           |
| 0x11C   | 0                      | DCLKout6<br>_HS       | SDCLKout7<br>_MUX        |                           | SDCLKo                              | ut7_DDLY               |                                       | SDCLKout7<br>_HS  |
| 0x11D   | 0                      | 0                     | 0                        | SDCLKout7<br>_ ADLY_EN    |                                     | SDCLKou                | ut7_ADLY                              |                   |
| 0x11E   | DCLKout6<br>_ DDLY_PD  | DCLKout6<br>_ HSg_PD  | DCLKout6<br>_ ADLYg_PD   | DCLKout6<br>_ADLY _PD     | CLKout6_7<br>_PD                    | SDCLKout7              | _DIS_MODE                             | SDCLKout7<br>_PD  |
| 0x11F   | SDCLKout7<br>_POL      |                       | CLKout7<br>_FMT          |                           | DCLKout6<br>_POL                    |                        | CLKout6_FMT                           |                   |
| 0x120   | 0                      | CLKout8_9<br>_ODL     | CLKout8_9<br>_IDL        |                           |                                     | DCLKout8_DIV           |                                       |                   |
| 0x121   |                        | DCLKout8_I            | DDLY_CNTH                |                           |                                     | DCLKout8_I             | ODLY_CNTL                             |                   |
| 0x123   |                        |                       | DCLKout8_ADLY            |                           | •                                   | DCLKout8<br>_ ADLY_MUX | DCLKo                                 | ut8_MUX           |
| 0x124   | 0                      | DCLKout8<br>_HS       | SDCLKout9<br>_MUX        |                           | SDCLKo                              | ut9_DDLY               |                                       | SDCLKout9<br>_HS  |
| 0x125   | 0                      | 0                     | 0                        | SDCLKout9<br>_ ADLY_EN    |                                     | SDCLKou                | ut9_ADLY                              |                   |
| 0x126   | DCLKout8<br>_ DDLY_PD  | DCLKout8<br>_ HSg_PD  | DCLKout8<br>_ ADLYg_PD   | DCLKout8<br>_ADLY _PD     | CLKout8_9<br>_PD                    | SDCLKout9              | _DIS_MODE                             | SDCLKout9<br>_PD  |
| 0x127   | SDCLKout9<br>_POL      |                       | CLKout9_FMT              |                           | DCLKout8<br>_POL                    |                        | CLKout8_FMT                           |                   |
| 0x128   | 0                      | CLKout10<br>_11 _ODL  | CLKout10<br>_11_IDL      |                           |                                     | DCLKout10_DIV          |                                       |                   |
| 0x129   |                        | DCLKout10_            | DDLY_CNTH                |                           |                                     | DCLKout10_             | DDLY_CNTL                             |                   |
| 0x12B   |                        |                       | DCLKout10_ADLY           | •                         | DCLKout10<br>_ ADLY_MUX DCLKout10_M |                        |                                       | t10_MUX           |
| 0x12C   | 0                      | DCLKout10<br>_HS      | SDCLKout11<br>_MUX       |                           | SDCLKou                             | out11_DDLY SD          |                                       | SDCLKout11<br>_HS |
| 0x12D   | 0                      | 0                     | 0                        | SDCKLout11<br>_ ADLY_EN   |                                     | SDCLKou                | t11_ADLY                              |                   |
| 0x12E   | DCLKout10<br>_ DDLY_PD | DCLKout10<br>_ HSg_PD | DLCLKout10<br>_ ADLYg_PD | DCLKout10<br>_ ADLY_PD    | CLKout10<br>_11_PD                  |                        |                                       | SDCLKout11<br>_PD |
| 0x12F   | SDCLKout11<br>_POL     |                       | CLKout11_FMT             |                           | DCLKout10<br>_POL                   | CLKout10_FMT           |                                       |                   |
| 0x130   | 0                      | CLKout12<br>_13 _ODL  | CLKout12<br>_13_IDL      |                           |                                     | DCLKout12_DIV          |                                       |                   |
| 0x131   |                        | DCLKout12_            | DDLY_CNTH                |                           |                                     | DCLKout12_             | DDLY_CNTL                             |                   |
| 0x133   |                        |                       | DCLKout12_ADLY           |                           |                                     | DCLKout12_<br>ADLY_MUX | DCLKou                                | it12_MUX          |
| 0x134   | 0                      | DCLKout12<br>_HS      | SDCLKout13<br>_MUX       |                           | SDCLKou                             | t13_DDLY               |                                       | SDCLKout13<br>_HS |
| 0x135   | 0                      | 0                     | 0                        | SDCLKout13<br>_ ADLY_EN   |                                     | SDCLKou                | t13_ADLY                              |                   |
| 0x136   | DCLKout12<br>_ DDLY_PD | DCLKout12<br>_ HSg_PD | DCLKout12<br>_ ADLYg_PD  | DCLKout12<br>_ ADLY_PD    | CLKout12<br>_13_PD                  | SDCLKout13             | 3_DIS_MODE                            | SDCLKout13<br>_PD |
| 0x137   | SDCLKout13<br>_POL     |                       | CLKout13_FMT             |                           | DCLKout12<br>_POL                   |                        | CLKout12_FMT                          |                   |
| 0x138   | 0                      | VCO                   | _MUX                     | OSCout<br>_MUX OSCout_FMT |                                     |                        |                                       |                   |
| 0x139   | 0                      | 0                     | 0                        | 0                         | 0                                   | SYSREF_<br>CLKin0_MUX  | SYSRE                                 | EF_MUX            |
| 0x13A   | 0                      | 0                     | 0                        |                           |                                     | SYSREF_DIV[12:8        | · · · · · · · · · · · · · · · · · · · |                   |
| 0x13B   |                        |                       |                          | SYSREF                    | _DIV[7:0]                           |                        |                                       |                   |
| 0x13C   | 0                      | 0                     | 0                        |                           | S                                   | YSREF_DDLY[12:         | 8]                                    |                   |



## **Register Maps (continued)**

## Table 8. LMK0482x Register Map (continued)

| ADDRESS |                     |  |                          |                                 | T Wap (Conti          | ,                      |                                 |                    |
|---------|---------------------|--|--------------------------|---------------------------------|-----------------------|------------------------|---------------------------------|--------------------|
| [11:0]  | 7                   | 6  | 5                        | 4                               | 3                     | 2                      | 1                               | 0                  |
| 0x13D   |                     |  |                          | SYSREE                          | DDLY[7:0]             | _                      | -                               |                    |
| 0x13E   | 0                   | 0  | 0                        | 0                               | 0                     | 0                      | SYSREF P                        | PULSE_CNT          |
| 0x13F   | 0                   | 0  | 0                        | 0 PLL2_NCLK PLL1_NCLK _MUX _MUX |                       |                        | MUX                             | FB_MUX<br>_EN      |
| 0x140   | PLL1_PD             | VCO_LDO_PD   | VCO_PD                   | OSCin_PD                        | SYSREF_GBL<br>_PD     | SYSREF_PD              | SYSREF<br>_DDLY_PD              | SYSREF<br>_PLSR_PD |
| 0x141   | DDLYd_<br>SYSREF_EN | DDLYd12<br>_EN                                     | DDLYd10<br>_EN           | DDLYd7_EN                       | DDLYd6_EN             | DDLYd4_EN              | DDLYd2_EN                       | DDLYd0_EN          |
| 0x142   | 0                   | 0  | 0                        |                                 | Г                     | DDLYd_STEP_CN          | Т                               |                    |
| 0x143   | SYSREF_DDLY<br>_CLR | SYNC_1SHOT<br>_EN                                  | SYNC_POL                 | SYNC_EN                         | SYNC_PLL2<br>_DLD     | SYNC_PLL1<br>_DLD      | SYNC                            | _MODE              |
| 0x144   | SYNC<br>_DISSYSREF  | SYNC_DIS12   | SYNC_DIS10               | SYNC_DIS8                       | SYNC_DIS6             | SYNC_DIS4              | SYNC_DIS2                       | SYNC_DIS0          |
| 0x145   | 0                   | 1  | 1                        | 1                               | 1                     | 1                      | 1                               | 1                  |
| 0x146   | 0                   | 0  | CLKin2_EN                | CLKin1_EN                       | CLKin0_EN             | CLKin2_TYPE            | CLKin1_TYPE                     | CLKin0_TYPE        |
| 0x147   | CLKin_SEL<br>_POL   |  | CLKin_SEL_MODE           | Ξ                               | CLKin1_C              | DUT_MUX                | CLKin0_0                        | OUT_MUX            |
| 0x148   | 0                   | 0  |                          | CLKin_SEL0_MU                   | (                     |                        | CLKin_SEL0_TYP                  | E                  |
| 0x149   | 0                   | SDIO_RDBK<br>_TYPE                                 |                          | CLKin_SEL1_MU                   | <                     |                        | CLKin_SEL1_TYP                  | E                  |
| 0x14A   | 0                   | 0  |                          | RESET_MUX                       |                       |                        | RESET_TYPE                      |                    |
| 0x14B   | LOS_TI              | LOS_TIMEOUT LOS_EN TRACK_EN HOLDOVER MAN_DAC MAN_D |                          |                                 |                       | DAC[9:8]               |                                 |                    |
| 0x14C   |                     | MAN_DAC[7:0]                                       |                          |                                 |                       |                        |                                 |                    |
| 0x14D   | 0                   | 0  |                          |                                 | DAC_TR                | IP_LOW                 |                                 |                    |
| 0x14E   | DAC_CL              | K_MULT   |                          |                                 | DAC_TR                | IP_HIGH                |                                 |                    |
| 0x14F   |                     |  | •                        | DAC_CL                          | K_CNTR                |                        |                                 |                    |
| 0x150   | 0                   | CLKin<br>_OVERRIDE                                 | 0                        | HOLDOVER<br>_ PLL1_DET          | HOLDOVER<br>_LOS _DET | HOLDOVER<br>_VTUNE_DET | HOLDOVER<br>_HITLESS<br>_SWITCH | HOLDOVER<br>_EN    |
| 0x151   | 0                   | 0  |                          |                                 | HOLDOVER_D            | DLD_CNT[13:8]          |                                 |                    |
| 0x152   |                     | 11   | 11                       | HOLDOVER_                       | DLD_CNT[7:0]          |                        |                                 |                    |
| 0x153   | 0                   | 0  |                          |                                 | CLKin0_               | _R[13:8]               |                                 |                    |
| 0x154   |                     | <u>I</u>   | <u>I</u>                 | CLKin(                          | )_R[7:0]              |                        |                                 |                    |
| 0x155   | 0                   | 0  |                          |                                 | CLKin1_               | _R[13:8]               |                                 |                    |
| 0x156   |                     | I .  | I .                      | CLKin1                          | _R[7:0]               |                        |                                 |                    |
| 0x157   | 0                   | 0  |                          |                                 | CLKin2_               | _R[13:8]               |                                 |                    |
| 0x158   |                     | 11   | 11                       | CLKin2                          | 2_R[7:0]              |                        |                                 |                    |
| 0x159   | 0                   | 0  |                          |                                 | PLL1_l                | N[13:8]                |                                 |                    |
| 0x15A   |                     | I .  | I .                      | PLL1_                           | _N[7:0]               |                        |                                 |                    |
| 0x15B   | PLL1_W              | ND_SIZE  | PLL1<br>_CP_TRI          | PLL1<br>_CP_POL                 |                       | PLL1_C                 | P_GAIN                          |                    |
| 0x15C   | 0                   | 0  |                          |                                 | PLL1_DLD.             | _CNT[13:8]             |                                 |                    |
| 0x15D   |                     | 1  | 1                        | PLL1_DL                         | D_CNT[7:0]            |                        |                                 |                    |
| 0x15E   | 0                   | 0 PLL1_R_DLY PLL1_N_DLY                            |                          |                                 |                       |                        |                                 |                    |
| 0x15F   |                     | I  | PLL1_LD_MUX PLL1_LD_TYPE |                                 |                       |                        |                                 |                    |
| 0x160   | 0                   | 0  | 0 0 PLL2_R[11:8]         |                                 |                       |                        |                                 |                    |
| 0x161   |                     | 1  | 1                        | PLL2                            | _R[7:0]               |                        |                                 |                    |
| 0x162   |                     | PLL2_P   |                          | -                               | OSCin_FREQ            |                        | PLL2<br>_XTAL_EN                | PLL2<br>_REF_2X_EN |
| 0x163   | 0                   | 0  | 0                        | 0                               | 0                     | 0                      |                                 | CAL[17:16]         |
| 0x164   |                     | 1  | 1                        | PLL2 N                          | CAL[15:8]             | 1                      |                                 | <u> </u>           |
| 0x165   |                     |  |                          |                                 |                       |                        |                                 |                    |
|         | 1                   | PLL2_N_CAL[7:0]                                    |                          |                                 |                       |                        |                                 |                    |



## **Register Maps (continued)**

## Table 8. LMK0482x Register Map (continued)

| ADDRESS |         | DATA                     |         |                 |            |                     |                 |                      |  |
|---------|---------|--------------------------|---------|-----------------|------------|---------------------|-----------------|----------------------|--|
| [11:0]  | 7       | 6                        | 5       | 4               | 3          | 2                   | 1               | 0                    |  |
| 0x166   | 0       | 0                        | 0       | 0               | 0          | PLL2_FCAL<br>_DIS   | PLL2_N          | N[17:16]             |  |
| 0x167   |         |                          |         | PLL2_           | N[15:8]    |                     |                 |                      |  |
| 0x168   |         |                          |         | PLL2_           | _N[7:0]    |                     |                 |                      |  |
| 0x169   | 0       | PLL2_WI                  | ND_SIZE | PLL2_C          | P_GAIN     | PLL2<br>_CP_POL     | PLL<br>2_CP_TRI | 1                    |  |
| 0x16A   | 0       | SYSREF_REQ_<br>EN        |         |                 | PLL2_DLD   | _CNT[15:8]          |                 |                      |  |
| 0x16B   |         |                          |         | PLL2_DL0        | D_CNT[7:0] |                     |                 |                      |  |
| 0x16C   | 0       | 0                        |         | PLL2_LF_R4      |            |                     | PLL2_LF_R3      |                      |  |
| 0x16D   |         | PLL2_                    | LF_C4   |                 |            | PLL2_               | LF_C3           |                      |  |
| 0x16E   |         | PLL2_LD_MUX PLL2_LD_TYPE |         |                 |            |                     |                 |                      |  |
| 0x171   | 1       | 0                        | 1       | 0               | 1          | 0                   | 1               | 0                    |  |
| 0x172   | 0       | 0                        | 0       | 0               | 0          | 0                   | 1               | 0                    |  |
| 0x173   | 0       | PLL2_PRE_PD              | PLL2_PD | 0               | 0          | 0                   | 0               | 0                    |  |
| 0x174   | 0       | 0                        | 0       |                 |            | VCO1_DIV            |                 |                      |  |
| 0x17C   |         |                          |         | OPT_I           | REG_1      |                     |                 |                      |  |
| 0x17D   |         |                          |         | OPT_I           | REG_2      |                     |                 |                      |  |
| 0x182   | 0       | 0                        | 0       | 0               | 0          | RB_PLL1_<br>LD_LOST | RB_PLL1_LD      | CLR_PLL1_<br>LD_LOST |  |
| 0x183   | 0       | 0                        | 0       | 0               | 0          | RB_PLL2_<br>LD_LOST | RB_PLL2_LD      | CLR_PLL2_<br>LD_LOST |  |
| 0x184   | RB_DAC_ |                          |         |                 |            |                     |                 | RB_CLKin0_<br>LOS    |  |
| 0x185   |         | RB_DAC_VALUE[7:0]        |         |                 |            |                     |                 |                      |  |
| 0x188   | 0       | 0                        | 0       | RB_<br>HOLDOVER | Х          | Х                   | Х               | Х                    |  |
| 0x1FFD  |         |                          |         | SPI_LO          | CK[23:16]  | •                   |                 | •                    |  |
| 0x1FFE  |         |                          |         | SPI_LO          | CK[15:8]   |                     |                 |                      |  |
| 0x1FFF  |         |                          |         | SPI_LC          | OCK[7:0]   |                     |                 |                      |  |



### 9.7 Device Register Descriptions

The following section details the fields of each register, the Power On Reset Defaults, and specific descriptions of each bit.

In some cases similar fields are located in multiple registers. In this case specific outputs may be designated as X or Y. In these cases the X will represent even numbers from 0 to 12 and the Y will represent odd numbers from 1 to 13. In the case where X and Y are both used in a bit name, then Y = X + 1.

#### 9.7.1 System Functions

#### 9.7.1.1 RESET, SPI\_3WIRE\_DIS

This register contains the RESET function.

Table 9. Register 0x000

| BIT | NAME          | POR<br>DEFAULT | DESCRIPTION  |
|-----|---------------|----------------|--|
| 7   | RESET         | 0              | Normal Operation     Reset (automatically cleared)   |
| 6:5 | NA            | 0              | Reserved   |
| 4   | SPI_3WIRE_DIS | 0              | Disable 3 wire SPI mode. 4 Wire SPI mode is enabled by selecting SPI Read back in one of the output MUX settings. For example CLKin0_SEL_MUX.  0: 3 Wire Mode enabled  1: 3 Wire Mode disabled |
| 3:0 | NA            | NA             | Reserved   |

#### 9.7.1.2 POWERDOWN

This register contains the POWERDOWN function.

Table 10. Register 0x002

| BIT | NAME      | POR<br>DEFAULT | DESCRIPTION                         |  |
|-----|-----------|----------------|-------------------------------------|--|
| 7:1 | NA        | 0              | Reserved                            |  |
| 0   | POWERDOWN | 0              | 0: Normal Operation<br>1: Powerdown |  |

## 9.7.1.3 ID\_DEVICE\_TYPE

This register contains the product device type. This is read only register.

Table 11. Register 0x003

| BIT | NAME           | POR<br>DEFAULT | DESCRIPTION              |  |
|-----|----------------|----------------|--------------------------|--|
| 7:0 | ID_DEVICE_TYPE | 6              | PLL product device type. |  |



## 9.7.1.4 ID\_PROD[15:8], ID\_PROD

These registers contain the product identifier. This is a read only register.

## Table 12. ID\_PROD Register Configuration, ID\_PROD[15:0]

| MSB        | LSB        |
|------------|------------|
| 0x004[7:0] | 0x005[7:0] |

| ВІТ | REGISTERS | FIELD NAME    | POR<br>DEFAULT | DESCRIPTION                    |
|-----|-----------|---------------|----------------|--------------------------------|
| 7:0 | 0x004     | ID_PROD[15:8] | 208            | MSB of the product identifier. |
| 7:0 | 0x005     | ID_PROD       | 91             | LSB of the product identifier. |

#### 9.7.1.5 ID MASKREV

This register contains the IC version identifier. This is a read only register.

## Table 13. Register 0x006

| ВІТ | NAME       | POR<br>DEFAULT | DESCRIPTION                        |  |
|-----|------------|----------------|------------------------------------|--|
|     |            | 36             | IC version identifier for LMK04821 |  |
| 7:0 | ID_MASKREV | 37             | IC version identifier for LMK04826 |  |
|     |            | 32             | IC version identifier for LMK04828 |  |

## 9.7.1.6 ID\_VNDR[15:8], ID\_VNDR

These registers contain the vendor identifier. This is a read only register.

#### Table 14. ID\_VNDR Register Configuration, ID\_VNDR[15:0]

| MSB        | LSB        |  |
|------------|------------|--|
| 0x00C[7:0] | 0x00D[7:0] |  |

#### Table 15. Registers 0x00C, 0x00D

| BIT | REGISTERS | NAME          | POR<br>DEFAULT | DESCRIPTION                   |
|-----|-----------|---------------|----------------|-------------------------------|
| 7:0 | 0x00C     | ID_VNDR[15:8] | 81             | MSB of the vendor identifier. |
| 7:0 | 0x00D     | ID_VNDR       | 4              | LSB of the vendor identifier. |

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### 9.7.2 (0x100 - 0x138) Device Clock and SYSREF Clock Output Controls

## 9.7.2.1 CLKoutX\_Y\_ODL, CLKoutX\_Y\_IDL, DCLKoutX\_DIV

These registers control the input and output drive level as well as the device clock out divider values.

Table 16. Registers 0x100, 0x108, 0x110, 0x118, 0x120, 0x128, and 0x130

| BIT | NAME          | POR<br>DEFAULT  | DESCRIPTION         |  |  |
|-----|---------------|---|---------------------|--|--|
| 7   | NA            | 0   | Reserved            |  |  |
| 6   | CLKoutX_Y_ODL | 0   | Output drive level. |  |  |
| 5   | CLKoutX_Y_IDL | 0   | Input drive level.  |  |  |
|     | DCLKoutX_DIV  | $X = 0 \rightarrow 2$ $X = 2 \rightarrow 4$ $X = 4 \rightarrow 8$ $X = 6 \rightarrow 8$ $X = 8 \rightarrow 8$ $X = 10 \rightarrow 8$ $X = 12 \rightarrow 2$ |                     | or the clock output, the divide may be even or odd. duty cycle clock if duty cycle correction (DCC) is 2 (bypass), equivalent divide of 1. |  |
|     |               |   | Field Value         | Divider Value  |  |
| 4:0 |               |   | 0 (0x00)            | 32   |  |
| 4.0 |               |   | 1 (0x01)            | 1 (1)  |  |
|     |               |   | 2 (0x02)            | 2  |  |
|     |               |   |                     |  |  |
|     |               |   | 30 (0x1E)           | 30   |  |
|     |               |   | 31 (0x1F)           | 31   |  |

<sup>(1)</sup> Not valid if DCLKoutX\_MUX = 0, Divider only. Not valid if DCLKoutX\_MUX = 3 (Analog Delay + Divider) and DCLKoutX\_ADLY\_MUX = 0 (without duty cycle correction/halfstep).

#### 9.7.2.2 DCLKoutX\_DDLY\_CNTH, DCLKoutX\_DDLY\_CNTL

This register controls the digital delay high and low count values for the device clock outputs.

Table 17. Registers 0x101, 0x109, 0x111, 0x119, 0x121, 0x129, 0x131

| BIT | NAME                   | POR<br>DEFAULT | DESCRIPTION                                    |  |  |
|-----|------------------------|----------------|--|--|--|
|     |                        |                | Number of clock cycles the output will be high | when digital delay is engaged.         |  |
|     |                        |                | Field Value                                    | Delay Values                           |  |
|     |                        |                | 0 (0x00)                                       | 16                                     |  |
| 7:4 | DCLKoutX<br>_DDLY_CNTH | 5              | 1 (0x01)                                       | Reserved                               |  |
|     | _5521_0((())           |                | 2 (0x02)                                       | 2                                      |  |
|     |                        |                |  |  |  |
|     |                        |                | 15 (0x0F)                                      | 15                                     |  |
|     |                        | - 5            | Number of clock cycles the output will be low  | when dynamic digital delay is engaged. |  |
|     | DCLKoutX<br>_DDLY_CNTL |                | Field Value                                    | Delay Values                           |  |
|     |                        |                | 0 (0x00)                                       | 16                                     |  |
| 3:0 |                        |                | 1 (0x01)                                       | Reserved                               |  |
|     |                        |                | 2 (0x02)                                       | 2                                      |  |
|     |                        |                |  |  |  |
|     |                        |                | 15 (0x0F)                                      | 15                                     |  |



## 9.7.2.3 DCLKoutX\_ADLY, DCLKoutX\_ADLY\_MUX, DCLKout\_MUX

These registers control the analog delay properties for the device clocks.

Table 18. Registers 0x103, 0x10B, 0x113, 0x11B, 0x123, 0x12B, 0x133

| ВІТ | NAME                  | POR<br>DEFAULT | DESCRIPTION   |  |  |
|-----|-----------------------|----------------|---|--|--|
|     |                       |                | Device clock analog delay value. Setting this additional to the delay of each 25 ps step. Eff   |  |  |
|     |                       |                | Field Value   | Delay Value                                      |  |
|     |                       |                | 0 (0x00)  | 0 ps   |  |
| 7:3 | DCLKoutX_ALDY         | 0              | 1 (0x01)  | 25 ps  |  |
|     |                       |                | 2 (0x02)  | 50 ps  |  |
|     |                       |                |   |  |  |
|     |                       |                | 23 (0x17)   | 575 ps   |  |
| 2   | DCLKoutX_ADLY<br>_MUX | 0              | This register selects the input to the analog delay for the device clock. Used when DCLKoutX_MUX = 3.  0: Divided without duty cycle correction or half step. (1)  1: Divided with duty cycle correction and half step. |  |  |
|     |                       | UX 0           | This selects the input to the device clock buffe  | er.  |  |
|     |                       |                | Field Value   | Mux Output                                       |  |
|     |                       |                | 0 (0x0)   | Divider only (1)                                 |  |
| 1:0 | DCLKoutX_MUX          |                | 1 (0x1)   | Divider with Duty Cycle Correction and Half Step |  |
|     |                       |                | 2 (0x2)   | Bypass   |  |
|     |                       |                | 3 (0x3)   | Analog Delay + Divider                           |  |

<sup>(1)</sup> DCLKoutX\_DIV = 1 is not valid.

## 9.7.2.4 DCLKoutX\_HS, SDCLKoutY\_MUX, SDCLKoutY\_DDLY, SDCLKoutY\_HS

These registers set the half step for the device clock, the SYSREF output MUX, the SYSREF clock digital delay, and half step.

Table 19. Registers 0x104, 0x10C, 0x114, 0x11C, 0x124, 0x12C, 0x134

| BIT | NAME           | POR<br>DEFAULT | DESCRIPTION   |                                     |
|-----|----------------|----------------|---|-------------------------------------|
| 7   | NA             | 0              | Reserved  |                                     |
| 6   | DCLKoutX_HS    | 0              | Sets the device clock half step value. Half step 0: 0 cycles 1: -0.5 cycles       | must be zero (0) for a divide of 1. |
| 5   | SDCLKoutY_MUX  | 0              | Sets the input the the SDCLKoutX outputs. 0: Device clock output 1: SYSREF output |                                     |
|     | SDCLKoutY_DDLY | KoutY_DDLY 0   | Sets the number of VCO cycles to delay the SDCLKout by.                           |                                     |
|     |                |                | Field Value   | Delay Cycles                        |
|     |                |                | 0 (0x00)  | Bypass                              |
| 4:1 |                |                | 1 (0x01)  | 2                                   |
| 4.1 |                |                | 2 (0x02)  | 3                                   |
|     |                |                |   |                                     |
|     |                |                | 10 (0x0A)   | 11                                  |
|     |                |                | 11 to 15 (0x0B to 0x0F)   | Reserved                            |
| 0   | SDCLKoutY_HS   | 0              | Sets the SYSREF clock half step value. 0: 0 cycles 1: -0.5 cycles                 |                                     |

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### 9.7.2.5 SDCLKoutY\_ADLY\_EN, SDCLKoutY\_ADLY

These registers set the analog delay parameters for the SYSREF outputs.

Table 20. Registers 0x105, 0x10D, 0x115, 0x11D, 0x125, 0x12D, 0x135

| BIT | NAME                  | POR<br>DEFAULT | DESCRIPTION  |                            |  |
|-----|-----------------------|----------------|--|----------------------------|--|
| 7:5 | NA                    | 0              | Reserved   |                            |  |
| 4   | SDCLKoutY<br>_ADLY_EN | 0              | Enables analog delay for the SYSREF output. 0: Disabled 1: Enabled                         |                            |  |
|     | SDCLKoutY<br>_ADLY    | SDCLKoutY      | Sets the analog delay value for the SYSREF additional 700 ps in propagation delay. Effecti |                            |  |
|     |                       |                | Field Value  | Delay Value                |  |
|     |                       |                | 0 (0x0)  | 0 ps                       |  |
|     |                       |                | 1 (0x1)  | 600 ps                     |  |
| 3:0 |                       |                | 2 (0x2)  | 750 ps (+150 ps from 0x1)  |  |
|     |                       |                | 3 (0x3)  | 900 ps (+150 ps from 0x2)  |  |
|     |                       |                |  |                            |  |
|     |                       |                | 14 (0xE)   | 2100 ps (+150 ps from 0xD) |  |
|     |                       |                | 15 (0xF)   | 2250 ps (+150 ps from 0xE) |  |



## 9.7.2.6 DCLKoutX\_DDLY\_PD, DCLKoutX\_HSg\_PD, DCLKout\_ADLYg\_PD, DCLKoutX\_Y\_PD, SDCLKoutY\_DIS\_MODE, SDCLKoutY\_PD

This register controls the power down functions for the digital delay, glitchless half step, glitchless analog delay, analog delay, outputs, and SYSREF disable modes.

Table 21. Registers 0x106, 0x10E, 0x116, 0x11E, 0x126, 0x12E, 0x136

| BIT | NAME                   | POR DEFAULT   | DESCR   | RIPTION   |  |  |          |  |
|-----|------------------------|---|---|---|--|--|----------|--|
| 7   | DCLKoutX<br>_DDLY_PD   | 0   | Powerdown the device clock digital delay circuitry. 0: Enabled 1: Powerdown |   |  |  |          |  |
| 6   | DCLKoutX<br>_HSg_PD    | 1   | Powerdown the device clock glitchless half 0: Enabled 1: Powerdown          |   |  |  |          |  |
| 5   | DCLKoutX<br>_ADLYg_PD  | 1   |   | Powerdown the device clock glitchless analog delay feature.  0: Enabled, analog delay step size of one code is glitchless between values 1 to 23.  1: Powerdown |  |  |          |  |
| 4   | DCLKoutX<br>_ADLY_PD   | 1   | Powerdown the device clock analog delay feature. 0: Enabled 1: Powerdown    |   |  |  |          |  |
| 3   | CLKoutX_Y_PD           | $X_{-}Y = 0_{-}1 \rightarrow 1$<br>$X_{-}Y = 2_{-}3 \rightarrow 1$<br>$X_{-}Y = 4_{-}5 \rightarrow 0$<br>$X_{-}Y = 6_{-}7 \rightarrow 0$<br>$X_{-}Y = 8_{-}9 \rightarrow 0$<br>$X_{-}Y = 10_{-}11 \rightarrow 0$<br>$X_{-}Y = 12_{-}13 \rightarrow 1$ | Powerdown the clock group defined by X and Y. 0: Enabled 1: Powerdown       |   |  |  |          |  |
|     |                        |   | Configures the output state of the SYSREF                                   |   |  |  |          |  |
|     |                        |   | Field Value   | Disable Mode  |  |  |          |  |
|     |                        |   | 0 (0x00)  | Active in normal operation  |  |  |          |  |
| 2:1 | SDCLKoutY<br>_DIS_MODE | 0   | 1 (0x01)  | If SYSREF_GBL_PD = 1, the output is a logic low, otherwise it is active.  |  |  |          |  |
|     | _                      |   |   |   |  |  | 2 (0x02) | If SYSREF_GBL_PD = 1, the output is a nominal Vcm voltage <sup>(1)</sup> , otherwise it is active. |
|     |                        |   | 3 (0x03)  | Output is a nominal Vcm voltage <sup>(1)</sup>  |  |  |          |  |
| 0   | SDCLKoutY_PD           | 1   | Powerdown SDCLKoutY and set to the state                                    | e defined by SDCLKoutY_DIS_MODE   |  |  |          |  |

<sup>(1)</sup> If LVPECL mode is used with emitter resistors to ground, the output Vcm will be ~0 V, each pin will be ~0 V.



## 9.7.2.7 SDCLKoutY\_POL, SDCLKoutY\_FMT, DCLKoutX\_POL, DCLKoutX\_FMT

These registers configure the output polarity, and format.

Table 22. Registers 0x107, 0x10F, 0x117, 0x11F, 0x127, 0x12F, 0x137

| BIT | NAME             | POR<br>DEFAULT                              | DESCRIPTION  |                  |  |
|-----|------------------|---|--|------------------|--|
| 7   | SDCLKoutY_POL    | 0   | Sets the polarity of clock on SDCLKoutY when device clock output is selected with SDCLKoutY_MUX.  0: Normal  1: Inverted |                  |  |
|     |                  |   | Sets the output format of the SYSREF clocks  |                  |  |
|     |                  |   | Field Value  | Output Format    |  |
|     |                  |   | 0 (0x00)   | Powerdown        |  |
|     |                  |   | 1 (0x01)   | LVDS             |  |
| 0.4 | CDCL Variety FMT | 0   | 2 (0x02)   | HSDS 6 mA        |  |
| 6:4 | SDCLKoutY_FMT    | 0   | 3 (0x03)   | HSDS 8 mA        |  |
|     |                  |   | 4 (0x04)   | HSDS 10 mA       |  |
|     |                  |   | 5 (0x05)   | LVPECL 1600 mV   |  |
|     |                  |   | 6 (0x06)   | LVPECL 2000 mV   |  |
|     |                  |   | 7 (0x07)   | LCPECL           |  |
| 3   | DCLKoutX_POL     | 0   | Sets the polarity of the device clocks from the 0: Normal 1: Inverted  | DCLKoutX outputs |  |
|     |                  |   | Sets the output format of the device clocks.   |                  |  |
|     |                  | LMK04821: 0                                 | Field Value  | Output Format    |  |
|     |                  | LMK04821. 0                                 | 0 (0x00)   | Powerdown        |  |
|     |                  | LMK04828B:                                  | 1 (0x01)   | LVDS             |  |
| 0.0 | DOLK- W FMT      | $X = 0 \rightarrow 0$ $X = 2 \rightarrow 0$ | 2 (0x02)   | HSDS 6 mA        |  |
| 2:0 | DCLKoutX_FMT     | $X = 4 \rightarrow 1$                       | 3 (0x03)   | HSDS 8 mA        |  |
|     |                  | $X = 6 \rightarrow 1$ $X = 8 \rightarrow 1$ | 4 (0x04)   | HSDS 10 mA       |  |
|     |                  | $X = 10 \rightarrow 1$                      | 5 (0x05)   | LVPECL 1600 mV   |  |
|     |                  | X = 12 → 0                                  | 6 (0x06)   | LVPECL 2000 mV   |  |
|     |                  |   | 7 (0x07)   | LCPECL           |  |



## 9.7.3 SYSREF, SYNC, and Device Config

## 9.7.3.1 VCO\_MUX, OSCout\_MUX, OSCout\_FMT

This register selects the clock distribution source, and OSCout parameters.

Table 23. Register 0x138

| ВІТ | NAME       | POR<br>DEFAULT | DESCRIPTION  Reserved   |   |  |
|-----|------------|----------------|---|---|--|
| 7   | NA         | 0              |   |   |  |
|     |            |                | Selects clock distribution path source from Vo                  | CO0, VCO1, or CLKin (external VCO)      |  |
|     |            |                | Field Value   | VCO Selected                            |  |
| 6:5 | VCO_MUX    | 0              | 0 (0x00)  | VCO 0                                   |  |
| 0.5 | VCO_IVIOX  | U              | 1 (0x01)  | VCO 1                                   |  |
|     |            |                | 2 (0x02)  | CLKin1 (external VCO)                   |  |
|     |            |                | 3 (0x03)  | Reserved                                |  |
| 4   | OSCout_MUX | 0              | Select the source for OSCout: 0: Buffered OSCin 1: Feedback Mux |   |  |
|     |            |                | Selects the output format of OSCout. When p CLKin2.             | powered down, these pins may be used as |  |
|     |            |                | Field Value   | OSCout Format                           |  |
|     |            |                | 0 (0x00)  | Powerdown (CLKin2)                      |  |
|     |            |                | 1 (0x01)  | LVDS                                    |  |
|     |            |                | 2 (0x02)  | Reserved                                |  |
|     |            |                | 3 (0x03)  | Reserved                                |  |
|     |            |                | 4 (0x04)  | LVPECL 1600 mVpp                        |  |
|     |            |                | 5 (0x05)  | LVPECL 2000 mVpp                        |  |
| 3:0 | OSCout_FM1 | OSCout_FMT 4   | 6 (0x06)  | LVCMOS (Norm / Inv)                     |  |
|     |            |                | 7 (0x07)  | LVCMOS (Inv / Norm)                     |  |
|     |            |                | 8 (0x08)  | LVCMOS (Norm / Norm)                    |  |
|     |            |                | 9 (0x09)  | LVCMOS (Inv / Inv)                      |  |
|     |            |                | 10 (0x0A)   | LVCMOS (Off / Norm)                     |  |
|     |            |                | 11 (0x0B)   | LVCMOS (Off / Inv)                      |  |
|     |            |                | 12 (0x0C)   | LVCMOS (Norm / Off)                     |  |
|     |            |                | 13 (0x0D)   | LVCMOS (Inv / Off)                      |  |
|     |            |                | 14 (0x0E)   | LVCMOS (Off / Off)                      |  |



## 9.7.3.2 SYSREF\_CLKin0\_MUX, SYSREF\_MUX

This register sets the source for the SYSREF outputs. Refer to Figure 13 and SYNC/SYSREF.

Table 24. Register 0x139

| ВІТ | NAME       | POR<br>DEFAULT | DESCRIPTION                         |                                     |  |
|-----|------------|----------------|-------------------------------------|-------------------------------------|--|
| 7:3 | NA         | 0              | Reserved                            |                                     |  |
|     |            |                | Selects the SYSREF output from SYSF | REF_MUX or CLKin0 direct            |  |
| 0   | SYSREF_    | 0              | Field Value                         | SYSREF Source                       |  |
| 2   | CLKin0_MUX | 0              | 0                                   | SYSREF Mux                          |  |
|     |            |                | 1                                   | CLKin0 Direct (from CLKin0_OUT_MUX) |  |
|     |            |                | Selects the SYSREF source.          |                                     |  |
|     | SYSREF_MUX | SYSREF_MUX 0   | Field Value                         | SYSREF Source                       |  |
| 4.0 |            |                | 0 (0x00)                            | Normal SYNC                         |  |
| 1:0 |            |                | 1 (0x01)                            | Re-clocked                          |  |
|     |            |                | 2 (0x02)                            | SYSREF Pulser                       |  |
|     |            |                | 3 (0x03)                            | SYSREF Continuous                   |  |



## 9.7.3.3 SYSREF\_DIV[12:8], SYSREF\_DIV[7:0]

These registers set the value of the SYSREF output divider.

Table 25. Registers 0x13A, 0x13B

| MSB        | LSB        |
|------------|------------|
| 0x13A[4:0] | 0x13B[7:0] |

| BIT | REGISTERS | NAME                  | POR<br>DEFAULT | DESCRIPTION                          |              |  |
|-----|-----------|-----------------------|----------------|--------------------------------------|--------------|--|
| 7:5 | 0x13A     | NA                    | 0              | Reserved                             | Reserved     |  |
|     | 4:0 0x13A |                       |                | Divide value for the SYSREF outputs. |              |  |
| 4.0 |           | SYSREF_DIV[12:8]      | 12             | Field Value                          | Divide Value |  |
| 4.0 |           |                       |                | 0x00 to 0x07                         | Reserved     |  |
|     |           |                       |                | 8 (0x08)                             | 8            |  |
|     |           | 0x13B SYSREF_DIV[7:0] | 0              | 9 (0x09)                             | 9            |  |
| 7.0 | 0.405     |                       |                |                                      |              |  |
| 7:0 | UXISB     |                       |                | 8190 (0x1FFE)                        | 8190         |  |
|     |           |                       |                | 8191 (0X1FFF)                        | 8191         |  |

## 9.7.3.4 SYSREF\_DDLY[12:8], SYSREF\_DDLY[7:0]

These registers set the delay of the SYSREF digital delay value.

Table 26. SYSREF Digital Delay Register Configuration, SYSREF\_DDLY[12:0]

| MSB        | LSB        |
|------------|------------|
| 0x13C[4:0] | 0x13D[7:0] |

| BIT | REGISTERS | NAME                   | POR<br>DEFAULT | DESCRIPTION                             |             |
|-----|-----------|------------------------|----------------|---|-------------|
| 7:5 | 0x13C     | NA                     | 0              | Reserved                                |             |
|     | 4:0 0x13C |                        |                | Sets the value of the SYSREF digital de | lay.        |
| 4.0 |           | SYSREF_DDLY[12:8]      | 0              | Field Value                             | Delay Value |
| 4.0 |           |                        |                | 0x00 to 0x07                            | Reserved    |
|     |           |                        |                | 8 (0x08)                                | 8           |
|     |           | 0x13D SYSREF_DDLY[7:0] | 8              | 9 (0x09)                                | 9           |
| 7.0 | 0.420     |                        |                |   |             |
| 7:0 | 0X13D     |                        |                | 8190 (0x1FFE)                           | 8190        |
|     |           |                        |                | 8191 (0X1FFF)                           | 8191        |



## 9.7.3.5 SYSREF\_PULSE\_CNT

This register sets the number of SYSREF pulses if SYSREF is not in continuous mode. See SYSREF\_CLKin0\_MUX, SYSREF\_MUX for further description of SYSREF's outputs.

Programming the register causes the specified number of pulses to be output if "SYSREF Pulses" is selected by SYSREF\_MUX and SYSREF functionality is powered up.

Table 27. Register 0x13E

| BIT | NAME             | POR<br>DEFAULT | DESCRIPTION   |  |
|-----|------------------|----------------|---|--|
| 7:2 | NA               | 0              | Reserved  |  |
|     |                  | 3              | Sets the number of SYSREF pulses generate See SYSREF_CLKin0_MUX, SYSREF_MUX | ed when not in continuous mode.  for more information on SYSREF modes. |
|     |                  |                | Field Value   | Number of Pulses   |
| 1:0 | SYSREF_PULSE_CNT |                | 0 (0x00)  | 1 pulse  |
|     |                  |                | 1 (0x01)  | 2 pulses   |
|     |                  |                | 2 (0x02)  | 4 pulses   |
|     |                  |                | 3 (0x03)  | 8 pulses   |

## 9.7.3.6 PLL2\_NCLK\_MUX, PLL1\_NCLK\_MUX, FB\_MUX, FB\_MUX\_EN

This register controls the feedback feature.

Table 28. Register 0x13F

| BIT | NAME          | POR<br>DEFAULT | DESCRIPTION   |   |  |
|-----|---------------|----------------|---|---|--|
| 7:5 | NA            | 0              | Reserved  |   |  |
| 4   | PLL2_NCLK_MUX | 0              | Selects the input to the PLL2 N Divider ): PLL Prescaler I: Feedback Mux                      |   |  |
| 3   | PLL1_NCLK_MUX | 0              | Selects the input to the PLL1 N Delay. 0: OSCin 1: Feedback Mux                               |   |  |
|     |               |                | When in 0-delay mode, the feedback mux sele PLL1 N Divider.                                   | ects the clock output to be fed back into the |  |
|     |               |                | Field Value   | Source  |  |
| 2:1 | FB_MUX        | FB_MUX 0       | 0 (0x00)  | DCLKout6                                      |  |
|     |               |                | 1 (0x01)  | DCLKout8                                      |  |
|     |               |                | 2 (0x02)  | SYSREF Divider                                |  |
|     |               |                | 3 (0x03)  | External                                      |  |
| 0   | FB_MUX_EN     | 0              | When using 0-delay, FB_MUX_EN must be se 0: Feedback mux powered down 1: Feedback mux enabled | et to 1 power up the feedback mux.            |  |



## 9.7.3.7 PLL1\_PD, VCO\_LDO\_PD, VCO\_PD, OSCin\_PD, SYSREF\_GBL\_PD, SYSREF\_PD, SYSREF\_DDLY\_PD, SYSREF\_PLSR\_PD

This register contains powerdown controls for OSCin and SYSREF functions.

Table 29. Register 0x140

| віт | NAME           | POR<br>DEFAULT | DESCRIPTION   |
|-----|----------------|----------------|---|
| 7   | PLL1_PD        | 0              | Powerdown PLL1 0: Normal operation 1: Powerdown   |
| 6   | VCO_LDO_PD     | 0              | Powerdown VCO_LDO 0: Normal operation 1: Powerdown  |
| 5   | VCO_PD         | 0              | Powerdown VCO 0: Normal operation 1: Powerdown  |
| 4   | OSCin_PD       | 0              | Powerdown the OSCin port. 0: Normal operation 1: Powerdown  |
| 3   | SYSREF_GBL_PD  | 0              | Powerdown individual SYSREF outputs depending on the setting of SDCLKoutY_DIS_MODE for each SYSREF output. SYSREF_GBL_PD allows many SYSREF outputs to be controlled through a single bit.  0: Normal operation  1: Activate Powerdown Mode |
| 2   | SYSREF_PD      | 1              | Powerdown the SYSREF circuitry and divider. If powered down, SYSREF output mode cannot be used. SYNC cannot be provided either.  0: SYSREF can be used as programmed by individual SYSREF output registers.  1: Powerdown                   |
| 1   | SYSREF_DDLY_PD | 1              | Powerdown the SYSREF digital delay circuitry. 0: Normal operation, SYSREF digital delay may be used. Must be powered up during SYNC for deterministic phase relationship with other clocks. 1: Powerdown                                    |
| 0   | SYSREF_PLSR_PD | 1              | Powerdown the SYSREF pulse generator. 0: Normal operation 1: Powerdown  |

## 9.7.3.8 DDLYdSYSREF\_EN, DDLYdX\_EN

This register enables dynamic digital delay for enabled device clocks and SYSREF when DDLYd\_STEP\_CNT is programmed.

Table 30. Register 0x141

| BIT | NAME             | POR DEFAULT | DESCRIPTION                                     |             |
|-----|------------------|-------------|---|-------------|
| 7   | DDLYd _SYSREF_EN | 0           | Enables dynamic digital delay on SYSREF outputs |             |
| 6   | DDLYd12_EN       | 0           | Enables dynamic digital delay on DCLKout12      |             |
| 5   | DDLYd10_EN       | 0           | Enables dynamic digital delay on DCLKout10      |             |
| 4   | DDLYd8_EN        | 0           | Enables dynamic digital delay on DCLKout8       | 0: Disabled |
| 3   | DDLYd6_EN        | 0           | Enables dynamic digital delay on DCLKout6       | 1: Enabled  |
| 2   | DDLYd4_EN        | 0           | Enables dynamic digital delay on DCLKout4       |             |
| 1   | DDLYd2_EN        | 0           | Enables dynamic digital delay on DCLKout2       |             |
| 0   | DDLYd0_EN        | 0           | Enables dynamic digital delay on DCLKout0       |             |



## 9.7.3.9 DDLYd\_STEP\_CNT

This register sets the number of dynamic digital delay adjustments occur. Upon programming, the dynamic digital delay adjustment begins for each clock output with dynamic digital delay enabled. Dynamic digital delay can only be started by SPI.

Other registers must be set: SYNC\_MODE = 3

Table 31. Register 0x142

| BIT | NAME           | POR<br>DEFAULT | DESCR   | RIPTION  |
|-----|----------------|----------------|---|--|
| 7:4 | NA             | 0              | Reserved  |  |
|     |                |                | Sets the number of dynamic digital delay adju                                   | stments that will occur.                             |
|     |                |                | Field Value   | SYNC Generation                                      |
|     |                |                | Reserved  Sets the number of dynamic digital delay adjustments that will occur. |  |
|     |                |                | 1 (0x01)  | SYNC Generation  No Adjust  1 step  2 steps  3 steps |
| 3:0 | DDLYd_STEP_CNT | 0              | 2 (0x02)  |  |
|     |                |                | 3 (0x03)  | 3 steps  |
|     |                |                |   |  |
|     |                |                | 14 (0x0E)   | 14 steps   |
|     |                |                | 15 (0x0F)   | 15 steps   |



# $9.7.3.10 \quad {\tt SYSREF\_CLR, SYNC\_1SHOT\_EN, SYNC\_POL, SYNC\_EN, SYNC\_PLL2\_DLD, SYNC\_PLL1\_DLD, SYNC\_MODE}$

This register sets general SYNC parameters such as polarization, and mode. Refer to Figure 13 for block diagram. Refer to Table 1 for using SYNC\_MODE for specific SYNC use cases.

Table 32. Register 0x143

| BIT | NAME          | POR<br>DEFAULT | _  | DESCRIPTION  |  |
|-----|---------------|----------------|--|--|--|
| 7   | SYSREF_CLR    | 1              |  | setup Procedure (see SYNC/SYSREF), this bit should always be his bit is set, extra current is used. Refer to Table 84.   |  |
| 6   | SYNC_1SHOT_EN | 0              | 1: SYNC is edge sensitive                              | edge sensitive SYNC. e and outputs will be held in SYNC as long as SYNC is asserted. e, outputs will be SYNCed on rising edge of SYNC. This results in /NC for a minimum amount of time. |  |
| 5   | SYNC_POL      | 0              | Sets the polarity of the SY 0: Normal 1: Inverted      | YNC pin.   |  |
| 4   | SYNC_EN       | 1              | Enables the SYNC functionality. 0: Disabled 1: Enabled |  |  |
| 3   | SYNC_PLL2_DLD | 0              | 0: Off<br>1: Assert SYNC until PLL2 DLD = 1            |  |  |
| 2   | SYNC_PLL1_DLD | 0              | 0: Off<br>1: Assert SYNC until PLL                     | 1 DLD = 1  |  |
|     |               |                | Sets the method of gener                               | ating a SYNC event.  |  |
|     |               | SYNC_MODE 1    | Field Value  | SYNC Generation  |  |
|     |               |                | 0 (0x00)   | Prevent SYNC Pin, SYNC_PLL1_DLD flag, or SYNC_PLL2_DLD flag from generating a SYNC event.  |  |
| 1:0 | SYNC_MODE     |                | 1 (0x01)   | SYNC event generated from SYNC pin or if enabled the SYNC_PLL1_DLD flag or SYNC_PLL2_DLD flag.   |  |
|     |               |                | 2 (0x02)   | For use with pulser - SYNC/SYSREF pulses are generated by pulser block via SYNC Pin or if enabled SYNC_PLL1_DLD flag or SYNC_PLL2_DLD flag.  |  |
|     |               |                | 3 (0x03)   | For use with pulser - SYNC/SYSREF pulses are generated by pulser block when programming register 0x13E (SYSREF_PULSE_CNT) is written to (see ).  |  |



#### 9.7.3.11 SYNC\_DISSYSREF, SYNC\_DISX

SYNC\_DISX will prevent a clock output from being synchronized or interrupted by a SYNC event or when outputting SYSREF.

Table 33. Register 0x144

| BIT | NAME           | POR<br>DEFAULT | DESCRIPTION  |
|-----|----------------|----------------|--|
| 7   | SYNC_DISSYSREF | 0              | Prevent the SYSREF clocks from becoming synchronized during a SYNC event. If SYNC_DISSYSREF is enabled it will continue to operate normally during a SYNC event. |
| 6   | SYNC_DIS12     | 0              |  |
| 5   | SYNC_DIS10     | 0              |  |
| 4   | SYNC_DIS8      | 0              | Prevent the device clock output from becoming synchronized during a SYNC event or  |
| 3   | SYNC_DIS6      | 0              | SYSREF clock. If SYNC_DIS bit for a particular output is enabled then it will continue to  |
| 2   | SYNC_DIS4      | 0              | operate normally during a SYNC event or SYSREF clock.  |
| 1   | SYNC_DIS2      | 0              |  |
| 0   | SYNC_DIS0      | 0              |  |

#### 9.7.3.12 Fixed Register

Always program this register to value 127.

#### Table 34. Register 0x145

| BIT | NAME           | POR<br>DEFAULT | DESCRIPTION           |  |
|-----|----------------|----------------|-----------------------|--|
| 7:0 | Fixed Register | 0              | Always program to 127 |  |

Always program this register to value 170.

## Table 35. Register 0x171

| BIT | NAME           | POR<br>DEFAULT | DESCRIPTION                  |  |
|-----|----------------|----------------|------------------------------|--|
| 7:0 | Fixed Register | 10 (0x0A)      | Always program to 170 (0xAA) |  |

Always program this register to value 2.

#### Table 36. Register 0x172

| BIT | NAME           | POR<br>DEFAULT | DESCRIPTION                |  |
|-----|----------------|----------------|----------------------------|--|
| 7:0 | Fixed Register | 0              | Always program to 2 (0x02) |  |

## 9.7.4 (0x146 - 0x149) CLKin Control

## 9.7.4.1 CLKin2\_EN, CLKin1\_EN, CLKin0\_EN, CLKin2\_TYPE, CLKin1\_TYPE, CLKin0\_TYPE

This register has CLKin enable and type controls.

## Table 37. Register 0x146

| BIT | NAME      | POR<br>DEFAULT | DESCRIPTION   |
|-----|-----------|----------------|---|
| 7:6 | NA        | 0              | Reserved  |
| 5   | CLKin2_EN | 0              | Enable CLKin2 to be used during auto-switching of CLKin_SEL_MODE.  0: Not enabled for auto mode  1: Enabled for auto mode |
| 4   | CLKin1_EN | 1              | Enable CLKin1 to be used during auto-switching of CLKin_SEL_MODE.  0: Not enabled for auto mode  1: Enabled for auto mode |



## Table 37. Register 0x146 (continued)

| BIT | NAME        | POR<br>DEFAULT | DESCRIPTION   |  |
|-----|-------------|----------------|---|--|
| 3   | CLKin0_EN   | 1              | Enable CLKin0 to be used during auto-switching of CLKin_SEL_MODE.  0: Not enabled for auto mode  1: Enabled for auto mode |  |
| 2   | CLKin2_TYPE | 0              |   | There are two buffer types for CLKin0, 1, and 2: bipolar and CMOS.   |
| 1   | CLKin1_TYPE | 0              |   | Bipolar is recommended for differential inputs like LVDS or LVPECL. CMOS is recommended for DC coupled single ended inputs.  |
| 0   | CLKin0_TYPE | 0              | 0: Bipolar<br>1: MOS  | When using bipolar, CLKinX and CLKinX* must be AC coupled. When using CMOS, CLKinX and CLKinX* may be AC or DC coupled if the input signal is differential. If the input signal is single-ended the used input may be either AC or DC coupled and the unused input must AC grounded. |

## 9.7.4.2 CLKin\_SEL\_POL, CLKin\_SEL\_MODE, CLKin1\_OUT\_MUX, CLKin0\_OUT\_MUX

## Table 38. Register 0x147

| ВІТ | NAME              | POR<br>DEFAULT | DESCRIPTION   |  |  |
|-----|-------------------|----------------|---|--|--|
| 7   | CLKin_SEL_POL     | 0              | Inverts the CLKin polarity for use in pin select mode. 0: Active High 1: Active Low |  |  |
|     |                   |                | Sets the mode used in determining the refer   | ence for PLL1.   |  |
|     |                   |                | Field Value   | CLKin Mode   |  |
|     |                   |                | 0 (0x00)  | e CLKin polarity for use in pin select mode. High Low node used in determining the reference for PLL1.  Field Value  0 (0x00)  CLKin0 Manual  1 (0x01)  CLKin1 Manual  2 (0x02)  CLKin2 Manual  3 (0x03)  Pin Select Mode  4 (0x04)  Auto Mode  5 (0x05)  Reserved  6 (0x06)  7 (0x07)  Reserved  here the output of the CLKin1 buffer is directed.  Field Value  CLKin1 Destination  0 (0x00)  Fin  1 (0x01)  Feedback Mux (0-delay mode)  2 (0x02)  PLL1  3 (0x03)  Off here the output of the CLKin0 buffer is directed.  Field Value  CLKin0 Destination  0 (0x00)  SYSREF Mux  1 (0x01)  Reserved |  |
|     |                   |                | 1 (0x01)  |  |  |
| 6:4 | CLKin_SEL_MODE    | 3              | 2 (0x02)  | CLKin2 Manual  |  |
| 0.4 | CLKIII_SEL_IVIODE | 3              | 3 (0x03)  | Pin Select Mode  |  |
|     |                   |                | 4 (0x04)  | Auto Mode  |  |
|     |                   |                | 5 (0x05)  | Reserved   |  |
|     |                   |                | 6 (0x06)  | Reserved   |  |
|     |                   |                | 7 (0x07)  | Reserved   |  |
|     |                   |                | Selects where the output of the CLKin1 buffer is directed.                          |  |  |
|     |                   |                | Field Value   | CLKin1 Destination   |  |
| 3:2 | CLIC's 1 OUT MUV  | 0              | 0 (0x00)  | Fin  |  |
| 3:2 | CLKin1_OUT_MUX    | 2              | 1 (0x01)  | Feedback Mux (0-delay mode)  |  |
|     |                   |                | 2 (0x02)  | PLL1   |  |
|     |                   |                | 3 (0x03)  | Off  |  |
|     |                   |                | Selects where the output of the CLKin0 buffe  | er is directed.  |  |
|     |                   |                | Field Value   | CLKin0 Destination   |  |
| 1.0 | CLISING OUT MUS   | 0              | 0 (0x00)  | SYSREF Mux   |  |
| 1:0 | CLKin0_OUT_MUX    | 2              | 1 (0x01)  | Reserved   |  |
|     |                   |                | 2 (0x02)  | PLL1   |  |
|     |                   |                | 3 (0x03)  | Off  |  |



## 9.7.4.3 CLKin\_SEL0\_MUX, CLKin\_SEL0\_TYPE

This register has CLKin\_SEL0 controls.

Table 39. Register 0x148

| BIT | NAME            | POR<br>DEFAULT                               | DESCRIPTION   |                                      |  |  |
|-----|-----------------|--|---|--------------------------------------|--|--|
| 7:6 | NA              | 0  | Reserved  |                                      |  |  |
|     |                 |  | This set the output value of the CLKin_SEL0 pin. This register only applies if CLKin_SEL0_TYPE is set to an output mode |                                      |  |  |
|     |                 |  | Field Value   | Output For                           | mat                                      |  |
|     |                 |  | 0 (0x00)  | Logic Lo                             | W  |  |
|     |                 |  | 1 (0x01)  | CLKin0 L0                            | OS                                       |  |
| 5:3 | CLKin_SEL0_MUX  | 0  | 2 (0x02)  | CLKin0 Sele                          | ected                                    |  |
|     |                 |  | 3 (0x03)  | DAC Locked                           |  |  |
|     |                 | 4 (0x04)<br>5 (0x05)<br>6 (0x06)<br>7 (0x07) | 4 (0x04)  | DAC Lov                              | V  |  |
|     |                 |  | DAC Hig   | h                                    |  |  |
|     |                 |  | 6 (0x06)  | SPI Readback                         |  |  |
|     |                 |  | 7 (0x07)  | Reserve                              | d  |  |
|     |                 |  | This sets the IO type of the C  | s the IO type of the CLKin_SEL0 pin. |  |  |
|     |                 |  | Field Value   | Configuration                        | Function                                 |  |
|     |                 |  | 0 (0x00)  | Input                                | Input mode, see Input                    |  |
|     |                 |  | 1 (0x01)  | Input /w pull-up resistor            | Clock Switching - Pin<br>Select Mode for |  |
| 2:0 | CLKin_SEL0_TYPE | 2  | 2 (0x02)  | Input /w pull-down resistor          | description of input mode.               |  |
|     |                 |  | 3 (0x03)  | Output (push-pull)                   | Output mades, the                        |  |
|     |                 |  | 4 (0x04)  | Output inverted (push-pull)          | Output modes; the CLKin_SEL0_MUX         |  |
|     |                 |  | 5 (0x05)  | Reserved                             | register for description of              |  |
|     |                 |  | 6 (0x06)  | Output (open drain)                  | outputs.                                 |  |



## 9.7.4.4 SDIO\_RDBK\_TYPE, CLKin\_SEL1\_MUX, CLKin\_SEL1\_TYPE

This register has CLKin\_SEL1 controls and register readback SDIO pin type.

## Table 40. Register 0x149

| BIT | NAME            | POR<br>DEFAULT | DESCRIPTION  |   |  |
|-----|-----------------|----------------|--|---|--|
| 7   | NA              | 0              | Reserved   |   |  |
| 6   | SDIO_RDBK_TYPE  | 1              | Sets the SDIO pin to open drain when during SPI readback in 3 wire mode. 0: Output, push-pull 1: Output, open drain. |   |  |
|     |                 |                | This set the output valu<br>CLKin_SEL1_TYPE is   | ue of the CLKin_SEL1 pin. This reset to an output mode. | egister only applies if                              |
|     |                 |                | Field Value  | Outp  | out Format   |
|     |                 |                | 0 (0x00)   | Lo  | ogic Low   |
|     |                 |                | 1 (0x01)   | CLI   | utput Format  Logic Low  CLKin1 LOS  LKin1 Selected  |
| 5:3 | CLKin_SEL1_MUX  | 0              | 2 (0x02)   | CLKii   |  |
|     |                 |                | 3 (0x03)   | DAC Locked  |  |
|     |                 |                | 4 (0x04)   | D   | AC Low   |
|     |                 |                | 5 (0x05)   | D   | AC High  |
|     |                 |                | 6 (0x06)   | SPI   | Readback   |
|     |                 |                | 7 (0x07)   | R   | eserved  |
|     |                 |                | This sets the IO type of the CLKin_SEL1 pin.   |   |  |
|     |                 |                | Field Value  | Configuration   | Function   |
|     |                 |                | 0 (0x00)   | Input   | Input mode, see Input Clock                          |
|     |                 |                | 1 (0x01)   | Input /w pull-up resistor                               | Switching - Pin Select Mode for                      |
| 2:0 | CLKin_SEL1_TYPE | 2              | 2 (0x02)   | Input /w pull-down resistor                             | description of input mode.                           |
|     |                 |                | 3 (0x03)   | Output (push-pull)                                      |  |
|     |                 |                | 4 (0x04)   | Output inverted (push-pull)                             | Output modes; see the<br>CLKin_SEL1_MUX register for |
|     |                 |                | 5 (0x05)   | Reserved  | description of outputs.                              |
|     |                 |                | 6 (0x06)   | Output (open drain)                                     |  |



## 9.7.5 RESET\_MUX, RESET\_TYPE

This register contains control of the RESET pin.

Table 41. Register 0x14A

| ВІТ | NAME       | POR<br>DEFAUL<br>T | DESCRIPTION  |                             |   |  |
|-----|------------|--------------------|--|-----------------------------|---|--|
| 7:6 | NA         | 0                  | Reserved   |                             |   |  |
|     |            |                    | This sets the output value of the RESET pin. This register only applies if RESET_TYPE is set to a output mode. |                             |   |  |
|     |            |                    | Field Value  | Outpu                       | put Format  pgic Low eserved  p2 Selected C Locked  AC Low  AC High   |  |
|     |            |                    | 0 (0x00)   | Log                         |   |  |
| - 0 | DECET MUN  |                    | 1 (0x01)   | Res                         |   |  |
| 5:3 | RESET_MUX  | 0                  | 2 (0x02)   | CLKin2                      |   |  |
|     |            |                    | 3 (0x03)   | DAC                         |   |  |
|     |            |                    | 4 (0x04)   | DAG                         |   |  |
|     |            |                    | 5 (0x05)   | DAG                         |   |  |
|     |            |                    | 6 (0x06)   | 6 (0x06) SPI Readback       |   |  |
|     |            |                    | This sets the IO type of the RESET pin.  |                             |   |  |
|     |            |                    | Field Value  | Configuration               | served 2 Selected 3 Locked C Low C High Readback  Function  Reset Mode Reset pin high = Reset  Output modes; see the RESET_MUX register for |  |
|     |            |                    | 0 (0x00)   | Input                       |   |  |
|     |            |                    | 1 (0x01)   | Input /w pull-up resistor   |   |  |
| 2:0 | RESET_TYPE | 2                  | 2 (0x02)   | Input /w pull-down resistor | rtocot piir riigir – rtocot   |  |
|     |            |                    | 3 (0x03)   | Output (push-pull)          |   |  |
|     |            |                    | 4 (0x04)   | Output inverted (push-pull) |   |  |
|     |            |                    | 5 (0x05)   | Reserved                    | description of outputs.   |  |
|     |            |                    | 6 (0x06)   | Output (open drain)         |   |  |



#### 9.7.6 (0x14B - 0x152) Holdover

# 9.7.6.1 LOS\_TIMEOUT, LOS\_EN, TRACK\_EN, HOLDOVER\_FORCE, MAN\_DAC\_EN, MAN\_DAC[9:8]

This register contains the holdover functions.

Table 42. Register 0x14B

| BIT | NAME               | POR<br>DEFAULT | DESCRIPTION  |   |  |  |
|-----|--------------------|----------------|--|---|--|--|
|     |                    |                | This controls the amount of time in which no ac event.   | This controls the amount of time in which no activity on a CLKin forces a clock switch event. |  |  |
|     |                    |                | Field Value  | Timeout   |  |  |
| 7:6 | LOS_TIMEOUT        | 0              | 0 (0x00)   | 370 kHz   |  |  |
|     |                    |                | 1 (0x01)   | 2.1 MHz   |  |  |
|     |                    |                | 2 (0x02)   | 8.8 MHz   |  |  |
|     |                    |                | 3 (0x03)   | 22 MHz  |  |  |
| 5   | LOS_EN             | 0              | Enables the LOS (Loss-of-Signal) timeout control. Valid for MOS clock inputs. 0: Disabled 1: Enabled   |   |  |  |
| 4   | TRACK_EN           | 1              | Enable the DAC to track the PLL1 tuning voltage, optionally for use in holdover mode. After device reset, tracking starts at DAC code = 512.  Tracking can be used to monitor PLL1 voltage in any mode.  0: Disabled  1: Enabled, will only track when PLL1 is locked. |   |  |  |
| 3   | HOLDOVER<br>_FORCE | 0              | This bit forces holdover mode. When holdover mode is forced, if MAN_DAC_EN = 1, then the DAC will set the programmed MAN_DAC value. Otherwise the tracked DAC value will set the DAC voltage.  0: Disabled 1: Enabled.   |   |  |  |
| 2   | MAN_DAC_EN         | 1              | This bit enables the manual DAC mode. 0: Automatic 1: Manual   |   |  |  |
| 1:0 | MAN_DAC[9:8]       | 2              | See MAN_DAC[9:8], MAN_DAC[7:0] for more  | information on the MAN_DAC settings.  |  |  |



#### 9.7.6.2 MAN\_DAC[9:8], MAN\_DAC[7:0]

These registers set the value of the DAC in holdover mode when used manually.

# Table 43. MAN\_DAC[9:0]

| MSB        | LSB        |  |
|------------|------------|--|
| 0x14B[1:0] | 0x14C[7:0] |  |

| віт | REGISTERS | NAME               | POR<br>DEFAULT | DESCRIPTION  |                     |
|-----|-----------|--------------------|----------------|--|---------------------|
| 7:2 | 0x14B     |                    |                | See LOS_TIMEOUT, LOS_EN, TRACK_EN, HOLDOVER_FORCE, MAN_DAC_EN, MAN_DAC[9:8] for information on these bits. |                     |
|     | 1:0 0x14B |                    |                | Sets the value of the manual DAC when  | in manual DAC mode. |
| 4.0 |           | MAN_DAC[9:8]       | 2              | Field Value  | DAC Value           |
| 1:0 |           |                    |                | 0 (0x00)   | 0                   |
|     |           |                    |                | 1 (0x01)   | 1                   |
|     |           | 0x14C MAN_DAC[7:0] | 0              | 2 (0x02)   | 2                   |
| 7.0 | 0x14C     |                    |                |  |                     |
| 7:0 |           |                    |                | 1022 (0x3FE)   | 1022                |
|     |           |                    |                | 1023 (0x3FF)   | 1023                |

#### 9.7.6.3 DAC\_TRIP\_LOW

This register contains the high value at which holdover mode is entered.

Table 44. Register 0x14D

| BIT | NAME         | POR<br>DEFAULT | DESCRIPTION                                 |                                      |
|-----|--------------|----------------|---|--------------------------------------|
| 7:6 | NA           | 0              | Reserved                                    |                                      |
|     |              |                | Voltage from GND at which holdover is enter | ed if HOLDOVER_VTUNE_DET is enabled. |
|     |              | 0              | Field Value                                 | DAC Trip Value                       |
|     | DAC_TRIP_LOW |                | 0 (0x00)                                    | 1 x Vcc / 64                         |
|     |              |                | 1 (0x01)                                    | 2 x Vcc / 64                         |
| 5:0 |              |                | 2 (0x02)                                    | 3 x Vcc / 64                         |
| 5.0 |              |                | 3 (0x03)                                    | 4 x Vcc / 64                         |
|     |              |                |   |                                      |
|     |              |                | 61 (0x17)                                   | 62 x Vcc / 64                        |
|     |              |                | 62 (0x18)                                   | 63 x Vcc / 64                        |
|     |              |                | 63 (0x19)                                   | 64 x Vcc / 64                        |



# 9.7.6.4 DAC\_CLK\_MULT, DAC\_TRIP\_HIGH

This register contains the multiplier for the DAC clock counter and the low value at which holdover mode is entered.

Table 45. Register 0x14E

| BIT | NAME          | POR<br>DEFAULT | DESCRIPTION   |   |  |
|-----|---------------|----------------|---|---|--|
|     |               |                | This is the multiplier for the DAC_CLK_CNTR tracked.                            | which sets the rate at which the DAC value is |  |
|     |               |                | Field Value   | DAC Multiplier Value                          |  |
| 7:6 | DAC_CLK_MULT  | 0              | 0 (0x00)  | 4   |  |
|     |               |                | 1 (0x01)  | 64  |  |
|     |               |                | 2 (0x02)  | 1024  |  |
|     |               |                | 3 (0x03)  | 16384   |  |
|     | DAC_TRIP_HIGH | 0              | Voltage from Vcc at which holdover is entered if HOLDOVER_VTUNE_DET is enabled. |   |  |
|     |               |                | Field Value   | DAC Trip Value                                |  |
|     |               |                | 0 (0x00)  | 1 x Vcc / 64                                  |  |
|     |               |                | 1 (0x01)  | 2 x Vcc / 64                                  |  |
| 5:0 |               |                | 2 (0x02)  | 3 x Vcc / 64                                  |  |
| 5.0 |               |                | 3 (0x03)  | 4 x Vcc / 64                                  |  |
|     |               |                |   |   |  |
|     |               |                | 61 (0x17)   | 62 x Vcc / 64                                 |  |
|     |               |                | 62 (0x18)   | 63 x Vcc / 64                                 |  |
|     |               |                | 63 (0x19)   | 64 x Vcc / 64                                 |  |

#### 9.7.6.5 DAC\_CLK\_CNTR

This register contains the value of the DAC when in tracked mode.

Table 46. Register 0x14F

| BIT | NAME         | POR<br>DEFAULT | DESCRIPTION  |           |
|-----|--------------|----------------|--|-----------|
|     |              |                | This with DAC_CLK_MULT set the rate at which the DAC is updated. The update rate is = DAC_CLK_MULT * DAC_CLK_CNTR / PLL1 PDF |           |
|     |              |                | Field Value  | DAC Value |
|     | DAC_CLK_CNTR | 127            | 0 (0x00)   | 0         |
|     |              |                | 1 (0x01)   | 1         |
| 7:0 |              |                | 2 (0x02)   | 2         |
|     |              |                | 3 (0x03)   | 3         |
|     |              |                |  |           |
|     |              |                | 253 (0xFD)   | 253       |
|     |              |                | 254 (0xFE)   | 254       |
|     |              |                | 255 (0xFF)   | 255       |



# $9.7.6.6 \quad CLK in\_OVERRIDE, HOLDOVER\_PLL1\_DET, HOLDOVER\_LOS\_DET, HOLDOVER\_VTUNE\_DET, \\ HOLDOVER\_HITLESS\_SWITCH, HOLDOVER\_EN$

This register has controls for enabling clock in switch events.

#### Table 47. Register 0x150

| BIT         | NAME                            | POR     | DESCRIPTION   |
|-------------|---------------------------------|---------|---|
| <b>D</b> 11 | IVAME                           | DEFAULT | DECOMI HOW  |
| 7           | NA                              | 0       | Reserved  |
| 6           | CLKin<br>_OVERRIDE              | 0       | When CLKin_SEL_MODE = 0/1/2 to select a manual clock input, CLKin_OVERRIDE = 1 will force that clock input. Used with clock distribution mode for best performance.  0: Normal, no override.  1: Force select of only CLKin0/1/2 as specified by CLKin_SEL_MODE in manual mode. |
| 5           | NA                              | 0       | Reserved  |
| 4           | HOLDOVER<br>_PLL1_DET           | 0       | This enables the HOLDOVER when PLL1 lock detect signal transitions from high to low. 0: PLL1 DLD does not cause a clock switch event 1: PLL1 DLD causes a clock switch event  |
| 3           | HOLDOVER<br>_LOS_DET            | 0       | This enables HOLDOVER when PLL1 LOS signal is detected. 0: Disabled 1: Enabled  |
| 2           | HOLDOVER<br>_VTUNE_DET          | 0       | Enables the DAC Vtune rail detections. When the DAC achieves a specified Vtune, if this bit is enabled, the current clock input is considered invalid and an input clock switch event is generated.  0: Disabled  1: Enabled  |
| 1           | HOLDOVER<br>_HITLESS<br>_SWITCH | 1       | Determines whether a clock switch event will enter holdover use hitless switching. 0: Hard Switch 1: Hitless switching (has an undefined switch time)   |
| 0           | HOLDOVER_EN                     | 1       | Sets whether holdover mode is active or not. 0: Disabled 1: Enabled   |

#### 9.7.6.7 HOLDOVER\_DLD\_CNT[13:8], HOLDOVER\_DLD\_CNT[7:0]

# Table 48. HOLDOVER\_DLD\_CNT[13:0]

| MSB        | LSB        |  |
|------------|------------|--|
| 0x151[5:0] | 0x152[7:0] |  |

This register has the number of valid clocks of PLL1 PDF before holdover is exited.

#### Table 49. Registers 0x151 and 0x152

| ВІТ | REGISTERS | NAME                            | POR<br>DEFAULT | DESCR                                  | RIPTION                         |
|-----|-----------|---------------------------------|----------------|--|---------------------------------|
| 7:6 | 0x151     | NA                              | 0              | Reserved                               |                                 |
|     |           |                                 |                | The number of valid clocks of PLL1 PDF | before holdover mode is exited. |
| 5:0 | 0x151     | HOLDOVER<br>_DLD_CNT[13:8]      | 2              | Field Value                            | Count Value                     |
| 5.0 |           |                                 |                | 0 (0x00)                               | 0                               |
|     |           |                                 |                | 1 (0x01)                               | 1                               |
|     | 7:0 0x152 | 0x152 HOLDOVER<br>_DLD_CNT[7:0] | 0              | 2 (0x02)                               | 2                               |
| 7.0 |           |                                 |                |  |                                 |
| 7:0 |           |                                 |                | 16382 (0x3FFE)                         | 16382                           |
|     |           |                                 |                | 16383 (0x3FFF)                         | 16383                           |



# 9.7.7 (0x153 - 0x15F) PLL1 Configuration

#### 9.7.7.1 CLKin0\_R[13:8], CLKin0\_R[7:0]

#### Table 50. CLKin0\_R[13:0]

| MSB        | LSB        |  |
|------------|------------|--|
| 0x153[5:0] | 0x154[7:0] |  |

These registers contain the value of the CLKin0 divider.

| BIT | REGISTERS | NAME                | POR<br>DEFAULT | DESCRIPTION                            |                 |
|-----|-----------|---------------------|----------------|--|-----------------|
| 7:6 | 0x153     | NA                  | 0              | Reserved                               |                 |
|     |           |                     |                | The value of PLL1 N counter when CLKii | n0 is selected. |
| 5:0 | 0x153     | CLKin0_R[13:8]      | 0              | Field Value                            | Divide Value    |
| 5.0 |           |                     |                | 0 (0x00)                               | Reserved        |
|     |           |                     |                | 1 (0x01)                               | 1               |
|     | 0x154     | 0x154 CLKin0_R[7:0] | 120            | 2 (0x02)                               | 2               |
| 7:0 |           |                     |                |  |                 |
| 7.0 |           |                     |                | 16382 (0x3FFE)                         | 16382           |
|     |           |                     |                | 16383 (0x3FFF)                         | 16383           |

#### 9.7.7.2 CLKin1\_R[13:8], CLKin1\_R[7:0]

# Table 51. CLKin1\_R[13:0]

| MSB        | LSB        |  |
|------------|------------|--|
| 0x155[5:0] | 0x156[7:0] |  |

These registers contain the value of the CLKin1 R divider.

#### Table 52. Registers 0x155 and 0x156

| BIT       | REGISTERS | NAME                | POR<br>DEFAULT                          | DESCRIPTION    |              |
|-----------|-----------|---------------------|---|----------------|--------------|
| 7:6       | 0x155     | NA                  | 0                                       | Reserved       |              |
| 5:0 0x155 |           |                     | The value of PLL1 N counter when CLKin1 | is selected.   |              |
|           | 0x155     | CLKin1_R[13:8]      | 0                                       | Field Value    | Divide Value |
| 5.0       |           |                     |   | 0 (0x00)       | Reserved     |
|           |           |                     |   | 1 (0x01)       | 1            |
|           |           | 0x156 CLKin1_R[7:0] | 150                                     | 2 (0x02)       | 2            |
| 7:0       | 0x156     |                     |   |                |              |
| 7.0       |           |                     |   | 16382 (0x3FFE) | 16382        |
|           |           |                     |   | 16383 (0x3FFF) | 16383        |



#### 9.7.7.3 CLKin2\_R[13:8], CLKin2\_R[7:0]

| MSB        | LSB        |
|------------|------------|
| 0x157[5:0] | 0x158[7:0] |

# Table 53. Registers 0x157 and 0x158

| BIT | REGISTERS   | NAME           | POR<br>DEFAULT | DESCRIPTION                           |                  |  |
|-----|-------------|----------------|----------------|---------------------------------------|------------------|--|
| 7:6 | 0x157       | NA             | 0              | Reserved                              |                  |  |
|     |             |                |                | The value of PLL1 N counter when CLKi | in2 is selected. |  |
| 5:0 | 0x157       | CLKin2_R[13:8] | 0              | Field Value                           | Divide Value     |  |
|     |             |                |                | 0 (0x00)                              | Reserved         |  |
|     |             |                |                | 1 (0x01)                              | 1                |  |
|     | 7:0 0x158 C |                | 150            | 2 (0x02)                              | 2                |  |
| 7.0 |             | CLIVing DIZ-01 |                |                                       |                  |  |
| 7:0 |             | CLKin2_R[7:0]  |                | 16382 (0x3FFE)                        | 16382            |  |
|     |             |                |                | 16383 (0x3FFF)                        | 16383            |  |

#### 9.7.7.4 PLL1\_N

# Table 54. PLL1\_N[13:8], PLL1\_N[7:0]

| PLL1_N[13:0] |            |  |  |  |
|--------------|------------|--|--|--|
| MSB LSB      |            |  |  |  |
| 0x159[5:0]   | 0x15A[7:0] |  |  |  |

These registers contain the N divider value for PLL1.

# Table 55. Registers 0x159 and 0x15A

| ВІТ        | REGISTERS | NAME              | POR<br>DEFAULT | DESCRIPTION                  |              |
|------------|-----------|-------------------|----------------|------------------------------|--------------|
| 7:6        | 0x159     | NA                | 0              | Reserved                     |              |
|            |           |                   |                | The value of PLL1 N counter. |              |
| <b>5</b> 0 | 0x159     | PLL1_N[13:8]      | 0              | Field Value                  | Divide Value |
| 5:0        |           |                   |                | 0 (0x00)                     | Not Valid    |
|            |           |                   |                | 1 (0x01)                     | 1            |
|            |           |                   | 120            | 2 (0x02)                     | 2            |
| 7:0        | 0x15A     | 0x15A PLL1_N[7:0] |                |                              |              |
|            |           |                   |                | 4,095 (0xFFF)                | 4,095        |



# 9.7.7.5 PLL1\_WND\_SIZE, PLL1\_CP\_TRI, PLL1\_CP\_POL, PLL1\_CP\_GAIN

This register controls the PLL1 phase detector.

Table 56. Register 0x15B

| BIT | NAME          | POR<br>DEFAULT | DESCRIPTION  |                  |  |
|-----|---------------|----------------|--|------------------|--|
|     |               |                | PLL1_WND_SIZE sets the window size used fo error between the reference and feedback of PLPLL1 lock counter increments.   |                  |  |
|     |               |                | Field Value  | Definition       |  |
| 7:6 | PLL1_WND_SIZE | 3              | 0 (0x00)   | 4 ns             |  |
|     |               |                | 1 (0x01)   | 9 ns             |  |
|     |               |                | 2 (0x02)   | 19 ns            |  |
|     |               |                | 3 (0x03)   | 43 ns            |  |
| 5   | PLL1_CP_TRI   | 0              | This bit allows for the PLL1 charge pump output pin, CPout1, to be placed into TRI-STATE 0: PLL1 CPout1 is active 1: PLL1 CPout1 is at TRI-STATE   |                  |  |
| 4   | PLL1_CP_POL   | 1              | PLL1_CP_POL sets the charge pump polarity for PLL1. Many VCXOs use positive slope. A positive slope VCXO increases output frequency with increasing voltage. A negative slope VCXO decreases output frequency with increasing voltage.  0: Negative Slope VCO/VCXO  1: Positive Slope VCO/VCXO |                  |  |
|     |               |                | This bit programs the PLL1 charge pump output  | t current level. |  |
|     |               |                | Field Value  | Gain             |  |
|     |               |                | 0 (0x00)   | 50 μA            |  |
|     |               |                | 1 (0x01)   | 150 μA           |  |
| 0.0 | DILLA OD OAIN | ,              | 2 (0x02)   | 250 μΑ           |  |
| 3:0 | PLL1_CP_GAIN  | 4              | 3 (0x03)   | 350 μΑ           |  |
|     |               |                | 4 (0x04)   | 450 μA           |  |
|     |               |                |  |                  |  |
|     |               |                | 14 (0x0E)  | 1450 μA          |  |
|     |               |                | 15 (0x0F)  | 1550 μΑ          |  |



# 9.7.7.6 PLL1\_DLD\_CNT[13:8], PLL1\_DLD\_CNT[7:0]

# Table 57. PLL1\_DLD\_CNT[13:0]

| MSB        | LSB        |
|------------|------------|
| 0x15C[5:0] | 0x15D[7:0] |

This register contains the value of the PLL1 DLD counter.

# Table 58. Registers 0x15C and 0x15D

| BIT | REGISTERS | NAME                     | POR DEFAULT | DESCRIF  | PTION                        |
|-----|-----------|--------------------------|-------------|--|------------------------------|
| 7:6 | 0x15C     | NA                       | 0           | Reserved   |                              |
|     |           |                          |             | The reference and feedback of PLL1 m error as specified by PLL1_WND_SIZE cycles before PLL1 digital lock detect is | for this many phase detector |
| 5:0 | 0x15C     | PLL1_DLD<br>_CNT[13:8]   | 32          | Field Value  | Delay Value                  |
|     |           |                          |             | 0 (0x00)   | Reserved                     |
|     |           |                          | 1 (0x01)    | 1  |                              |
|     |           |                          | 0           | 2 (0x02)   | 2                            |
|     |           |                          |             | 3 (0x03)   | 3                            |
| 7:0 | 0x15D     | 0x15D PLL1_DLD _CNT[7:0] |             |  |                              |
|     |           |                          |             | 16,382 (0x3FFE)  | 16,382                       |
|     |           |                          |             | 16,383 (0x3FFF)  | 16,383                       |



# 9.7.7.7 PLL1\_R\_DLY, PLL1\_N\_DLY

This register contains the delay value for PLL1 N and R delays.

Table 59. Register 0x15E

| BIT | NAME       | POR<br>DEFAULT | DESC   | RIPTION |  |
|-----|------------|----------------|--|---------|--|
| 7:6 | NA         | 0              | Reserved   |         |  |
|     |            |                | Increasing delay of PLL1_R_DLY will cause the outputs to lag from CLKinX. For use in ( delay mode. |         |  |
|     |            |                | Field Value  | Gain    |  |
|     |            |                | 0 (0x00)   | 0 ps    |  |
|     |            |                | 1 (0x01)   | 205 ps  |  |
| 5:3 | PLL1_R_DLY | 0              | 2 (0x02)   | 410 ps  |  |
|     |            |                | 3 (0x03)   | 615 ps  |  |
|     |            |                | 4 (0x04)   | 820 ps  |  |
|     |            |                | 5 (0x05)   | 1025 ps |  |
|     |            |                | 6 (0x06)   | 1230 ps |  |
|     |            |                | 7 (0x07)   | 1435 ps |  |
|     |            |                | Increasing delay of PLL1_N_DLY will cause the outputs to lead from CLKinX. For use in delay mode.  |         |  |
|     |            |                | Field Value  | Gain    |  |
|     |            |                | 0 (0x00)   | 0 ps    |  |
|     |            |                | 1 (0x01)   | 205 ps  |  |
| 2:0 | PLL1_N_DLY | 0              | 2 (0x02)   | 410 ps  |  |
|     |            |                | 3 (0x03)   | 615 ps  |  |
|     |            |                | 4 (0x04)   | 820 ps  |  |
|     |            |                | 5 (0x05)   | 1025 ps |  |
|     |            |                | 6 (0x06)   | 1230 ps |  |
|     |            |                | 7 (0x07)   | 1435 ps |  |



#### 9.7.7.8 PLL1\_LD\_MUX, PLL1\_LD\_TYPE

This register configures the PLL1 LD pin.

Table 60. Register 0x15F

| віт | NAME         | POR<br>DEFAULT | DESCRIPTION                                 |                             |  |
|-----|--------------|----------------|---|-----------------------------|--|
|     |              |                | This sets the output value of the Status_LD | 1 pin.                      |  |
|     |              |                | Field Value                                 | MUX Value                   |  |
|     |              |                | 0 (0x00)                                    | Logic Low                   |  |
|     |              |                | 1 (0x01)                                    | PLL1 DLD                    |  |
|     |              |                | 2 (0x02)                                    | PLL2 DLD                    |  |
|     |              |                | 3 (0x03)                                    | PLL1 & PLL2 DLD             |  |
|     |              |                | 4 (0x04)                                    | Holdover Status             |  |
|     |              |                | 5 (0x05)                                    | DAC Locked                  |  |
|     |              |                | 6 (0x06)                                    | Reserved                    |  |
|     |              |                | 7 (0x07)                                    | SPI Readback                |  |
| 7:3 | PLL1_LD_MUX  | 1              | 8 (0x08)                                    | DAC Rail                    |  |
|     |              |                | 9 (0x09)                                    | DAC Low                     |  |
|     |              |                | 10 (0x0A)                                   | DAC High                    |  |
|     |              |                | 11 (0x0B)                                   | PLL1_N                      |  |
|     |              |                | 12 (0x0C)                                   | PLL1_N/2                    |  |
|     |              |                | 13 (0x0D)                                   | PLL2_N                      |  |
|     |              |                | 14 (0x0E)                                   | PLL2_N/2                    |  |
|     |              |                | 15 (0x0F)                                   | PLL1_R                      |  |
|     |              |                | 16 (0x10)                                   | PLL1_R/2                    |  |
|     |              |                | 17 (0x11)                                   | PLL2_R <sup>(1)</sup>       |  |
|     |              |                | 18 (0x12)                                   | PLL2_R/2 <sup>(1)</sup>     |  |
|     |              |                | Sets the IO type of the Status_LD1 pin.     |                             |  |
|     |              |                | Field Value                                 | TYPE                        |  |
|     |              |                | 0 (0x00)                                    | Reserved                    |  |
|     |              |                | 1 (0x01)                                    | Reserved                    |  |
| 2:0 | PLL1_LD_TYPE | 6              | 2 (0x02)                                    | Reserved                    |  |
|     |              |                | 3 (0x03)                                    | Output (push-pull)          |  |
|     |              |                | 4 (0x04)                                    | Output inverted (push-pull) |  |
|     |              |                | 5 (0x05)                                    | Reserved                    |  |
|     |              |                | 6 (0x06)                                    | Output (open drain)         |  |

<sup>(1)</sup> Only valid when PLL2\_LD\_MUX is not set to 2 (PLL2\_DLD) or 3 (PLL1 & PLL2 DLD).



# 9.7.8 (0x160 - 0x16E) PLL2 Configuration

# 9.7.8.1 PLL2\_R[11:8], PLL2\_R[7:0]

#### Table 61. PLL2\_R[11:0]

| MSB        | LSB        |  |
|------------|------------|--|
| 0x160[3:0] | 0x161[7:0] |  |

This register contains the value of the PLL2 R divider.

#### Table 62. Registers 0x160 and 0x161

| BIT | REGISTERS | NAME          | POR DEFAULT | DESCRIF                              | PTION        |
|-----|-----------|---------------|-------------|--------------------------------------|--------------|
| 7:4 | 0x160     | NA            | 0           | Reserved                             |              |
|     |           |               |             | Valid values for the PLL2 R divider. |              |
| 2.0 | 0.400     | DI LO DI44.01 | 0           | Field Value                          | Divide Value |
| 3:0 | 0x160     | PLL2_R[11:8]  | 0           | 0 (0x00)                             | Not Valid    |
|     |           |               |             | 1 (0x01)                             | 1            |
|     |           |               | 2           | 2 (0x02)                             | 2            |
|     |           |               |             | 3 (0x03)                             | 3            |
| 7:0 | 0x161 PL  | PLL2_R[7:0]   |             |                                      |              |
|     |           |               |             | 4,094 (0xFFE)                        | 4,094        |
|     |           |               |             | 4,095 (0xFFF)                        | 4,095        |



# 9.7.8.2 PLL2\_P, OSCin\_FREQ, PLL2\_XTAL\_EN, PLL2\_REF\_2X\_EN

This register sets other PLL2 functions.

Table 63. Register 0x162

| ВІТ | NAME           | POR<br>DEFAULT | DESCR  | RIPTION                                |  |
|-----|----------------|----------------|--|--|--|
|     |                |                | The PLL2 N Prescaler divides the output of the VCO as selected by Mode_MUX1 and is connected to the PLL2 N divider.  |  |  |
|     |                |                | Field Value  | Value                                  |  |
|     |                |                | 0 (0x00)   | 8                                      |  |
|     |                |                | 1 (0x01)   | 2                                      |  |
| 7:5 | PLL2_P         | 2              | 2 (0x02)   | 2                                      |  |
|     |                |                | 3 (0x03)   | 3                                      |  |
|     |                |                | 4 (0x04)   | 4                                      |  |
|     |                |                | 5 (0x05)   | 5                                      |  |
|     |                |                | 6 (0x06)   | 6                                      |  |
|     |                |                | 7 (0x07)   | 7                                      |  |
|     |                | 7              | The frequency of the PLL2 reference input to the PLL2 Phase Detector (OSCin/OSCin* port) must be programmed in order to support proper operation of the frequency calibration routine which locks the internal VCO to the target frequency.      |  |  |
|     |                |                | Field Value  | OSCin Frequency                        |  |
|     | OSCin_FREQ     |                | 0 (0x00)   | 0 to 63 MHz                            |  |
| 4:2 |                |                | 1 (0x01)   | >63 MHz to 127 MHz                     |  |
|     |                |                | 2 (0x02)   | >127 MHz to 255 MHz                    |  |
|     |                |                | 3 (0x03)   | Reserved                               |  |
|     |                |                | 4 (0x04)   | >255 MHz to 500 MHz                    |  |
|     |                |                | 5 (0x05) to 7(0x07)  | Reserved                               |  |
| 1   | PLL2_XTAL_EN   | 0              | If an external crystal is being used to implement a discrete VCXO, the internal feedback amplifier must be enabled with this bit in order to complete the oscillator circuit.  0: Oscillator Amplifier Disabled  1: Oscillator Amplifier Enabled |  |  |
| 0   | PLL2_REF_2X_EN | 1              | Enabling the PLL2 reference frequency double frequencies on PLL2 than would normally be a frequency.  Higher phase detector frequencies reduces the wider loop bandwidth filters possible.  Doubler Disabled Doubler Enabled                     | allowed with the given VCXO or Crystal |  |



#### 9.7.8.3 PLL2 N CAL

#### PLL2\_N\_CAL[17:0]

PLL2 never uses 0-delay during frequency calibration. These registers contain the value of the PLL2 N divider used with PLL2 pre-scaler during calibration for cascaded 0-delay mode. Once calibration is complete, PLL2 will use PLL2\_N value. Cascaded 0-delay mode occurs when PLL2\_NCLK\_MUX = 1.

#### Table 64. Register 0x162

| MSB        | _          | LSB        |
|------------|------------|------------|
| 0x163[1:0] | 0x164[7:0] | 0x165[7:0] |

#### Table 65. Registers 0x163, 0x164, and 0x165

| BIT | REGISTERS                  | NAME                  | POR<br>DEFAULT  | DESCR             | RIPTION      |
|-----|----------------------------|-----------------------|-----------------|-------------------|--------------|
| 7:2 | 0x163                      | NA                    | 0               | Reserved          |              |
| 1.0 | 0v462                      | PLL2_N<br>_CAL[17:16] | 0               | Field Value       | Divide Value |
| 1.0 | 1:0 0x163                  |                       |                 | 0 (0x00)          | Not Valid    |
| 7.0 | 7:0 0x164 PLL2_N_CAL[15:8] | 404 BULO N. OALI45 01 | 110 N CALIATION | 1 (0x01)          | 1            |
| 7:0 |                            | 3] 0                  | 2 (0x02)        | 2                 |              |
| 7.0 | 7:0 0x165 PLL2_            | PLL2_N_CAL[7:0]       | .CAL[7:0] 12    |                   |              |
| 7.0 |                            |                       |                 | 262,143 (0x3FFFF) | 262,143      |

#### 9.7.8.4 PLL2 FCAL DIS, PLL2 N

This register disables frequency calibration and sets the PLL2 N divider value. Programming register 0x168 starts a VCO calibration routine if PLL2\_FCAL\_DIS = 0.

#### Table 66. PLL2\_N[17:0]

| MSB        | _          | LSB        |
|------------|------------|------------|
| 0x166[1:0] | 0x167[7:0] | 0x168[7:0] |

#### Table 67. Registers 0x166, 0x167, and 0x168

| BIT | REGISTERS              | NAME              | POR<br>DEFAULT | DESCRIPTION   |                                       |              |              |                 |               |                 |                    |               |              |               |              |            |             |   |          |   |
|-----|------------------------|-------------------|----------------|---|---------------------------------------|--------------|--------------|-----------------|---------------|-----------------|--------------------|---------------|--------------|---------------|--------------|------------|-------------|---|----------|---|
| 7:3 | 0x166                  | NA                | 0              | Reserved  |                                       |              |              |                 |               |                 |                    |               |              |               |              |            |             |   |          |   |
| 2   | 0x166                  | PLL2_FCAL_DIS     | 0              | This disables the PLL2 frequency calib 0: Frequency calibration enabled 1: Frequency calibration disabled | ration on programming register 0x168. |              |              |                 |               |                 |                    |               |              |               |              |            |             |   |          |   |
| 1.0 | 0v166                  | PLL2_N[17:16]     | PLL2_N[17:16]  | 0   | Field Value                           | Divide Value |              |                 |               |                 |                    |               |              |               |              |            |             |   |          |   |
| 1:0 | 0x166                  |                   |                | 0   | 0 (0x00)                              | Not Valid    |              |                 |               |                 |                    |               |              |               |              |            |             |   |          |   |
| 7:0 | 0x167                  | PLL2_N[15:8] 0    | DI LO N[45.0]  | DI I O N[45.0]  | DLI 0 N[45:0]                         | DLLO NIAE.01 | DILO NIAE-01 | DI I O NI(45.01 | DLI 2 N[45.0] | 67 DLLO N[45,0] | 0v467 DLLQ N[45:0] | DI LO N[45.0] | DLLO NIAC.01 | DI LO NI45.01 | DLLO NIAE-01 | DLLO NIACO | DILO NIAE-O | 0 | 1 (0x01) | 1 |
| 7.0 | 7.0 0X167 PLLZ_N[15.6] |                   | U              | 2 (0x02)  | 2                                     |              |              |                 |               |                 |                    |               |              |               |              |            |             |   |          |   |
| 7:0 | 7:0 0x168 F            | 0x168 PLL2_N[7:0] | _N[7:0] 12     |   |                                       |              |              |                 |               |                 |                    |               |              |               |              |            |             |   |          |   |
| 7.0 |                        |                   |                | 262,143 (0x3FFFF)   | 262,143                               |              |              |                 |               |                 |                    |               |              |               |              |            |             |   |          |   |



# 9.7.8.5 PLL2\_WND\_SIZE, PLL2\_CP\_GAIN, PLL2\_CP\_POL, PLL2\_CP\_TRI

This register controls the PLL2 phase detector.

Table 68. Register 0x169

| ВІТ | NAME          | POR<br>DEFAULT | DESCRIPTION  |   |
|-----|---------------|----------------|--|---|
| 7   | NA            | 0              | Reserved   |   |
|     |               |                | PLL2_WND_SIZE sets the window size used error between the reference and feedback of PLL2 lock counter increments. This value must  | PLL2 is less than specified time, then the                                  |
|     |               |                | Field Value  | Definition  |
| 6:5 | PLL2_WND_SIZE | 2              | 0 (0x00)   | Reserved  |
|     |               |                | 1 (0x01)   | Reserved  |
|     |               |                | 2 (0x02)   | 3.7 ns  |
|     |               |                | 3 (0x03)   | Reserved  |
|     |               |                | This bit programs the PLL2 charge pump outpillustrates the impact of the PLL2 TRISTATE by  |   |
|     |               | 3              | Field Value  | Definition  |
| 4:3 | PLL2_CP_GAIN  |                | 0 (0x00)   | 100 μΑ  |
|     |               |                | 1 (0x01)   | 400 μA  |
|     |               |                | 2 (0x02)   | 1600 μΑ   |
|     |               |                | 3 (0x03)   | 3200 μΑ   |
| 2   | PLL2 CP POL   | 0              | PLL2_CP_POL sets the charge pump polarity negative charge pump polarity to be selected. A positive slope VCO increases output freque VCO decreases output frequency with increas | Many VCOs use positive slope. ncy with increasing voltage. A negative slope |
| 2   | PLLZ_CP_POL   | U              | Field Value  | Description   |
|     |               |                | 0  | Negative Slope VCO/VCXO   |
|     |               |                | 1  | Positive Slope VCO/VCXO   |
| 1   | PLL2_CP_TRI   | 0              | PLL2_CP_TRI TRI-STATEs the output of the PLL2 charge pump. 0: Disabled 1: TRI-STATE  |   |
| 0   | Fixed Value   | 1              | When programming register 0x169, this field r  | must be set to 1.   |



# 9.7.8.6 SYSREF\_REQ\_EN, PLL2\_DLD\_CNT

# Table 69. PLL2\_DLD\_CNT[15:0]

| MSB        | LSB        |
|------------|------------|
| 0x16A[5:0] | 0x16B[7:0] |

This register has the value of the PLL2 DLD counter.

# Table 70. Registers 0x16A and 0x16B

| BIT | REGISTERS | NAME                            | POR<br>DEFAULT | DESCRIPTION  |   |
|-----|-----------|---------------------------------|----------------|--|---|
| 7   | 0x16A     | NA                              | 0              | Reserved   |   |
| 6   | 0x16A     | SYSREF_REQ_EN                   | 0              | Enables the SYNC/SYSREF_REQ pin to continuous pulses. When using this featu SYSREF_MUX = 2 (Pulser). |   |
|     |           | PLL2 DLD                        |                | The reference and feedback of PLL2 mu as specified by PLL2_WND_SIZE for PL lock detect is asserted.  | st be within the window of phase error<br>L2_DLD_CNT cycles before PLL2 digital |
| 5:0 | 0x16A     | CNT[13:8] 32 Field Value Divide | Divide Value   |  |   |
|     |           |                                 | ļ              | 0 (0x00)   | Not Valid   |
|     |           |                                 |                | 1 (0x01)   | 1   |
|     |           |                                 |                | 2 (0x02)   | 2   |
|     |           |                                 |                | 3 (0x03)   | 3   |
| 7:0 | 0x16B     | PLL2_DLD_CNT                    | 0              |  |   |
|     |           |                                 |                | 16,382 (0x3FFE)  | 16,382  |
|     |           |                                 |                | 16,383 (0x3FFF)  | 16,383  |



# 9.7.8.7 PLL2\_LF\_R4, PLL2\_LF\_R3

This register controls the integrated loop filter resistors.

Table 71. Register 0x16C

| ВІТ | NAME       | POR<br>DEFAULT | DESCRIPTION  |   |  |
|-----|------------|----------------|--|---|--|
| 7:6 | NA         | 0              | Reserved   |   |  |
|     |            |                | Internal loop filter components are available filters without requiring external components. Internal loop filter resistor R4 can be set according to the components of the components of the components are available filter.   | •   |  |
|     |            |                | Field Value  | Resistance  |  |
|     |            |                | 0 (0x00)   | 200 Ω   |  |
|     |            |                | 1 (0x01)   | 1 kΩ  |  |
| 5:3 | PLL2_LF_R4 | 0              | 2 (0x02)   | 2 kΩ  |  |
|     |            |                | 3 (0x03)   | 4 kΩ  |  |
|     |            |                | 4 (0x04)   | 16 kΩ   |  |
|     |            |                | 5 (0x05)   | Reserved  |  |
|     |            |                | 6 (0x06)   | ble for PLL2, enabling either 3rd or 4th order loop ints. according to the following table. |  |
|     |            |                | 7 (0x07)   |   |  |
|     |            |                | Internal loop filter components are available filters without requiring external components. Internal loop filter resistor R3 can be set according to the components of the co |   |  |
|     |            |                | Field Value  | Resistance  |  |
|     |            |                | 0 (0x00)   | 200 Ω   |  |
|     |            |                | 1 (0x01)   | 1 kΩ  |  |
| 2:0 | PLL2_LF_R3 | 0              | 2 (0x02)   | 2 kΩ  |  |
|     |            |                | 3 (0x03)   | 4 kΩ  |  |
|     |            |                | 4 (0x04)   | 16 kΩ   |  |
|     |            |                | 5 (0x05)   | Reserved  |  |
|     |            |                | 6 (0x06)   | Reserved  |  |
|     |            |                | 7 (0x07)   | Reserved  |  |



# 9.7.8.8 PLL2\_LF\_C4, PLL2\_LF\_C3

This register controls the integrated loop filter capacitors.

Table 72. Register 0x16D

| BIT | NAME       | POR<br>DEFAULT | DESCRIPTION  |   |  |
|-----|------------|----------------|--|---|--|
|     |            |                | Internal loop filter components are available for filters without requiring external components. Internal loop filter capacitor C4 can be set according to the components of t |   |  |
|     |            |                | Field Value  | Resistance                                |  |
|     |            |                | 0 (0x00)   | 10 pF                                     |  |
|     |            |                | 1 (0x01)   | 15 pF                                     |  |
|     |            |                | 2 (0x02)   | 29 pF                                     |  |
|     |            |                | 3 (0x03)   | 34 pF                                     |  |
|     |            |                | 4 (0x04)   | 47 pF                                     |  |
|     |            |                | 5 (0x05)   | 52 pF                                     |  |
| 7:4 | PLL2_LF_C4 | 0              | 6 (0x06)   | 66 pF                                     |  |
|     |            |                | 7 (0x07)   | 71 pF                                     |  |
|     |            |                | 8 (0x08)   | 103 pF                                    |  |
|     |            |                | 9 (0x09)   | 108 pF                                    |  |
|     |            |                | 10 (0x0A)  | 122 pF                                    |  |
|     |            |                | 11 (0x0B)  | 126 pF                                    |  |
|     |            |                | 12 (0x0C)  | 141 pF                                    |  |
|     |            |                | 13 (0x0D)  | 146 pF                                    |  |
|     |            |                | 14 (0x0E)  | Reserved                                  |  |
|     |            |                | 15 (0x0F)  | Reserved                                  |  |
|     |            |                | Internal loop filter components are available for PLL2, enabling either 3rd or 4th order loop filters without requiring external components.  Internal loop filter capacitor C3 can be set according to the following table.   |   |  |
|     |            |                | Field Value  | Resistance                                |  |
|     |            |                | 0 (0x00)   | 10 pF                                     |  |
|     |            |                | 1 (0x01)   | 11 pF                                     |  |
|     |            |                | 2 (0x02)   | 15 pF                                     |  |
|     |            |                | 3 (0x03)   | 16 pF                                     |  |
|     |            |                | 4 (0x04)   | 19 pF                                     |  |
|     |            |                | 5 (0x05)   | 20 pF                                     |  |
|     | PLL2_LF_C3 | 0              | 6 (0x06)   | 24 pF                                     |  |
| 3:0 |            |                | 7 (0x07)   | 25 pF                                     |  |
| 3:0 |            |                | 7 (0,07)   | =0 p.                                     |  |
| 3:0 |            |                | 8 (0x08)   | 29 pF                                     |  |
| 3:0 |            |                |  |   |  |
| 3:0 |            |                | 8 (0x08)   | 29 pF                                     |  |
| 3:0 |            |                | 8 (0x08)<br>9 (0x09)   | 29 pF<br>30 pF                            |  |
| 3:0 |            |                | 8 (0x08)<br>9 (0x09)<br>10 (0x0A)  | 29 pF<br>30 pF<br>33 pF                   |  |
| 3:0 |            |                | 8 (0x08)<br>9 (0x09)<br>10 (0x0A)<br>11 (0x0B)   | 29 pF<br>30 pF<br>33 pF<br>34 pF          |  |
| 3:0 |            |                | 8 (0x08)<br>9 (0x09)<br>10 (0x0A)<br>11 (0x0B)<br>12 (0x0C)  | 29 pF<br>30 pF<br>33 pF<br>34 pF<br>38 pF |  |

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#### 9.7.8.9 PLL2\_LD\_MUX, PLL2\_LD\_TYPE

This register sets the output value of the Status\_LD2 pin.

Table 73. Register 0x16E

| віт | NAME         | POR<br>DEFAULT | DESCRIPTION                                 |                             |  |
|-----|--------------|----------------|---|-----------------------------|--|
|     |              |                | This sets the output value of the Status_LD | 2 pin.                      |  |
|     |              |                | Field Value                                 | MUX Value                   |  |
|     |              |                | 0 (0x00)                                    | Logic Low                   |  |
|     |              |                | 1 (0x01)                                    | PLL1 DLD                    |  |
|     |              |                | 2 (0x02)                                    | PLL2 DLD                    |  |
|     |              |                | 3 (0x03)                                    | PLL1 & PLL2 DLD             |  |
|     |              |                | 4 (0x04)                                    | Holdover Status             |  |
|     |              |                | 5 (0x05)                                    | DAC Locked                  |  |
|     |              |                | 6 (0x06)                                    | Reserved                    |  |
|     |              |                | 7 (0x07)                                    | SPI Readback                |  |
| 7:3 | PLL2_LD_MUX  | 2              | 8 (0x08)                                    | DAC Rail                    |  |
|     |              |                | 9 (0x09)                                    | DAC Low                     |  |
|     |              |                | 10 (0x0A)                                   | DAC High                    |  |
|     |              |                | 11 (0x0B)                                   | PLL1_N                      |  |
|     |              |                | 12 (0x0C)                                   | PLL1_N/2                    |  |
|     |              |                | 13 (0x0D)                                   | PLL2_N                      |  |
|     |              |                | 14 (0x0E)                                   | PLL2_N/2                    |  |
|     |              |                | 15 (0x0F)                                   | PLL1_R                      |  |
|     |              |                | 16 (0x10)                                   | PLL1_R/2                    |  |
|     |              |                | 17 (0x11)                                   | PLL2_R <sup>(1)</sup>       |  |
|     |              |                | 18 (0x12)                                   | PLL2_R/2 <sup>(1)</sup>     |  |
|     |              |                | Sets the IO type of the Status_LD2 pin.     |                             |  |
|     |              |                | Field Value                                 | TYPE                        |  |
|     |              |                | 0 (0x00)                                    | Reserved                    |  |
|     |              |                | 1 (0x01)                                    | Reserved                    |  |
| 2:0 | PLL2_LD_TYPE | 6              | 2 (0x02)                                    | Reserved                    |  |
|     |              |                | 3 (0x03)                                    | Output (push-pull)          |  |
|     |              |                | 4 (0x04)                                    | Output inverted (push-pull) |  |
|     |              |                | 5 (0x05)                                    | Reserved                    |  |
|     |              |                | 6 (0x06)                                    | Output (open drain)         |  |

<sup>(1)</sup> Only valid when PLL1\_LD\_MUX is not set to 2 (PLL2\_DLD) or 3 (PLL1 & PLL2 DLD).



#### 9.7.9 (0x16F - 0x1FFF) Misc Registers

#### 9.7.9.1 PLL2\_PRE\_PD, PLL2\_PD

Table 74. Register 0x173

| BIT | NAME        | DESCRIPTION   |
|-----|-------------|---|
| 7   | N/A         | Reserved  |
| 6   | PLL2_PRE_PD | Powerdown PLL2 prescaler 0: Normal Operation 1: Powerdown |
| 5   | PLL2_PD     | Powerdown PLL2 0: Normal Operation 1: Powerdown           |
| 4:0 | N/A         | Reserved  |

#### 9.7.9.2 VCO1\_DIV

Sets VCO1 VCO divider value. This divider cannot be bypassed and has a minimum value of 2. This register is reserved for LMK04826 and LMK04828 and should be left unprogrammed.

Table 75. Register 0x174

|     | <b>G</b>                    |                |   |              |   |  |
|-----|-----------------------------|----------------|---|--------------|---|--|
| BIT | NAME                        | POR<br>DEFAULT | DESCRIPTION   |              |   |  |
| 7:5 | N/A                         | 0              | Reserved  |              |   |  |
|     | VCO1_DIV<br>(LMK04821 only) | o O            | When VCO_MUX selects VCO1 for LMK04821, the clock distribution frequency will be equal to VCO1 frequency divided by this divide value. Note this divider is also on the PLL2 feedback path and will impact PLL2 N divider value.  Unlisted field values are reserved. |              |   |  |
|     |                             |                | Field Value   | Divide Value |   |  |
|     |                             |                | 0 (0x00)  | 2            |   |  |
| 4:0 |                             |                | 5 (0x05)  | 3            |   |  |
|     |                             |                | 10 (0x0A)   | 8            |   |  |
|     |                             |                | 20 (0x14)   | 4            |   |  |
|     |                             |                | 23 (0x17)   | 5            |   |  |
|     |                             |                | 27 (0x1B)   | 7            |   |  |
|     |                             |                |   | 30 (0x1E)    | 6 |  |

#### 9.7.9.3 OPT\_REG\_1

This register must be written with the following value depending on which LMK0482x family part is used to optimize VCO1 phase noise performance over temperature. This register must be written before writing register 0x168 when using VCO1.

Table 76. Register 0x17C

| BIT | NAME      | DESCRIPTION                                  |
|-----|-----------|--|
| 7:0 | OPT_REG_1 | 21: LMK04821<br>24: LMK04826<br>21: LMK04828 |

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# 9.7.9.4 OPT\_REG\_2

This register must be written with the following value depending on which LMK0482x family part is used to optimize VCO1 phase noise performance over temperature. This register must be written before writing register 0x168 when using VCO1.

#### Table 77. Register 0x17D

| BIT | NAME      | DESCRIPTION                                   |
|-----|-----------|---|
| 7:0 | OPT_REG_2 | 51: LMK04821<br>119: LMK04826<br>51: LMK04828 |

#### 9.7.9.5 RB\_PLL1\_LD\_LOST, RB\_PLL1\_LD, CLR\_PLL1\_LD\_LOST

#### Table 78. Register 0x182

| BIT | NAME             | DESCRIPTION  |  |  |
|-----|------------------|--|--|--|
| 7:3 | N/A              | Reserved   |  |  |
| 2   | RB_PLL1_LD_LOST  | This is set when PLL1 DLD edge falls. Does not set if cleared while PLL1 DLD is low.   |  |  |
| 1   | RB_PLL1_LD       | Read back 0: PLL1 DLD is low. Read back 1: PLL1 DLD is high.   |  |  |
| 0   | CLR_PLL1_LD_LOST | To reset RB_PLL1_LD_LOST, write CLR_PLL1_LD_LOST with 1 and then 0.  0: RB_PLL1_LD_LOST will be set on next falling PLL1 DLD edge.  1: RB_PLL1_LD_LOST is held clear (0). User must clear this bit to allow RB_PLL1_LD_LOST to become set again. |  |  |

#### 9.7.9.6 RB\_PLL2\_LD\_LOST, RB\_PLL2\_LD, CLR\_PLL2\_LD\_LOST

#### Table 79. Register 0x0x183

| BIT | NAME             | DESCRIPTION  |  |
|-----|------------------|--|--|
| 7:3 | N/A              | Reserved   |  |
| 2   | RB_PLL2_LD_LOST  | This is set when PLL2 DLD edge falls. Does not set if cleared while PLL2 DLD is low.   |  |
| 1   | RB_PLL2_LD       | PLL1_LD_MUX or PLL2_LD_MUX must select setting 2 (PLL2 DLD) for valid reading of this bit.  Read back 0: PLL2 DLD is low.  Read back 1: PLL2 DLD is high.  |  |
| 0   | CLR_PLL2_LD_LOST | To reset RB_PLL2_LD_LOST, write CLR_PLL2_LD_LOST with 1 and then 0.  0: RB_PLL2_LD_LOST will be set on next falling PLL2 DLD edge.  1: RB_PLL2_LD_LOST is held clear (0). User must clear this bit to allow RB_PLL2_LD_LOST to become set again. |  |



#### 9.7.9.7 RB\_DAC\_VALUE(MSB), RB\_CLKinX\_SEL, RB\_CLKinX\_LOS

This register provides read back access to CLKinX selection indicator and CLKinX LOS indicator. The 2 MSBs are shared with the RB\_DAC\_VALUE. See RB\_DAC\_VALUE section.

#### Table 80. Register 0x184

| BIT | NAME              | DESCRIPTION   |  |  |
|-----|-------------------|---|--|--|
| 7:6 | RB_DAC_VALUE[9:8] | See RB_DAC_VALUE section.   |  |  |
| 5   | RB_CLKin2_SEL     | Read back 0: CLKin2 is not selected for input to PLL1. Read back 1: CLKin2 is selected for input to PLL1. |  |  |
| 4   | RB_CLKin1_SEL     | Read back 0: CLKin1 is not selected for input to PLL1. Read back 1: CLKin1 is selected for input to PLL1. |  |  |
| 3   | RB_CLKin0_SEL     | Read back 0: CLKin0 is not selected for input to PLL1. Read back 1: CLKin0 is selected for input to PLL1. |  |  |
| 2   | N/A               |   |  |  |
| 1   | RB_CLKin1_LOS     | Read back 1: CLKin1 LOS is active. Read back 0: CLKin1 LOS is not active.                                 |  |  |
| 0   | RB_CLKin0_LOS     | Read back 1: CLKin0 LOS is active. Read back 0: CLKin0 LOS is not active.                                 |  |  |

#### 9.7.9.8 RB\_DAC\_VALUE

Contains the value of the DAC for user readback.

| FIELD NAME   | MSB         | LSB         |  |
|--------------|-------------|-------------|--|
| RB_DAC_VALUE | 0x184 [7:6] | 0x185 [7:0] |  |

#### Table 81. Registers 0x184 and 0x185

| ВІТ | REGISTERS | NAME                  | POR<br>DEFAULT | DESCRIPTION  |
|-----|-----------|-----------------------|----------------|--|
| 7:6 | 0x184     | RB_DAC_<br>VALUE[9:8] | 2              | DAC value is 512 on power on reset, if PLL1 locks upon power-up the DAC value will change. |
| 7:0 | 0x185     | RB_DAC_<br>VALUE[7:0] | 0              |  |

### 9.7.9.9 RB\_HOLDOVER

#### Table 82. Register 0x188

| BIT | NAME        | DESCRIPTION   |
|-----|-------------|---|
| 7:5 | N/A         | Reserved  |
| 4   | RB_HOLDOVER | Read back 0: Not in HOLDOVER. Read back 1: In HOLDOVER. |
| 3:0 | N/A         | Reserved  |



#### 9.7.9.10 SPI\_LOCK

Prevents SPI registers from being written to, except for 0x1FFD, 0x1FFE, 0x1FFF. These registers must be written to sequentially and in order: 0x1FFD, 0x1FFE, 0x1FFF.

These registers cannot be read back.

| MSB          | _            | LSB          |  |
|--------------|--------------|--------------|--|
| 0x1FFD [7:0] | 0x1FFE [7:0] | 0x1FFF [7:0] |  |

# Table 83. Registers 0x1FFD, 0x1FFE, and 0x1FFF

| ВІТ | REGISTERS | NAME            | POR<br>DEFAULT | DESCRIPTION  |
|-----|-----------|-----------------|----------------|--|
| 7:0 | 0x1FFD    | SPI_LOCK[23:16] | 0              | 0: Registers unlocked.<br>1 to 255: Registers locked                               |
| 7:0 | 0x1FFE    | SPI_LOCK[15:8]  | 0              | 0: Registers unlocked.<br>1 to 255: Registers locked                               |
| 7:0 | 0x1FFF    | SPI_LOCK[7:0]   | 83             | 0 to 82: Registers locked<br>83: Registers unlocked<br>84 to 256: Registers locked |



### 10 Applications and Implementation

#### 10.1 Application Information

To assist customers in frequency planning and design of loop filters Texas Instrument's provides the Clock Design Tool (www.ti.com/tool/clockdesigntool) and Clock Architect (www.ti.com/clockarchitect).

#### 10.2 Typical Applications

#### 10.2.1 Digital Lock Detect Frequency Accuracy

The digital lock detect circuit is used to determine PLL1 locked, PLL2 locked, and holdover exit events. A window size and lock count register are programmed to set a ppm frequency accuracy of reference to feedback signals of the PLL for each event to occur. When a PLL digital lock event occurs the PLL's digital lock detect is asserted true. When the holdover exit event occurs, the device will exit holdover mode.

| EVENT         | PLL  | WINDOW SIZE   | LOCK COUNT       |
|---------------|------|---------------|------------------|
| PLL1 Locked   | PLL1 | PLL1_WND_SIZE | PLL1_DLD_CNT     |
| PLL2 Locked   | PLL2 | PLL2_WND_SIZE | PLL2_DLD_CNT     |
| Holdover exit | PLL1 | PLL1_WND_SIZE | HOLDOVER_DLD_CNT |

For a digital lock detect event to occur there must be a "lock count" number of phase detector cycles of PLLX during which the time/phase error of the PLLX\_R reference and PLLX\_N feedback signal edges are within the user programmable "window size." Since there must be at least "lock count" phase detector events before a lock event occurs, a minimum digital lock event time can be calculated as "lock count" / f<sub>PDX</sub> where X = 1 for PLL1 or 2 for PLL2.

By using Equation 3, values for a "lock count" and "window size" can be chosen to set the frequency accuracy required by the system in ppm before the digital lock detect event occurs:

$$ppm = \frac{1e6 \times PLLX\_WND\_SIZE \times f_{PDX}}{PLLX\_DLD\_CNT}$$
(3)

The effect of the "lock count" value is that it shortens the effective lock window size by dividing the "window size" by "lock count".

If at any time the PLLX\_R reference and PLLX\_N feedback signals are outside the time window set by "window size", then the "lock count" value is reset to 0.

#### 10.2.1.1 Minimum Lock Time Calculation Example

To calculate the minimum PLL2 digital lock time given a PLL2 phase detector frequency of 40 MHz and PLL2\_DLD\_CNT = 10,000. Then the minimum lock time of PLL2 will be 10,000 / 40 MHz =  $250 \mu s$ .

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#### 10.2.2 Driving CLKin AND OSCin Inputs

#### 10.2.2.1 Driving CLKin PINS with a Differential Source

Both CLKin ports can be driven by differential signals. It is recommended that the input mode be set to bipolar (CLKinX\_BUF\_TYPE = 0) when using differential reference clocks. The LMK0482x family internally biases the input pins so the differential interface should be AC coupled. The recommended circuits for driving the CLKin pins with either LVDS or LVPECL are shown in Figure 20 and Figure 21.

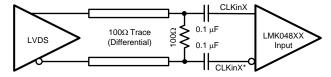


Figure 20. CLKinX/X\* Termination for an LVDS Reference Clock Source

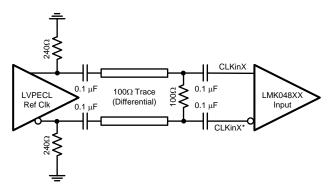


Figure 21. CLKinX/X\* Termination for an LVPECL Reference Clock Source

Finally, a reference clock source that produces a differential sine wave output can drive the CLKin pins using the following circuit. Note: the signal level must conform to the requirements for the CLKin pins listed in *Electrical Characteristics*.

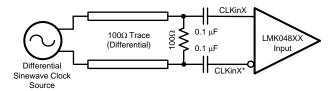


Figure 22. CLKinX/X\* Termination for a Differential Sinewave Reference Clock Source



#### 10.2.2.2 Driving CLKin Pins with a Single-ended Source

The CLKin pins of the LMK0482x family can be driven using a single-ended reference clock source, for example, either a sine wave source or an LVCMOS/LVTTL source. Either AC coupling or DC coupling may be used. In the case of the sine wave source that is expecting a 50  $\Omega$  load, it is recommended that AC coupling be used as shown in the circuit below with a 50- $\Omega$  termination.

#### NOTE

The signal level must conform to the requirements for the CLKin pins listed in *Electrical Characteristics*. CLKinX\_BUF\_TYPE is recommended to be set to bipolar mode (CLKinX\_BUF\_TYPE = 0).

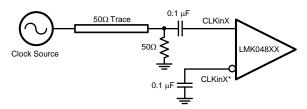


Figure 23. CLKinX/X\* Single-ended Termination

If the CLKin pins are being driven with a single-ended LVCMOS/LVTTL source, either DC coupling or AC coupling may be used. If DC coupling is used, the CLKinX\_BUF\_TYPE should be set to MOS buffer mode (CLKinX\_BUF\_TYPE = 1) and the voltage swing of the source must meet the specifications for DC coupled, MOS-mode clock inputs given in *Electrical Characteristics*. If AC coupling is used, the CLKinX\_BUF\_TYPE should be set to the bipolar buffer mode (CLKinX\_BUF\_TYPE = 0). The voltage swing at the input pins must meet the specifications for AC coupled, bipolar mode clock inputs given in *Electrical Characteristics*. In this case, some attenuation of the clock input level may be required. A simple resistive divider circuit before the AC coupling capacitor is sufficient.

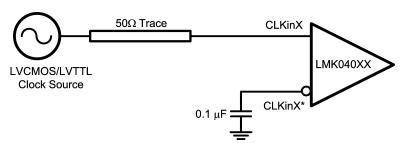


Figure 24. DC Coupled LVCMOS/LVTTL Reference Clock



#### 10.2.3 Design Example

This design example below highlights using the available tools to design loop filters and create programming map for LMK0482x.

#### 10.2.3.1 Design Requirements

Clocks outputs:

- 1x 245.76 MHz clock for JESD204B ADC, LVPECL.
  - This clock requires the best performance in this example.
- 2x 983.04 MHz clock for JESD204B DAC, LVPECL.
- 1x 122.88 MHz clock for JESD204B FPGA block, LVDS
- 3x 10.24 MHz SYSREF for ADC (LVPECL), DAC (LVPECL), FPGA (LVDS).
- 2x 122.88 MHz clock for FPGA, LVDS

For best performance, the highest possible phase detector frequency is used at PLL2. As such a 122.88 MHz VCXO is used.

#### 10.2.3.2 Detailed Design Procedure

Please note this information is current as of the date of the release of this datasheet. Design tools receive continuous improvements to add features and improve model accuracy. Please refer to software instructions or training for latest features.

#### 10.2.3.2.1 Device Selection

Enter the required frequencies into the tools. In this design the LMK04826B VCO0 and LMK04828B VCO1 both meet the design requirements. VCO0 offers lower noise floor while VCO1 offers improved VCO phase noise which reduces RMS jitter. Depending on application requirements and simulations one solution may be chosen over the other. In this case we will choose LMK04828B\_VCO1 for improved RMS jitter in the 12 kHz to 20 MHz integration range. Larger integration ranges may benefit from the lower noise floor of VCO0.

#### 10.2.3.2.1.1 Clock Architect

Only one device of a family will be returned as a possible solution. For the above example, LMK04828B VCO1.

Under advanced tab, filtering of specific parts can be done using regular expressions in the Part Filter box. "LMK0482x.\*" will filter for only LMK0482x devices (without quotes). More detailed filters can be given such as the entire part name LMK04826B\_VCO0 to force an LMK04826B using VCO0 solution if one is available.

#### 10.2.3.2.1.2 Clock Design Tool

In wizard-mode, select Dual Loop PLL to find LMK0482x devices. If a high frequency and clean reference is available, it is not required to use dual loop; PLL1 can be powered down and input is then provided via the OSCin port. When simulating single loop solutions, set PLL1 loop filter block to "0 Hz LBW" and use VCXO as the reference block.



#### 10.2.3.2.2 Device Configuration and Simulation

The tools automatically configure the simulation to meet the input and output frequency requirements given and make assumptions about other parameters to give some default simulations. However the user may chose to make adjustments for more accurate simulations to their application. For example:

- Entering the VCO Gain of the external VCXO or possible external VCO used device.
- Adjust the charge pump current to help with loop filter component selection. Lower charge pump currents
  result in smaller components but may increase impacts of leakage and at the lowest values reduce PLL
  phase nosie performance.
- Clock Design Tool allows loading a custom phase noise plot for any block. Typically, a custom phase noise
  plot is entered for CLKin to match the reference phase noise to device; a phase noise plot for the VCXO can
  additionally be provided to match the performance of VCXO used. For improved accuracy in simulation and
  optimum loop filter design, be sure to load these custom noise profiles for use in application.
- The design tools return with high reference/phase detector frequencies by default. In the Clock Design Tool the user may increase the reference divider to reduce the frequency if desired. Due to the narrow loop bandwidth used on PLL1, it is common to reduce the phase detector frequency on PLL1.

#### 10.2.3.2.3 Device Programming

Using the clock design tools configuration the CodeLoader software is manually updated with this information to meet the required application. Note for the JESD204B outputs place device clocks on the DCLKoutX output, then turn on the paired SDCLKoutY output for SYSREF output. For Non-JESD204B outputs both DCLKoutX and paired SDCLKoutY may be driven by the device clock divider to maximize number of available outputs.

Frequency planning for assignment of outputs:

- To minimize crosstalk perform frequency planning / CLKout assignments to keep common frequencies on outputs close together.
- It is best to place common device clock output frequencies on outputs sharing the same Vcc group. For
  example, these outputs share Vcc4\_CG2. Refer to Pin Configuration and Functions to see the Vcc groupings
  the clock outputs.

In this example, the 245.76 MHz ADC output needs the best performance. DCLKout2 on the LMK0482x provides the best noise floor / performance. The 245.76 MHz will be placed on DCLKout2 with 10.24 MHz SYSREF on SDCLKout3.

 For best performance the input and output drive level bits may be set. Best noise floor performance is achieved with DCLKout2 IDL = 1 and DCLKout2 ODL = 1.

In this example, the 983.04 MHz DAC output is placed on DCLKout4 and DCLKout6 with 10.24 MHz SYSREF on paired SDCLKout5 and SDCLKout7 outputs.

These outputs share Vcc4\_CG2.

In this example, the 122.88 MHz FPGA JESD204B output is placed on DCLKout10 with 10.24 MHz SYSREF on paired SDCLKout11 output.

Additionally, the 122.88 MHz FPGA non-JESD204B outputs are placed on DCLKout8 and SDCLKout9.

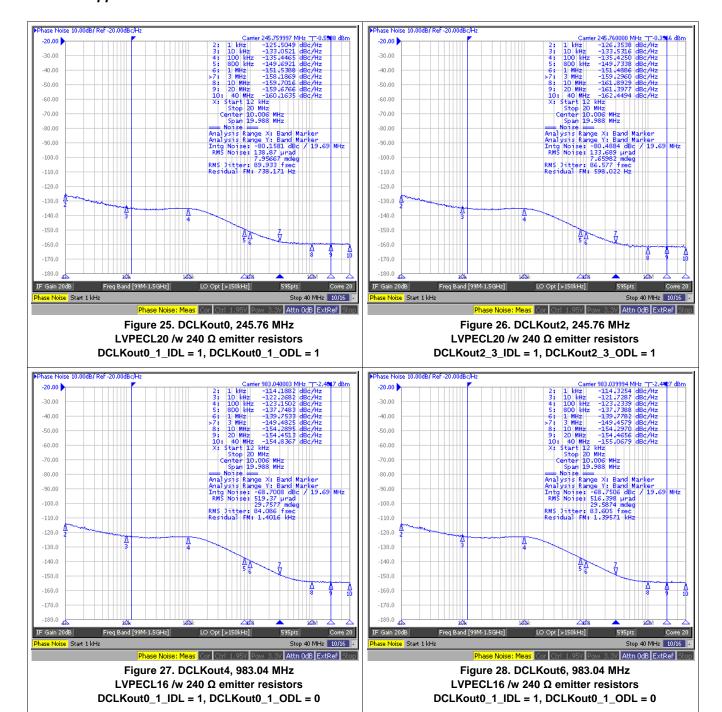
• When frequency planning, consider PLL2 as a clock output at the phase detector frequency. As such, these 122.88 MHz outputs have been placed on the outputs close to the PLL2 & Charge Pump power supplies.

Once the device programming is completed as desired in the CodeLoader software, it is possible to export the register settings from the Register tab for use in application.

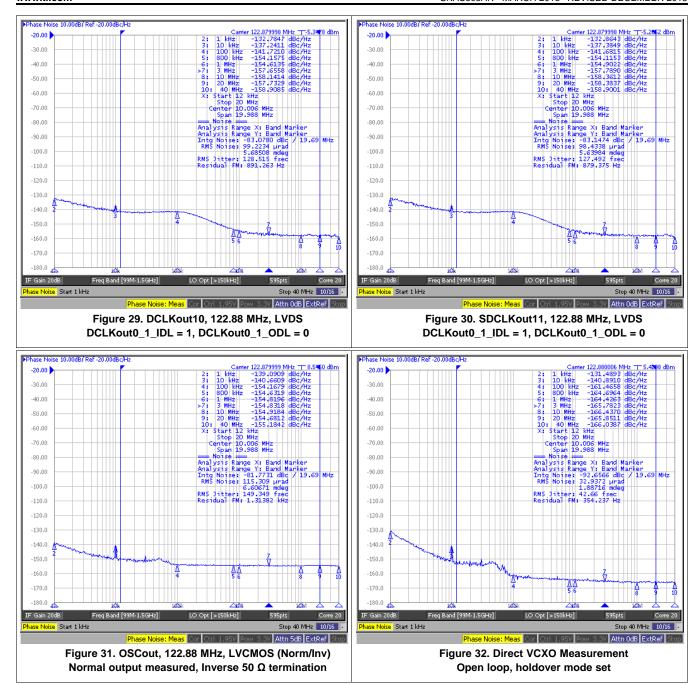
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#### 10.2.3.3 Application Curves







#### 10.3 Do's and Don'ts

#### 10.3.1 Pin Connection Recommendations

- V<sub>CC</sub> Pins and Decoupling: all V<sub>CC</sub> pins must always be connected.
- Unused Clock Outputs: leave unused clock outputs floating and powered down.
- · Unused Clock Inputs: unused clock inputs can be left floating.



# 11 Power Supply Recommendations

# 11.1 Current Consumption / Power Dissipation Calculations

From Table 84 the current consumption can be calculated for any configuration. Data below is typical and not assured.

Table 84. Typical Current Consumption for Selected Functional Blocks ( $T_A = 25$  °C,  $V_{CC} = 3.3$  V)

| вьоск                            | CONE                           | DITION                          | TYPICAL I <sub>CC</sub> (mA) | POWER DISSIPATED in DEVICE (mW) | POWER DISSIPATED EXTERNALLY (mW) |
|----------------------------------|--------------------------------|---------------------------------|------------------------------|---------------------------------|----------------------------------|
| CORE and FUNCTIONAL B            | LOCKS                          |                                 |                              |                                 |                                  |
| Core Dual Loop, Internative VCO0 |                                | PLL1 and PLL2 locked            | 131.5                        | 433.95                          | -                                |
| VCO (with VCO divider for        | VCO1 is selected               | LMK04826B/LMK04828<br>B         |                              | 44.55                           | -                                |
| LMK04821)                        |                                | LMK04821                        | 22                           | 72.6                            | -                                |
| OSCin Doubler                    | Doubler is enabled             | EN_PLL2_REF_2X = 1              | 3                            | 9.9                             | -                                |
| CLKin                            | Any one of the CLKinX is       | enabled                         | 4.9                          | 16.17                           | -                                |
|                                  | Holdover is enabled            | HOLDOVER_EN = 1                 | 1.3                          | 4.29                            | -                                |
| Holdover                         | Hitless switch is enabled      | HOLDOVER_HITLESS_<br>SWITCH = 1 | 0.9                          | 2.97                            | -                                |
|                                  | Track mode                     | TRACK_EN = 1                    | 2.5                          | 8.25                            | -                                |
| SYNC_EN = 1                      | Required for SYNC and S        | SYSREF functionality            | 7.6                          | 25.08                           | -                                |
|                                  | Enabled                        | SYSREF_PD = 0                   | 27.2                         | 89.76                           | -                                |
|                                  | Dynamic Digital Delay enabled  | SYSREF_DDLY_PD = 0              | 5                            | 16.5                            | -                                |
| SYSREF                           | Pulser is enabled              | SYSREF_PLSR_PD = 0              | 4.1                          | 13.53                           |                                  |
|                                  | SYSREF Pulses mode             | SYSREF_MUX = 2                  | 3                            | 9.9                             |                                  |
|                                  | SYSREF Continuous mode         | SYSREF_MUX = 3                  | 3                            | 9.9                             |                                  |
| CLOCK GROUP                      |                                |                                 |                              |                                 |                                  |
| Enabled                          | Any one of the CLKoutX_        | Y_PD = 0                        | 20.1                         | 66.33                           |                                  |
| IDL                              | Any one of the CLKoutX_        | Y_IDL = 1                       | 2.2                          | 7.26                            |                                  |
| ODL                              | Andy one of the CLKoutX        | _Y_ODL = 1                      | 3.2                          | 10.56                           |                                  |
|                                  | Divider Only                   | DCLKoutX_MUX = 0                | 13.6                         | 44.88                           |                                  |
| Clock Divider                    | Divider + DCC + HS             | DCLKoutX_MUX = 1                | 17.7                         | 58.41                           |                                  |
|                                  | Analog Delay + Divider         | DCLKoutX_MUX = 3                | 13.6                         | 44.88                           |                                  |
| <b>CLOCK OUTPUT BUFFERS</b>      |                                | •                               | •                            | •                               | •                                |
| LVDS                             | 100 Ω differential termina     | tion                            | 6                            | 19.8                            | -                                |
|                                  | HSDS 6 mA, 100 Ω differ        | ential termination              | 8.8                          | 29.04                           | -                                |
| HSDS                             | HSDS 8 mA, 100 Ω differ        | ential termination              | 11.6                         | 38.28                           | -                                |
|                                  | HSDS 10 mA, 100 $\Omega$ diffe | rential termination             | 19.4                         | 64.02                           | -                                |
| OSCout BUFFERS                   |                                |                                 |                              |                                 |                                  |
| LVDS                             | 100 Ω differential termina     | tion                            | 18.5                         | 61.05                           | -                                |
| LVCMOS                           | LVCMOS Pair                    | 150 MHz                         | 42.6                         | 140.58                          | -                                |
| LVCIVIOS                         | LVCMOS Single                  | 150 MHz                         | 27                           | 89.1                            | -                                |



#### 12 Layout

#### 12.1 Layout Guidelines

#### 12.1.1 Thermal Management

Power consumption of the LMK0482x family of devices can be high enough to require attention to thermal management. For reliability and performance reasons the die temperature should be limited to a maximum of 125°C. That is, as an estimate,  $T_A$  (ambient temperature) plus device power consumption times  $R_{\theta JA}$  should not exceed 125°C.

The package of the device has an exposed pad that provides the primary heat removal path as well as excellent electrical grounding to a printed circuit board. To maximize the removal of heat from the package a thermal land pattern including multiple vias to a ground plane must be incorporated on the PCB within the footprint of the package. The exposed pad must be soldered down to ensure adequate heat conduction out of the package.

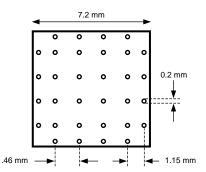
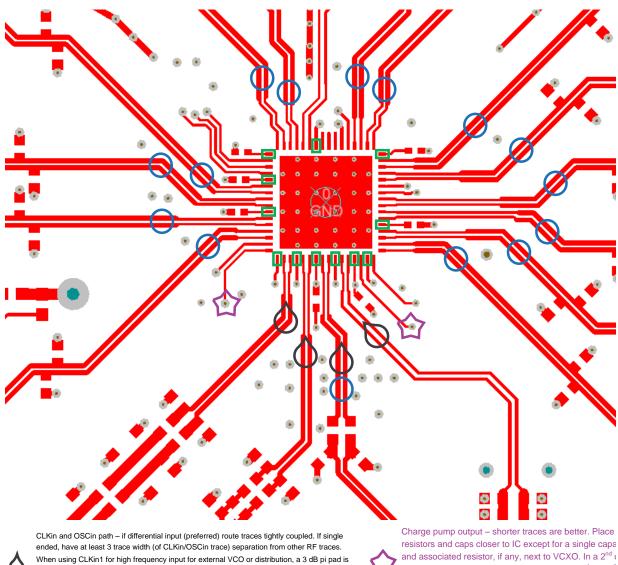


Figure 33. Recommended Land and Via Pattern



#### 12.2 Layout Example



When using CLKin1 for high frequency input for external VCO or distribution, a 3 dB pi pad is suggested for termination.

Place terminations close to IC.

CLKin2 and OSCout share pins and is programmable for input or output.

For CLKout Vccs in JESD204B application, place ferrite beads then 1  $\mu F$ capacitor. The 1  $\mu\text{F}$  capacitor supports low frequency SYSREF switching/turn on. For CLKout Vccs in traditional application place ferrite bead on top layer close to pins to choke high frequency noise from via.



filter place C1 close to VCXO Vtune pin. In a 3<sup>rd</sup> and 4<sup>tl</sup> order filter place R3/C3 or R4/C4 respectively close to VCXO.

CLKouts/OSCouts - Normally differential signals, shou routed tightly coupled to minimize PCB crosstalk. Trace impedance and terminations should be designed accor to output type being used (i.e. LVDS, LVPECL, LVCMC For LVPECL/LCPECL place emitter resistors close to I OSCout shares pins with CLKin2 and is programmable input or output

Figure 34. LMK0482x Layout Example



# 13 Device and Documentation Support

#### 13.1 Device Support

#### 13.1.1 Development Support

#### 13.1.1.1 Clock Architect

Part selection, loop filter design, simulation.

For the Clock Architect, go to www.ti.com/clockarchitect.

#### 13.1.1.2 Clock Design Tool

Limited part selection, advanced loop filter design and simulation capabilities.

For the Clock Design Tool, go to www.ti.com/tool/clockdesigntool. Please note training videos on this tool page.

#### 13.1.1.3 CodeLoader

EVM programming software. Can also be used to generate register map for programming for a specific application.

For CodeLoader, go to www.ti.com/tool/codeloader

#### 13.2 Related Links

The table below lists quick access links. Categories include technical documents, support and community resources, tools and software, and quick access to sample or buy.

#### Table 85. Related Links

| PARTS    | PRODUCT FOLDER SAMPLE & BUY |            | PRODUCT FOLDER SAMPLE & BUY TECHNICAL DOCUMENTS |            | SUPPORT & COMMUNITY |  |
|----------|-----------------------------|------------|---|------------|---------------------|--|
| LMK04821 | Click here                  | Click here | Click here                                      | Click here | Click here          |  |
| LMK04826 | Click here                  | Click here | Click here                                      | Click here | Click here          |  |
| LMK04828 | Click here                  | Click here | Click here                                      | Click here | Click here          |  |

#### 13.3 Trademarks

PLLatinum is a trademark of Texas Instruments.

All other trademarks are the property of their respective owners.

#### 13.4 Electrostatic Discharge Caution



These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

#### 13.5 Glossary

SLYZ022 — TI Glossary.

This glossary lists and explains terms, acronyms, and definitions.

# 14 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.

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17-Nov-2015

#### **PACKAGING INFORMATION**

| Orderable Device   | Status | Package Type | Package<br>Drawing | Pins | Package<br>Qty | Eco Plan                   | Lead/Ball Finish | MSL Peak Temp       | Op Temp (°C) | Device Marking (4/5) | Samples |
|--------------------|--------|--------------|--------------------|------|----------------|----------------------------|------------------|---------------------|--------------|----------------------|---------|
| LMK04821NKDR       | ACTIVE | WQFN         | NKD                | 64   | 1000           | Green (RoHS<br>& no Sb/Br) | CU SN            | Level-3-260C-168 HR | -40 to 85    | K04821NKD            | Samples |
| LMK04821NKDT       | ACTIVE | WQFN         | NKD                | 64   | 250            | Green (RoHS<br>& no Sb/Br) | CU SN            | Level-3-260C-168 HR | -40 to 85    | K04821NKD            | Samples |
| LMK04826BISQ/NOPB  | ACTIVE | WQFN         | NKD                | 64   | 1000           | Green (RoHS<br>& no Sb/Br) | CU SN            | Level-3-260C-168 HR | -40 to 85    | K04826BISQ           | Samples |
| LMK04826BISQE/NOPB | ACTIVE | WQFN         | NKD                | 64   | 250            | Green (RoHS<br>& no Sb/Br) | CU SN            | Level-3-260C-168 HR | -40 to 85    | K04826BISQ           | Samples |
| LMK04826BISQX/NOPB | ACTIVE | WQFN         | NKD                | 64   | 2000           | Green (RoHS<br>& no Sb/Br) | CU SN            | Level-3-260C-168 HR | -40 to 85    | K04826BISQ           | Samples |
| LMK04828BISQ/NOPB  | ACTIVE | WQFN         | NKD                | 64   | 1000           | Green (RoHS<br>& no Sb/Br) | CU SN            | Level-3-260C-168 HR | -40 to 85    | K04828BISQ           | Samples |
| LMK04828BISQE/NOPB | ACTIVE | WQFN         | NKD                | 64   | 250            | Green (RoHS<br>& no Sb/Br) | CU SN            | Level-3-260C-168 HR | -40 to 85    | K04828BISQ           | Samples |
| LMK04828BISQX/NOPB | ACTIVE | WQFN         | NKD                | 64   | 2000           | Green (RoHS<br>& no Sb/Br) | CU SN            | Level-3-260C-168 HR | -40 to 85    | K04828BISQ           | Samples |

<sup>(1)</sup> The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

TBD: The Pb-Free/Green conversion plan has not been defined.

**Pb-Free** (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes. **Pb-Free** (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

<sup>(2)</sup> Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

<sup>(3)</sup> MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.



# PACKAGE OPTION ADDENDUM

17-Nov-2015

- (4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.
- (5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.
- (6) Lead/Ball Finish Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

**Important Information and Disclaimer:** The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

**PACKAGE MATERIALS INFORMATION** 

www.ti.com 18-Nov-2015

# TAPE AND REEL INFORMATION





| A0 | Dimension designed to accommodate the component width     |
|----|---|
|    | Dimension designed to accommodate the component length    |
| K0 | Dimension designed to accommodate the component thickness |
| W  | Overall width of the carrier tape                         |
| P1 | Pitch between successive cavity centers                   |

# QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



#### \*All dimensions are nominal

| Device             | Package | Package | Pins | SPQ  | Reel             | Reel             | Α0   | В0   | K0   | P1   | w    | Pin1     |
|--------------------|---------|---------|------|------|------------------|------------------|------|------|------|------|------|----------|
| 201100             | Type    | Drawing |      | ;    | Diameter<br>(mm) | Width<br>W1 (mm) | (mm) | (mm) | (mm) | (mm) | (mm) | Quadrant |
| LMK04821NKDR       | WQFN    | NKD     | 64   | 1000 | 330.0            | 16.4             | 9.3  | 9.3  | 1.3  | 12.0 | 16.0 | Q1       |
| LMK04821NKDT       | WQFN    | NKD     | 64   | 250  | 178.0            | 16.4             | 9.3  | 9.3  | 1.3  | 12.0 | 16.0 | Q1       |
| LMK04826BISQ/NOPB  | WQFN    | NKD     | 64   | 1000 | 330.0            | 16.4             | 9.3  | 9.3  | 1.3  | 12.0 | 16.0 | Q1       |
| LMK04826BISQE/NOPB | WQFN    | NKD     | 64   | 250  | 178.0            | 16.4             | 9.3  | 9.3  | 1.3  | 12.0 | 16.0 | Q1       |
| LMK04826BISQX/NOPB | WQFN    | NKD     | 64   | 2000 | 330.0            | 16.4             | 9.3  | 9.3  | 1.3  | 12.0 | 16.0 | Q1       |
| LMK04828BISQ/NOPB  | WQFN    | NKD     | 64   | 1000 | 330.0            | 16.4             | 9.3  | 9.3  | 1.3  | 12.0 | 16.0 | Q1       |
| LMK04828BISQE/NOPB | WQFN    | NKD     | 64   | 250  | 178.0            | 16.4             | 9.3  | 9.3  | 1.3  | 12.0 | 16.0 | Q1       |
| LMK04828BISQX/NOPB | WQFN    | NKD     | 64   | 2000 | 330.0            | 16.4             | 9.3  | 9.3  | 1.3  | 12.0 | 16.0 | Q1       |

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\*All dimensions are nominal

| Device             | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|--------------------|--------------|-----------------|------|------|-------------|------------|-------------|
| LMK04821NKDR       | WQFN         | NKD             | 64   | 1000 | 367.0       | 367.0      | 38.0        |
| LMK04821NKDT       | WQFN         | NKD             | 64   | 250  | 213.0       | 191.0      | 55.0        |
| LMK04826BISQ/NOPB  | WQFN         | NKD             | 64   | 1000 | 367.0       | 367.0      | 38.0        |
| LMK04826BISQE/NOPB | WQFN         | NKD             | 64   | 250  | 213.0       | 191.0      | 55.0        |
| LMK04826BISQX/NOPB | WQFN         | NKD             | 64   | 2000 | 367.0       | 367.0      | 38.0        |
| LMK04828BISQ/NOPB  | WQFN         | NKD             | 64   | 1000 | 367.0       | 367.0      | 38.0        |
| LMK04828BISQE/NOPB | WQFN         | NKD             | 64   | 250  | 213.0       | 191.0      | 55.0        |
| LMK04828BISQX/NOPB | WQFN         | NKD             | 64   | 2000 | 367.0       | 367.0      | 38.0        |



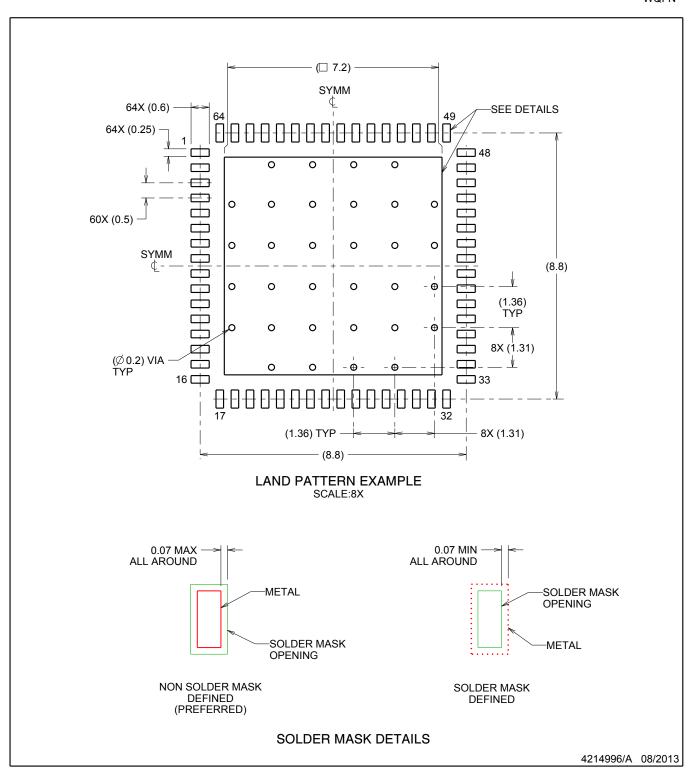
WQFN Α 8.9 PIN 1 INDEX AREA 9.1 0.3 0.2 **DETAIL** OPTIONAL TERMINAL TYPICAL 0.8 MAX С SEATING PLANE (0.1) TYP  $\square$  7.2  $\pm$  0.1 SEE TERMINAL 17 32 60X 0.5 **DETAIL** 4X חחחחח 7.5  $\vdash$ Þ  $64X_{0.2}^{0.3}$ PIN 1 ID 49 (OPTIONAL) 0.1M C AS BS 64X  $^{0.5}_{0.3}$  -0.05M C 4214996/A 08/2013

#### NOTES:

- 1. All linear dimensions are in millimeters. Dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
- 2. This drawing is subject to change without notice.
- 3. The package thermal pad must be soldered to the printed circuit board for thermal and mechanical performance.



WQFN

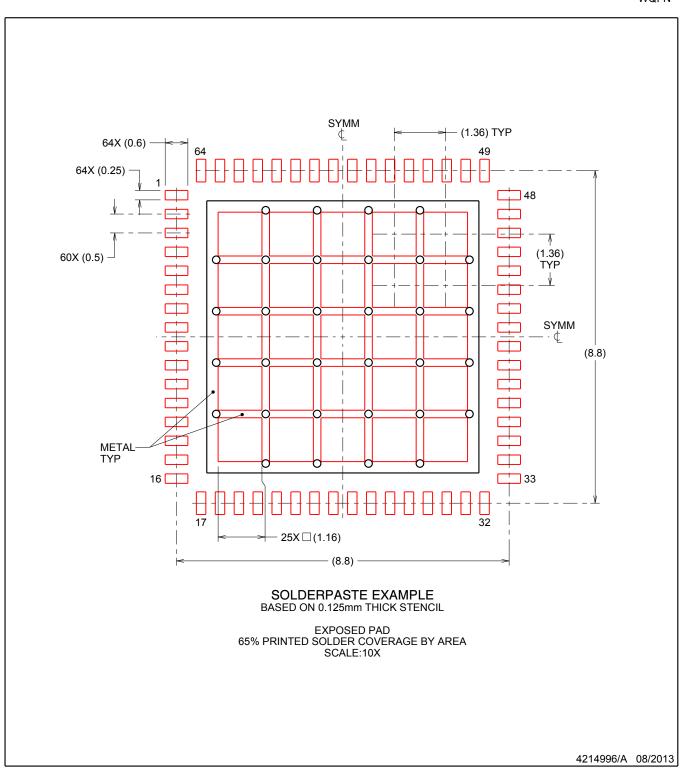


NOTES: (continued)

4. This package is designed to be soldered to a thermal pad on the board. For more information, refer to QFN/SON PCB application note in literature No. SLUA271 (www.ti.com/lit/slua271).



WQFN



NOTES: (continued)

5. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.



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